

Lecture 13
2025/2026

Microwave Devices and Circuits for Radiocommunications

2025/2026

- 2C/1L, **MDCR**
- Attendance at minimum 7 sessions (course or laboratory)
- Lectures- **associate professor Radu Damian**
 - Tuesday **12-14, P2**
 - E – 50% final grade
 - problems + (2p atten. lect.) + (3 tests) + (bonus activity)
 - first test L1: 24.02.2026 (t2 and t3 not announced, lecture)
 - 3att.=+0.5p
 - all materials/equipments authorized

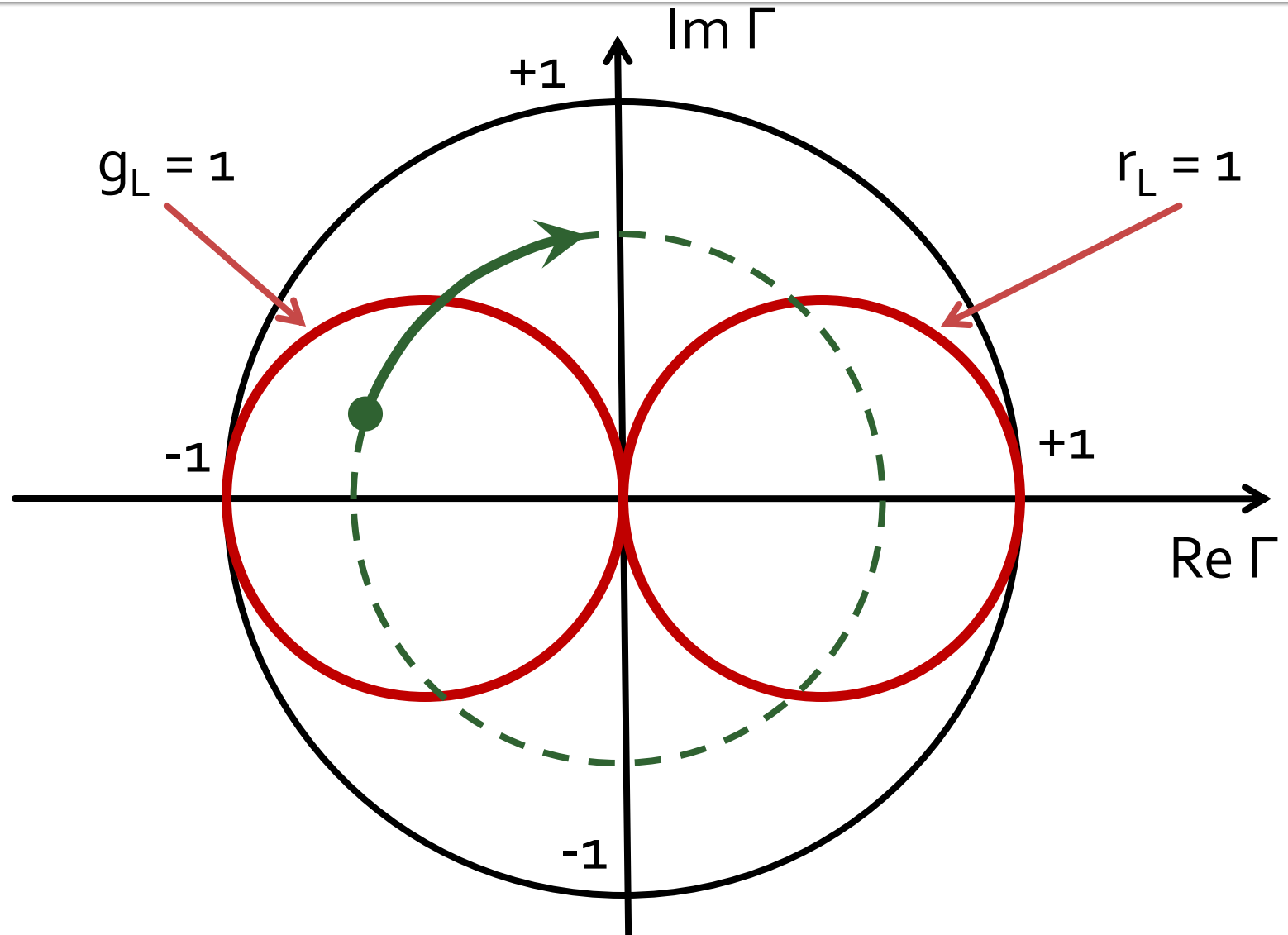
2025/2026

- Laboratory – **associate professor Radu Damian**
 - Monday 14-16, II.13 / (even weeks)
 - L – 25% final grade
 - ADS, 4 sessions
 - Attendance + **personal results**
 - P – 25% final grade
 - ADS, 3 sessions (-1? 24.02.2026)
 - personal homework

Impedance Matching

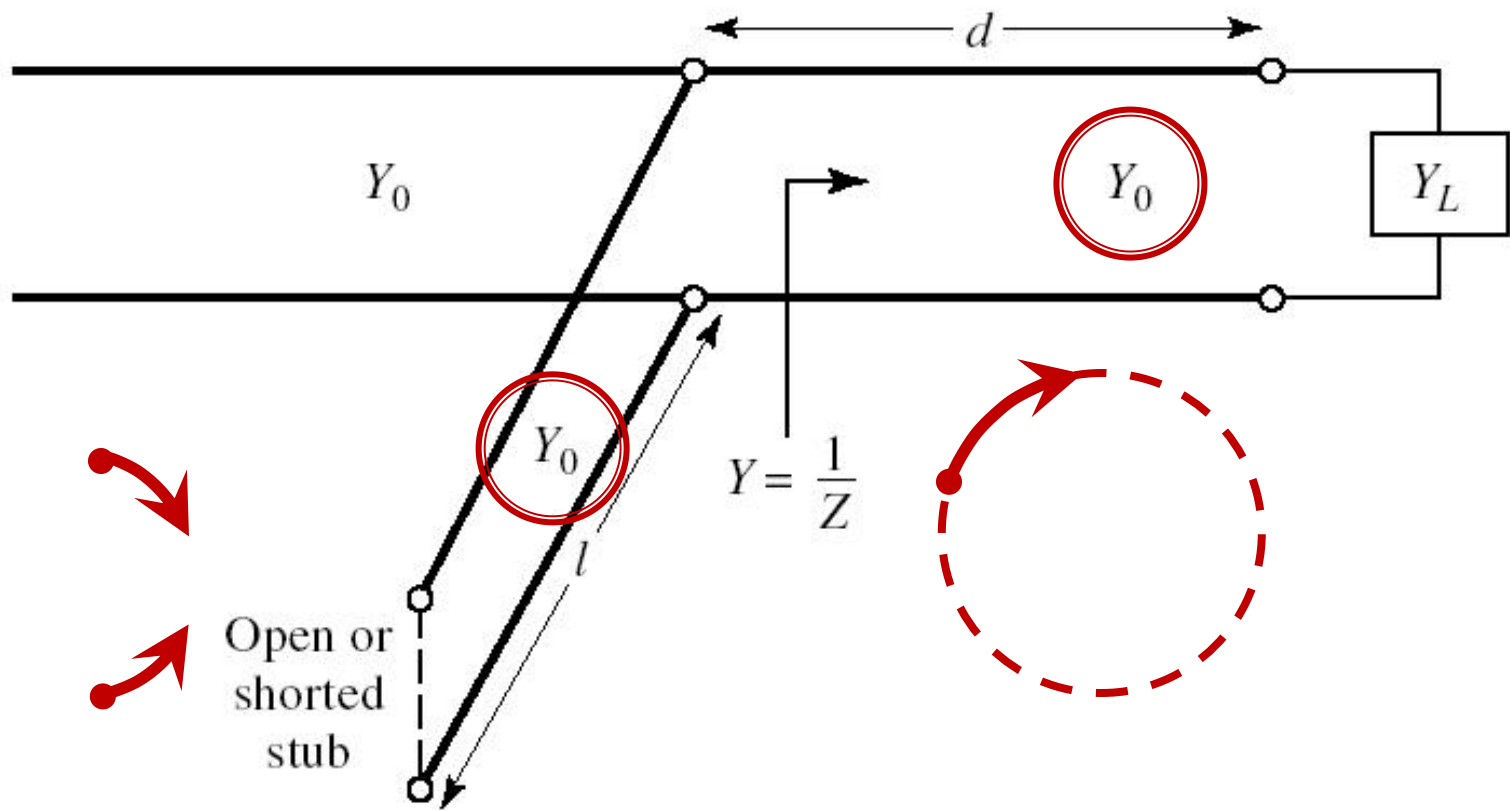
Impedance Matching with Stubs

Smith chart, $r=1$ and $g=1$



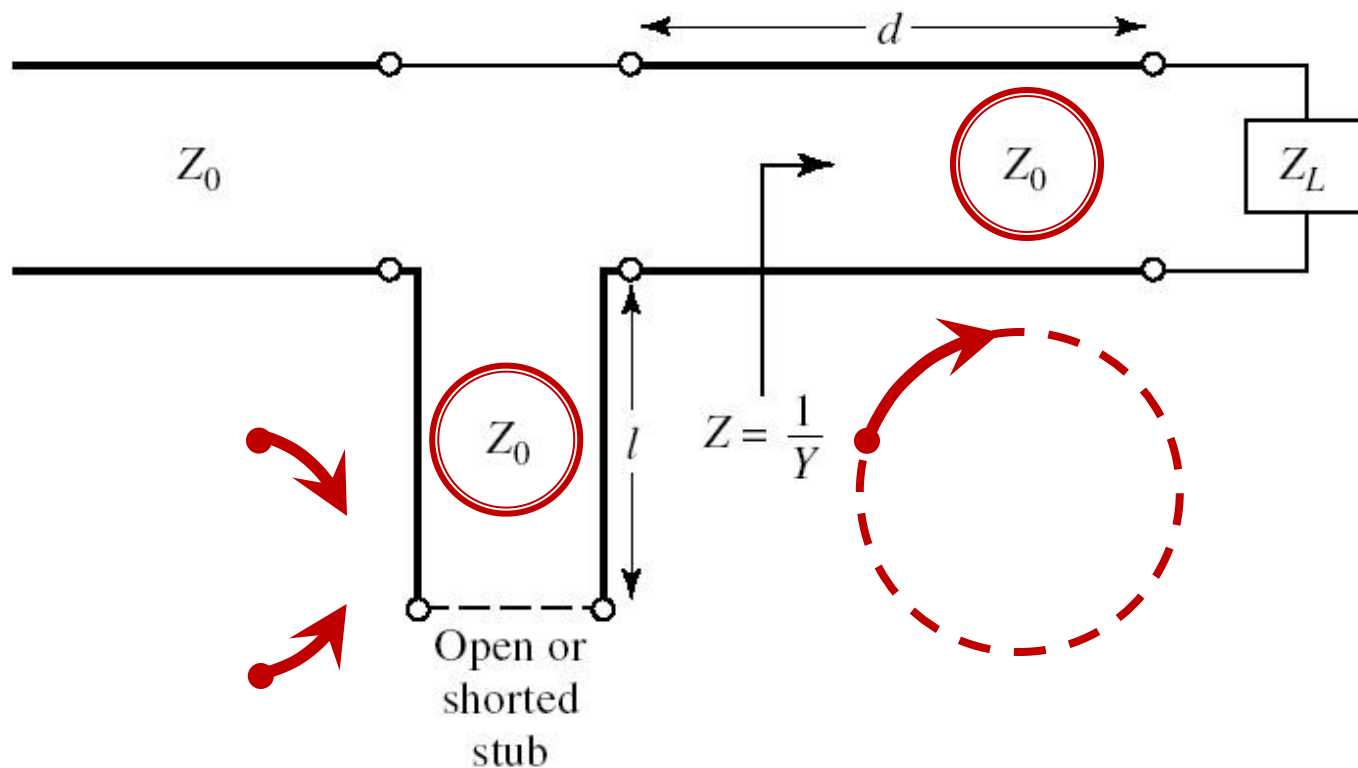
Single stub tuning

- Shunt Stub



Single stub tuning

- Series Stub
- difficult to realize in single conductor line technologies (microstrip)

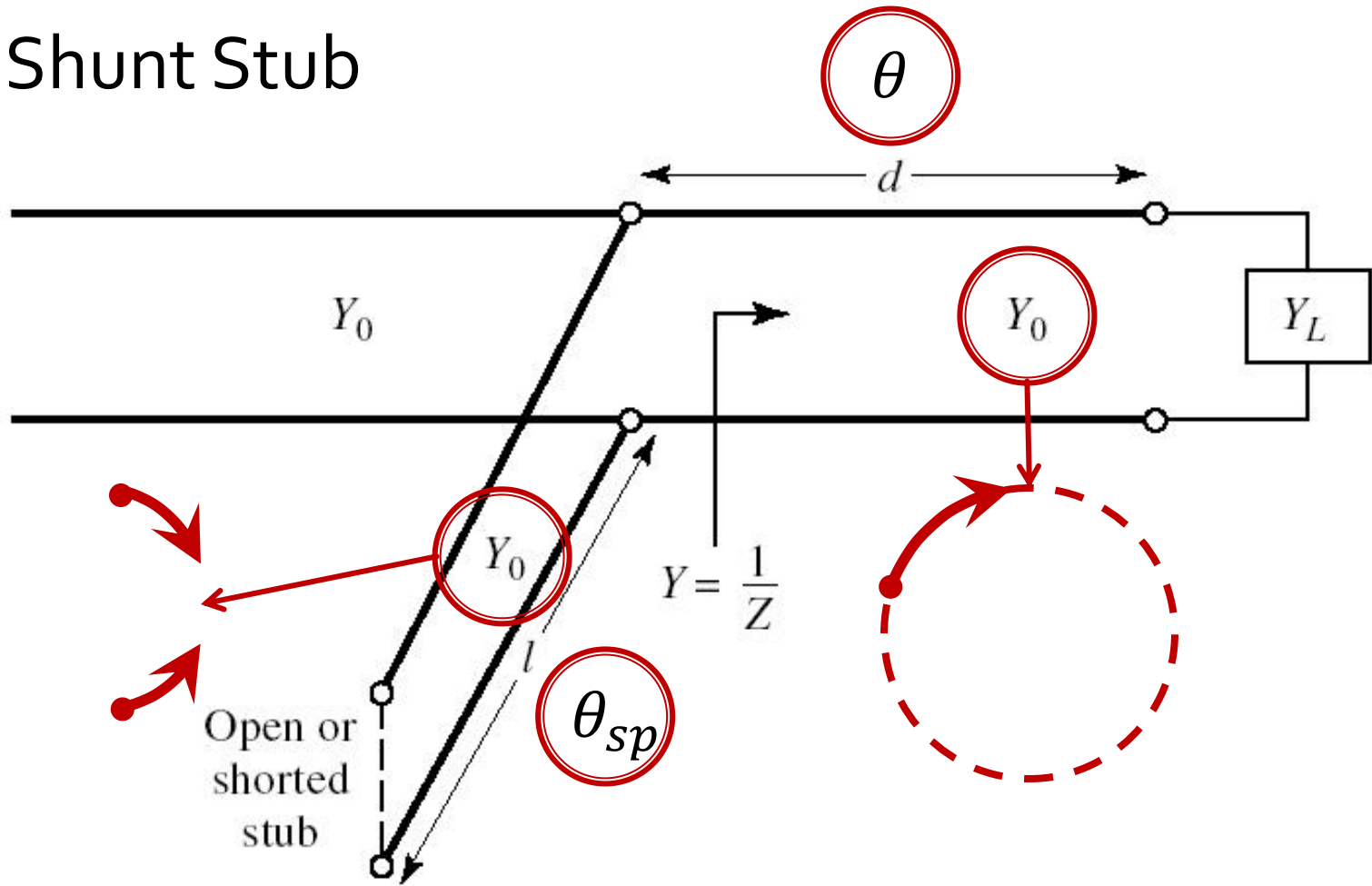


Analytical solutions

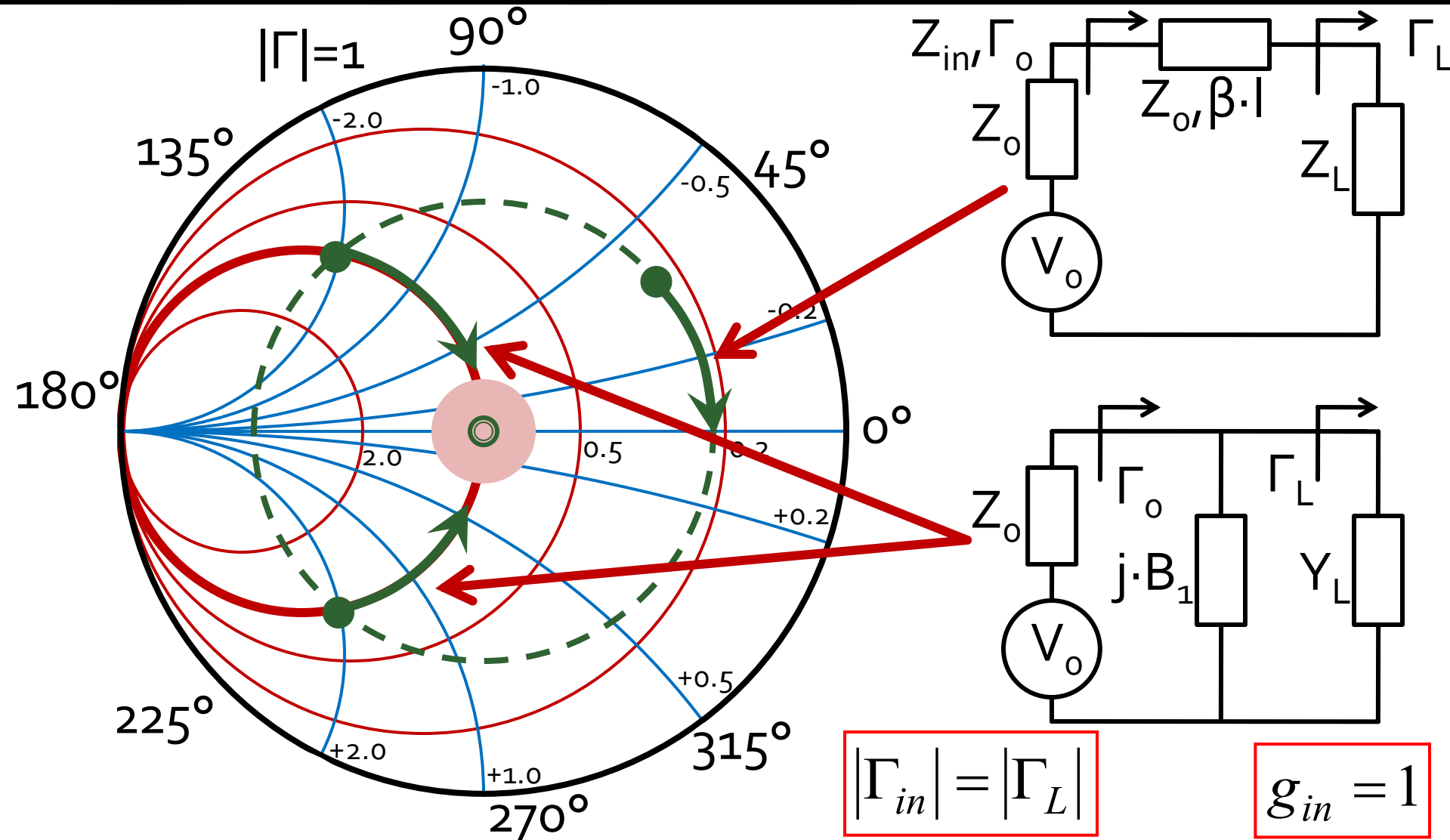
Exam / Project

Case 1, Shunt Stub

- Shunt Stub



Matching, series line + shunt susceptance



Analytical solution, usage

$$\cos(\varphi + 2\theta) = -|\Gamma_S|$$

$$\Gamma_S = 0.593 \angle 46.85^\circ$$

$$|\Gamma_S| = 0.593; \quad \varphi = 46.85^\circ \quad \cos(\varphi + 2\theta) = -0.593 \Rightarrow (\varphi + 2\theta) = \pm 126.35^\circ$$

$$\theta_{sp} = \beta \cdot l = \tan^{-1} \frac{\mp 2 \cdot |\Gamma_S|}{\sqrt{1 - |\Gamma_S|^2}}$$

- The **sign** (+/-) chosen for the **series line** equation imposes the **sign** used for the **shunt stub** equation

- “+” solution ↓

$$(46.85^\circ + 2\theta) = +126.35^\circ \quad \theta = +39.7^\circ \quad \text{Im } y_S = \frac{-2 \cdot |\Gamma_S|}{\sqrt{1 - |\Gamma_S|^2}} = -1.472$$

$$\theta_{sp} = \tan^{-1}(\text{Im } y_S) = -55.8^\circ (+180^\circ) \rightarrow \theta_{sp} = 124.2^\circ$$

- “-” solution ↓

$$(46.85^\circ + 2\theta) = -126.35^\circ \quad \theta = -86.6^\circ (+180^\circ) \rightarrow \theta = 93.4^\circ$$

$$\text{Im } y_S = \frac{+2 \cdot |\Gamma_S|}{\sqrt{1 - |\Gamma_S|^2}} = +1.472 \quad \theta_{sp} = \tan^{-1}(\text{Im } y_S) = 55.8^\circ$$

Analytical solution, usage

$$(\varphi + 2\theta) = \begin{cases} +126.35^\circ \\ -126.35^\circ \end{cases} \quad \theta = \begin{cases} 39.7^\circ \\ 93.4^\circ \end{cases} \quad \text{Im}[y_s(\theta)] = \begin{cases} -1.472 \\ +1.472 \end{cases} \quad \theta_{sp} = \begin{cases} -55.8^\circ + 180^\circ = 124.2^\circ \\ +55.8^\circ \end{cases}$$

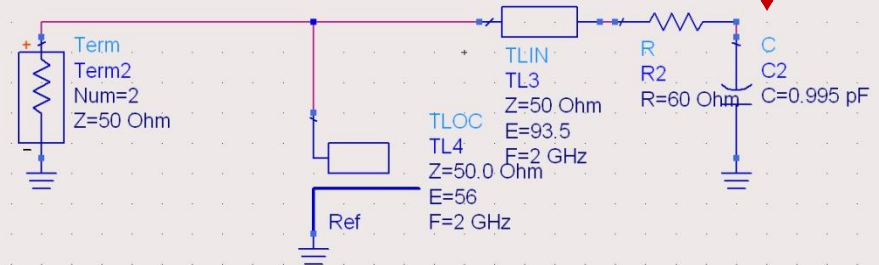
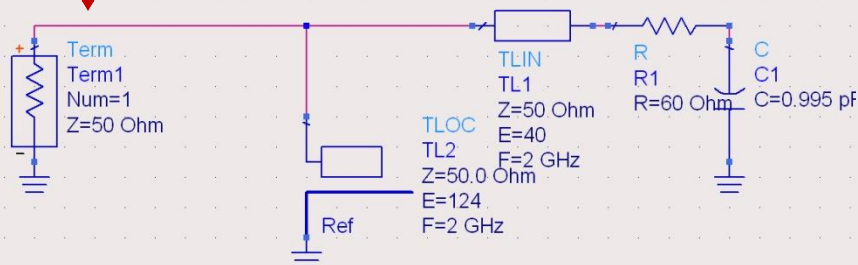
- We choose **one** of the two possible solutions
- The **sign** (+/-) chosen for the **series line** equation imposes the **sign** used for the **shunt stub** equation

$$l_1 = \frac{39.7^\circ}{360^\circ} \cdot \lambda = 0.110 \cdot \lambda$$

$$l_2 = \frac{124.2^\circ}{360^\circ} \cdot \lambda = 0.345 \cdot \lambda$$

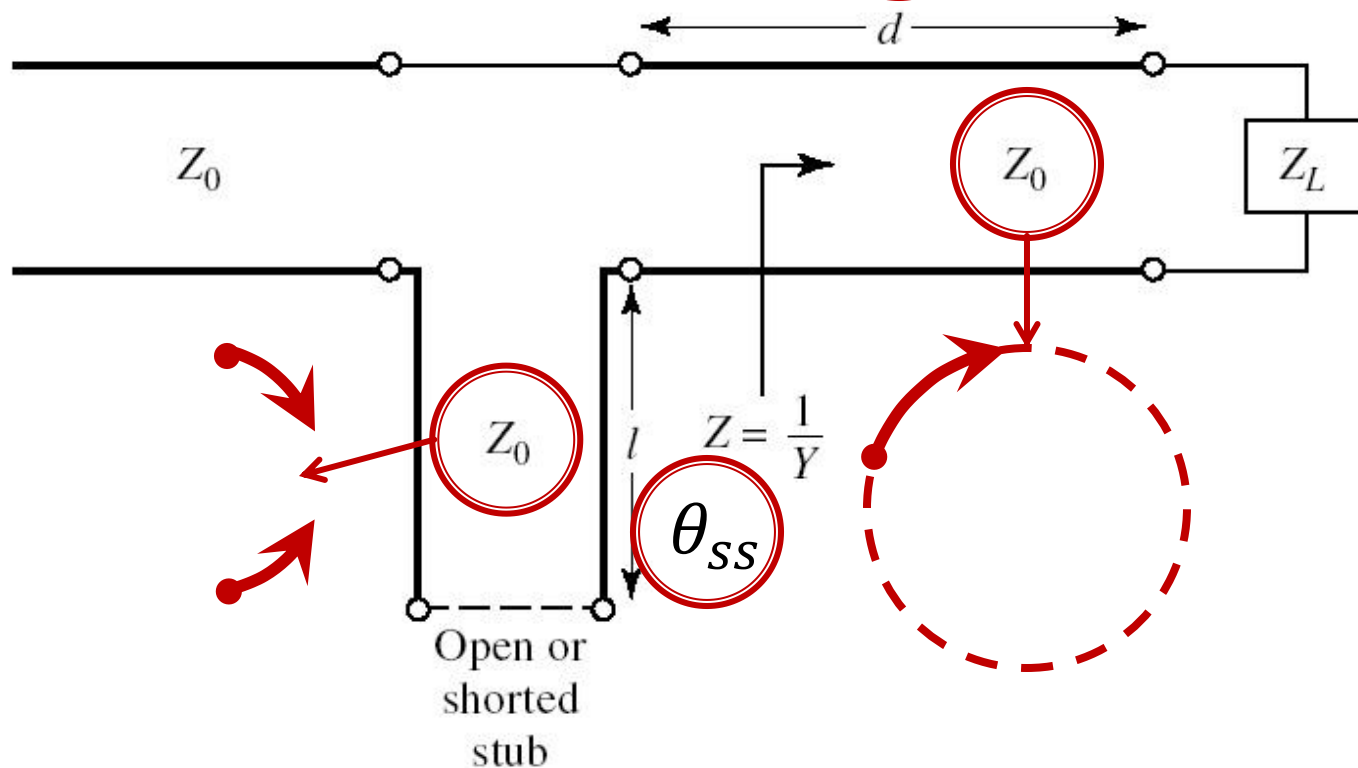
$$l_1 = \frac{93.4^\circ}{360^\circ} \cdot \lambda = 0.259 \cdot \lambda$$

$$l_2 = \frac{55.8^\circ}{360^\circ} \cdot \lambda = 0.155 \cdot \lambda$$

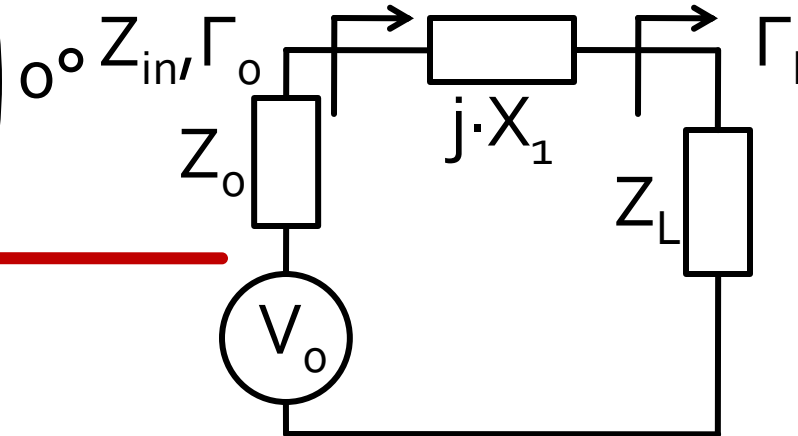
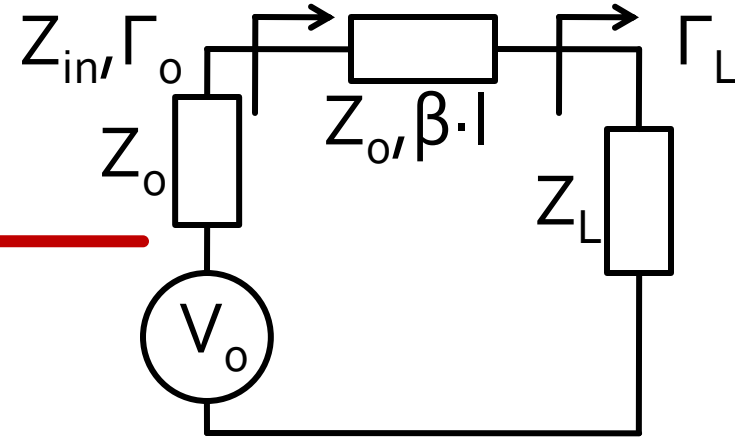
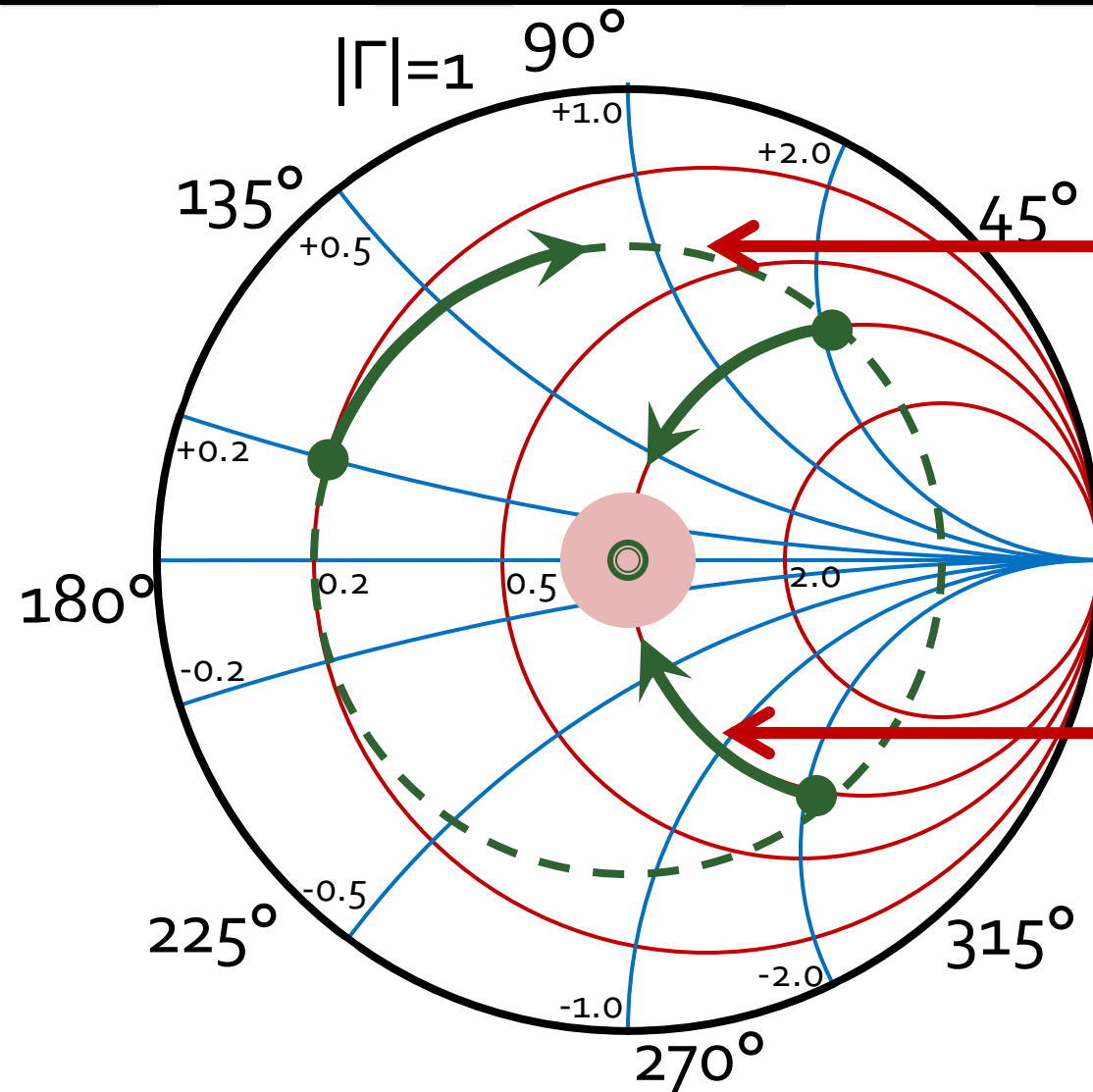


Case 2, Series Stub

- Series Stub
- difficult to realize in single conductor line technologies (microstrip) θ



Matching, series line + series reactance



$$|\Gamma_{in}| = |\Gamma_L|$$

$$r_{in} = 1$$

Analytical solution, usage

$$\cos(\varphi + 2\theta) = |\Gamma_S|$$

$$\theta_{ss} = \beta \cdot l = \cot^{-1} \frac{\mp 2 \cdot |\Gamma_S|}{\sqrt{1 - |\Gamma_S|^2}}$$

$$\Gamma_S = 0.555 \angle -29.92^\circ$$

$$|\Gamma_S| = 0.555; \quad \varphi = -29.92^\circ \quad \cos(\varphi + 2\theta) = 0.555 \Rightarrow (\varphi + 2\theta) = \pm 56.28^\circ$$

- The **sign** (+/-) chosen for the **series line** equation imposes the **sign** used for the **series stub** equation

- **"+" solution** ↓

$$(-29.92^\circ + 2\theta) = +56.28^\circ \quad \theta = 43.1^\circ \quad \text{Im } z_S = \frac{+2 \cdot |\Gamma_S|}{\sqrt{1 - |\Gamma_S|^2}} = +1.335$$

$$\theta_{ss} = -\cot^{-1}(\text{Im } z_S) = -36.8^\circ (+180^\circ) \rightarrow \theta_{ss} = 143.2^\circ$$

- **"-" solution** ↓

$$(-29.92^\circ + 2\theta) = -56.28^\circ \quad \theta = -13.2^\circ (+180^\circ) \rightarrow \theta = 166.8^\circ$$

$$\text{Im } z_S = \frac{-2 \cdot |\Gamma_S|}{\sqrt{1 - |\Gamma_S|^2}} = -1.335 \quad \theta_{ss} = -\cot^{-1}(\text{Im } z_S) = 36.8^\circ$$

Analytical solution, usage

$$(\varphi + 2\theta) = \begin{cases} +56.28^\circ \\ -56.28^\circ \end{cases} \quad \theta = \begin{cases} 43.1^\circ \\ 166.8^\circ \end{cases} \quad \text{Im}[z_s(\theta)] = \begin{cases} +1.335 \\ -1.335 \end{cases} \quad \theta_{ss} = \begin{cases} -36.8^\circ + 180^\circ = 143.2^\circ \\ +36.8^\circ \end{cases}$$

- We choose **one** of the two possible solutions
- The **sign** (+/-) chosen for the **series line** equation imposes the **sign** used for the **series stub** equation

$$l_1 = \frac{43.1^\circ}{360^\circ} \cdot \lambda = 0.120 \cdot \lambda$$

$$l_2 = \frac{143.2^\circ}{360^\circ} \cdot \lambda = 0.398 \cdot \lambda$$

$$l_1 = \frac{166.8^\circ}{360^\circ} \cdot \lambda = 0.463 \cdot \lambda$$

$$l_2 = \frac{36.8^\circ}{360^\circ} \cdot \lambda = 0.102 \cdot \lambda$$



Stub, observations

- adding or subtracting **180°** ($\lambda/2$) doesn't change the result (full rotation around the Smith Chart)

$$E = \beta \cdot l = \pi = 180^\circ \quad l = k \cdot \frac{\lambda}{2}, \forall k \in \mathbf{N}$$

- if the lines/stubs result with **negative** "length"/ "electrical length" we add $\lambda/2$ / 180° to obtain physically realizable lines
- adding or subtracting **90°** ($\lambda/4$) change the stub impedance:

$$Z_{in,sc} = j \cdot Z_0 \cdot \tan \beta \cdot l \quad \Leftrightarrow \quad Z_{in,g} = -j \cdot Z_0 \cdot \cot \beta \cdot l$$

- for the stub we can add or subtract 90° ($\lambda/4$) while in the same time changing **open-circuit** \Leftrightarrow **short-circuit**

Microwave Filters

Insertion loss method

- We control the power loss ratio/attenuation introduced by the filter:
 - in the passband (pass all frequencies)
 - in the stopband (reject all frequencies)

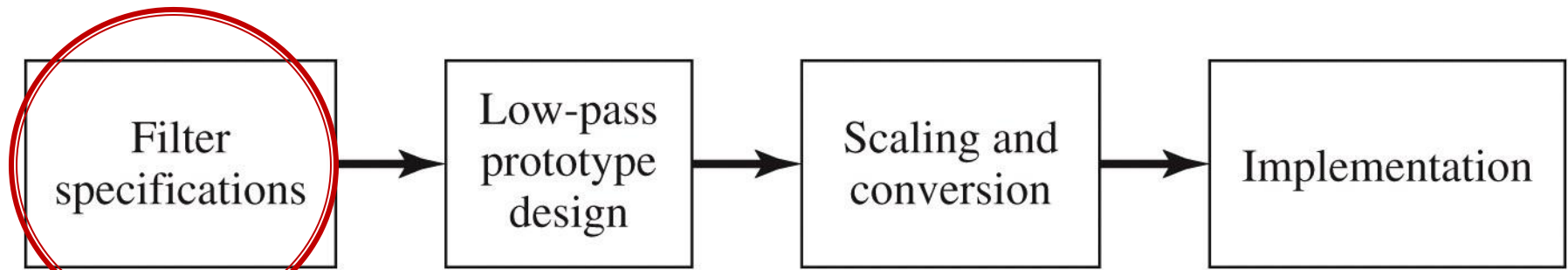
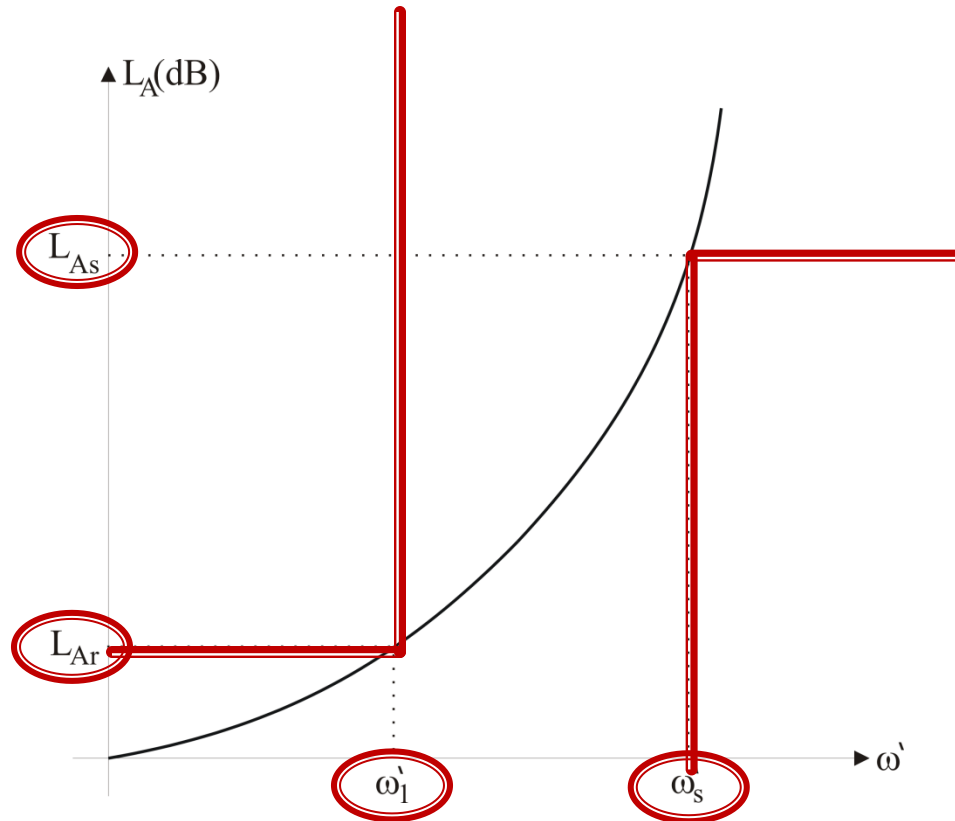


Figure 8.23

Filter specifications

- Attenuation
 - in passband
 - in stopband
 - most often in **dB**
- Frequency range
 - passband
 - stopband
 - cutoff frequency ω_1'
usually normalized
(= **1**)



Insertion loss method

- We choose the right polynomials to design an **low-pass** filter (prototype)
- The low-pass prototype are then converted to the desired other types of filters
 - low-pass, high-pass, bandpass, or bandstop

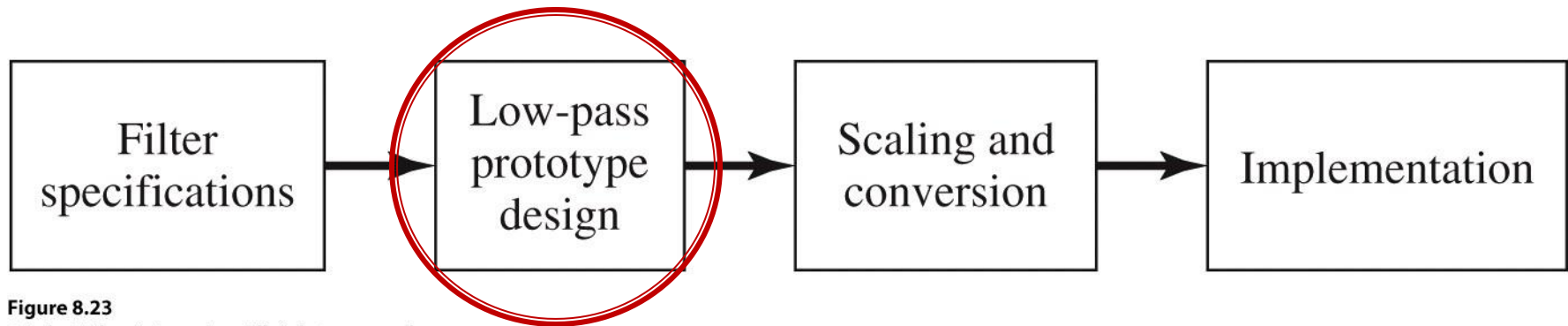


Figure 8.23
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Maximally Flat/Equal ripple LPF Prototype

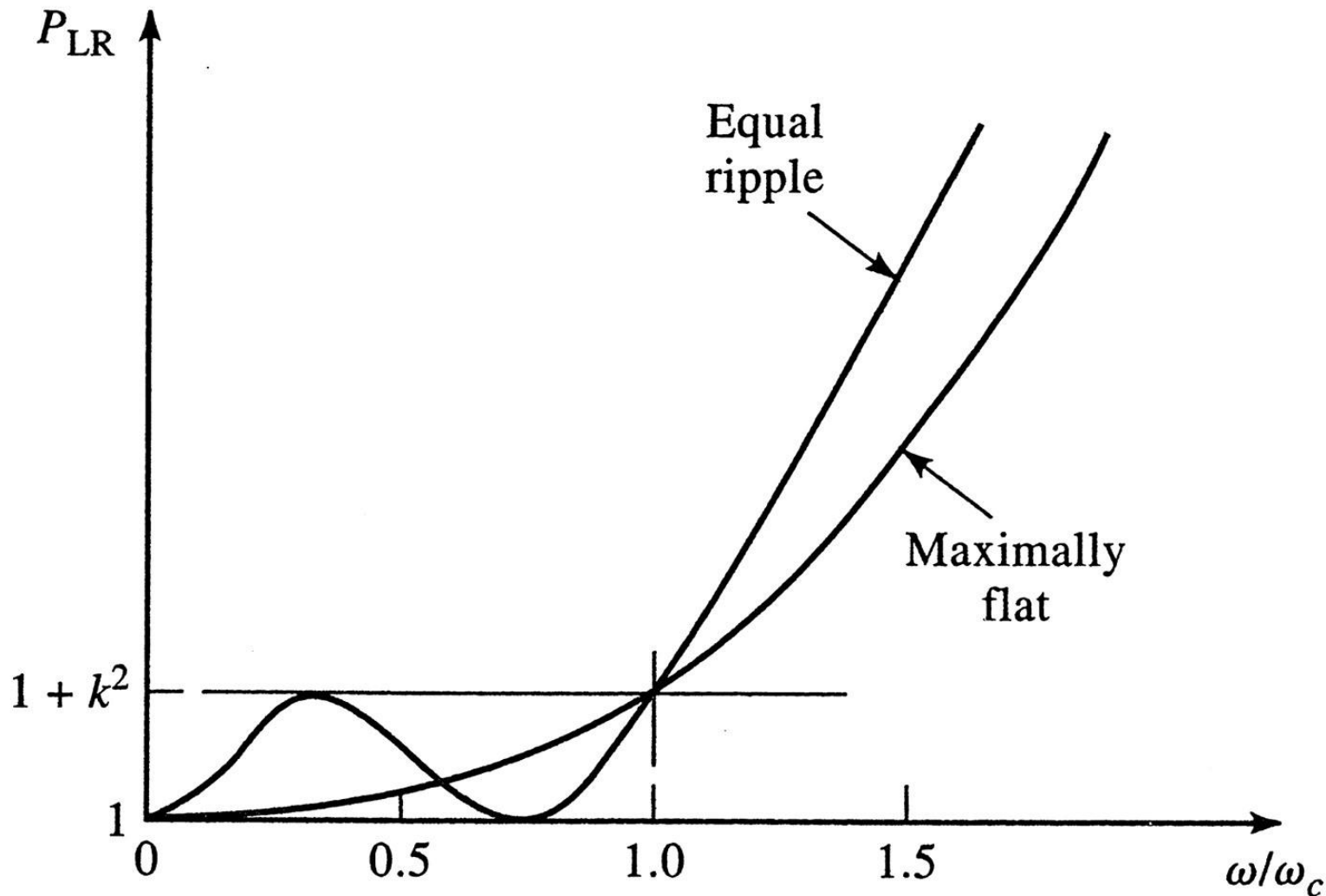
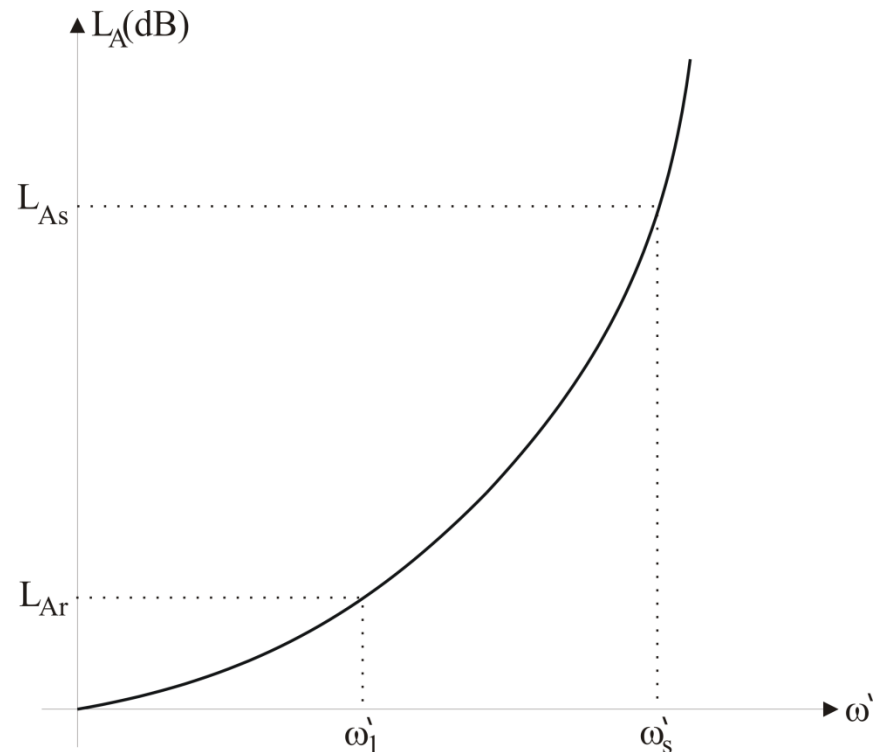


Figure 8.21
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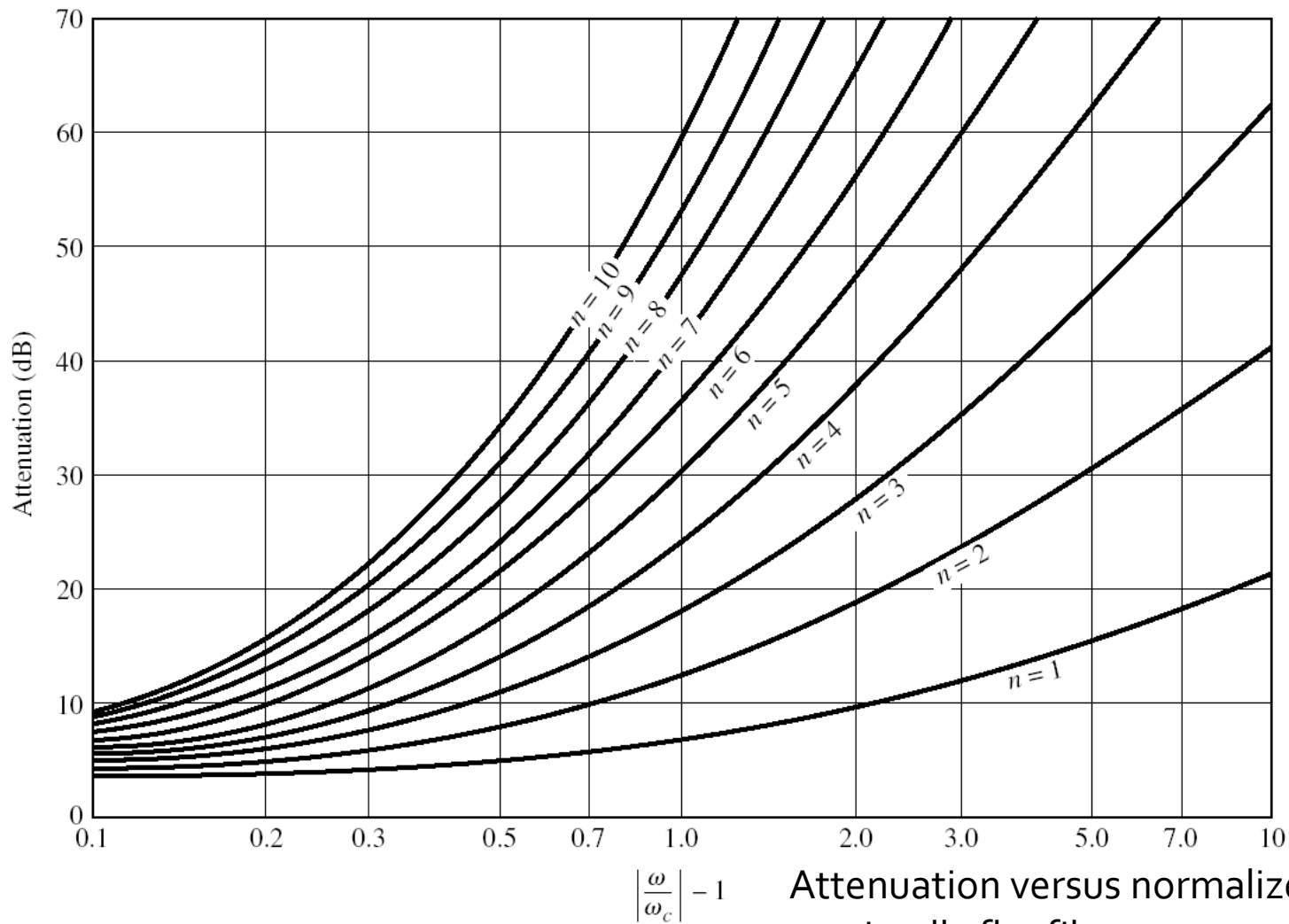
Order (N) of the Maximally Flat filter

$$n \geq \frac{\log \left(\frac{10^{\frac{L_{As}}{10}} - 1}{10^{\frac{L_{Ar}}{10}} - 1} \right)}{2 \cdot \log \frac{\omega'_s}{\omega'_1}}$$

- !attenuations in **dB**

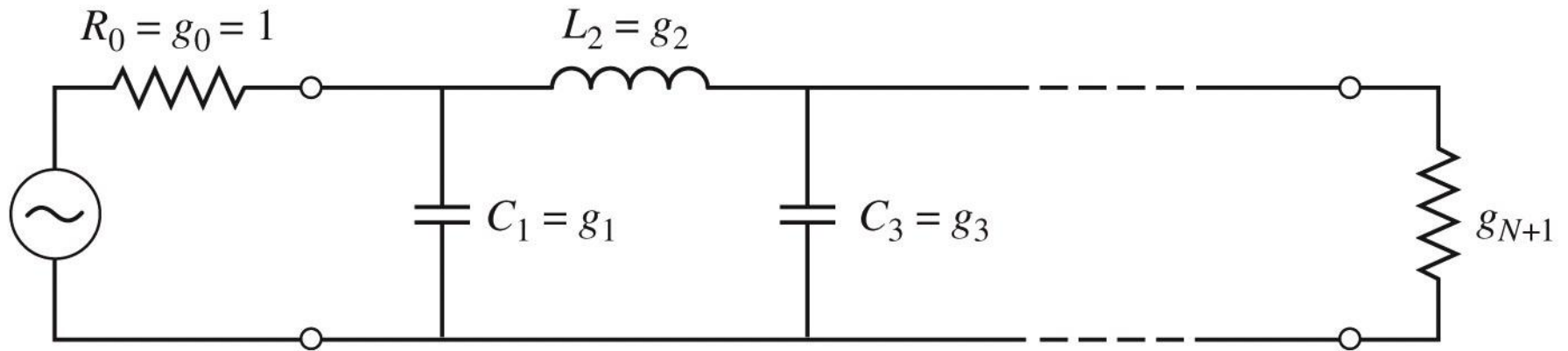


Maximally flat filter prototypes

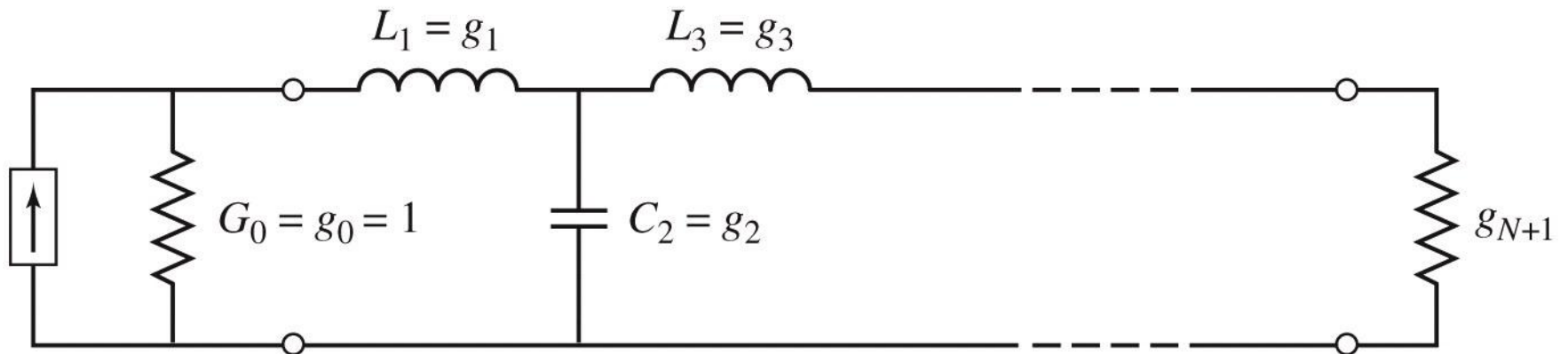


Attenuation versus normalized frequency for maximally flat filter prototypes

Prototype Filters



(a)



(b)

Prototype Filters

- Prototype filters are:
 - Low-Pass Filters (**LPF**)
 - cutoff frequency **$\omega_o = 1 \text{ rad/s}$** ($f_o = 0.159 \text{ Hz}$)
 - connected to a source with **$R = 1\Omega$**
- The number of reactive elements (L/C) is the order of the filter (N)
- Reactive elements are alternated: series L / shunt C
- There two prototypes with the same response, a prototype beginning with a shunt C element, and a prototype beginning with a series L element

Prototype Filters

- We define filter parameters g_i , $i=0, N+1$
- g_i are the element values in the prototype filter

$$g_0 = \begin{cases} \text{generator resistance } R'_0 & \text{if } g_1 = C'_1 \\ \text{generator conductance } G'_0 & \text{if } g_1 = L'_1 \end{cases}$$

$$g_k \Big|_{k=1, \overline{N}} = \begin{cases} \text{inductance for series inductors} \\ \text{capacitance for shunt capacitors} \end{cases}$$

$$g_{N+1} = \begin{cases} \text{load resistance } R'_{N+1} & \text{if } g_N = C'_N \\ \text{load conductance } G'_{N+1} & \text{if } g_N = L'_N \end{cases}$$

Maximally Flat LPF Prototype

- Formulas for filter parameters

$$g_0 = 1$$

$$g_k = 2 \cdot \sin \left[\frac{(2 \cdot k - 1) \cdot \pi}{2 \cdot N} \right], \quad k = 1, N$$

$$g_{N+1} = 1$$

Maximally Flat LPF Prototype

TABLE 8.3 Element Values for Maximally Flat Low-Pass Filter Prototypes ($g_0 = 1$, $\omega_c = 1$, $N = 1$ to 10)

N	g_1	g_2	g_3	g_4	g_5	g_6	g_7	g_8	g_9	g_{10}	g_{11}
1	2.0000	1.0000									
2	1.4142	1.4142	1.0000								
3	1.0000	2.0000	1.0000	1.0000							
4	0.7654	1.8478	1.8478	0.7654	1.0000						
5	0.6180	1.6180	2.0000	1.6180	0.6180	1.0000					
6	0.5176	1.4142	1.9318	1.9318	1.4142	0.5176	1.0000				
7	0.4450	1.2470	1.8019	2.0000	1.8019	1.2470	0.4450	1.0000			
8	0.3902	1.1111	1.6629	1.9615	1.9615	1.6629	1.1111	0.3902	1.0000		
9	0.3473	1.0000	1.5321	1.8794	2.0000	1.8794	1.5321	1.0000	0.3473	1.0000	
10	0.3129	0.9080	1.4142	1.7820	1.9754	1.9754	1.7820	1.4142	0.9080	0.3129	1.0000

Source: Reprinted from G. L. Matthaei, L. Young, and E. M. T. Jones, *Microwave Filters, Impedance-Matching Networks, and Coupling Structures*, Artech House, Dedham, Mass., 1980, with permission.

TABLE 8.4 Element Values for Equal-Ripple Low-Pass Filter Prototypes ($g_0 = 1, \omega_c = 1, N = 1$ to 10, 0.5 dB and 3.0 dB ripple)

0.5 dB Ripple											
N	g_1	g_2	g_3	g_4	g_5	g_6	g_7	g_8	g_9	g_{10}	g_{11}
1	0.6986	1.0000									
2	1.4029	0.7071	1.9841								
3	1.5963	1.0967	1.5963	1.0000							
4	1.6703	1.1926	2.3661	0.8419	1.9841						
5	1.7058	1.2296	2.5408	1.2296	1.7058	1.0000					
6	1.7254	1.2479	2.6064	1.3137	2.4758	0.8696	1.9841				
7	1.7372	1.2583	2.6381	1.3444	2.6381	1.2583	1.7372	1.0000			
8	1.7451	1.2647	2.6564	1.3590	2.6964	1.3389	2.5093	0.8796	1.9841		
9	1.7504	1.2690	2.6678	1.3673	2.7239	1.3673	2.6678	1.2690	1.7504	1.0000	
10	1.7543	1.2721	2.6754	1.3725	2.7392	1.3806	2.7231	1.3485	2.5239	0.8842	1.9841

3.0 dB Ripple											
N	g_1	g_2	g_3	g_4	g_5	g_6	g_7	g_8	g_9	g_{10}	g_{11}
1	1.9953	1.0000									
2	3.1013	0.5339	5.8095								
3	3.3487	0.7117	3.3487	1.0000							
4	3.4389	0.7483	4.3471	0.5920	5.8095						
5	3.4817	0.7618	4.5381	0.7618	3.4817	1.0000					
6	3.5045	0.7685	4.6061	0.7929	4.4641	0.6033	5.8095				
7	3.5182	0.7723	4.6386	0.8039	4.6386	0.7723	3.5182	1.0000			
8	3.5277	0.7745	4.6575	0.8089	4.6990	0.8018	4.4990	0.6073	5.8095		
9	3.5340	0.7760	4.6692	0.8118	4.7272	0.8118	4.6692	0.7760	3.5340	1.0000	
10	3.5384	0.7771	4.6768	0.8136	4.7425	0.8164	4.7260	0.8051	4.5142	0.6091	5.8095

Source: Reprinted from G. L. Matthaei, L. Young, and E. M. T. Jones, *Microwave Filters, Impedance-Matching Networks, and Coupling Structures*, Artech House, Dedham, Mass., 1980, with permission.

- For even N order of the filter (N = 2, 4, 6, 8 ...) equal-ripple filters **must** closed by a load impedance

$g_{N+1} \neq 1$

- If the application doesn't allow this, supplemental impedance matching is required (quarter-wave transformer, binomial ...) to $g_L = 1$

Impedance and Frequency Scaling

- LPF Prototype is only used as an intermediate step
 - Low-Pass Filter (LPF)
 - cutoff frequency $\omega_o = 1 \text{ rad/s}$ ($f_o = 0.159 \text{ Hz}$)
 - connected to a source with $R = 1\Omega$

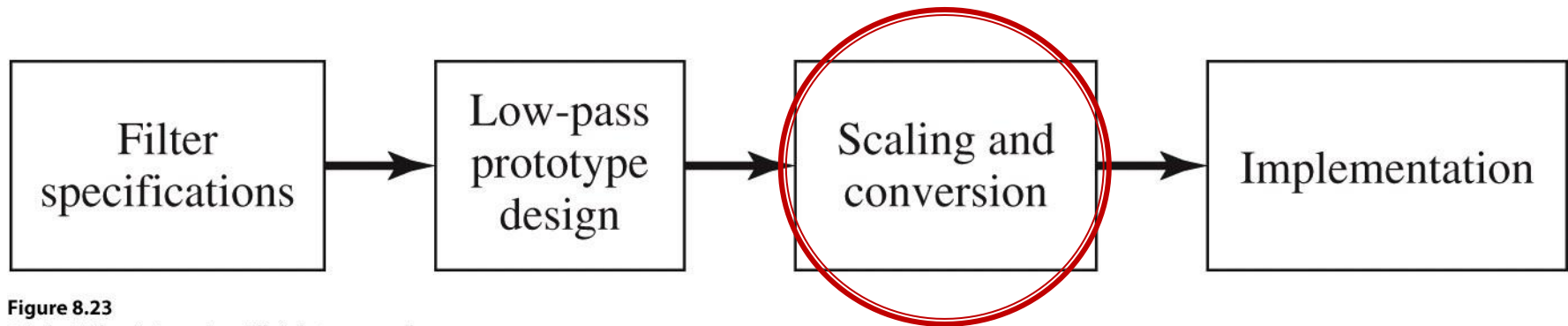


Figure 8.23

Impedance Scaling

- To design a filter which will work with a source resistance of R_0 we multiply all the impedances of the prototype design by R_0 (" $'$ " denotes scaled values)

$$R'_s = R_0 \cdot (R_s = 1)$$

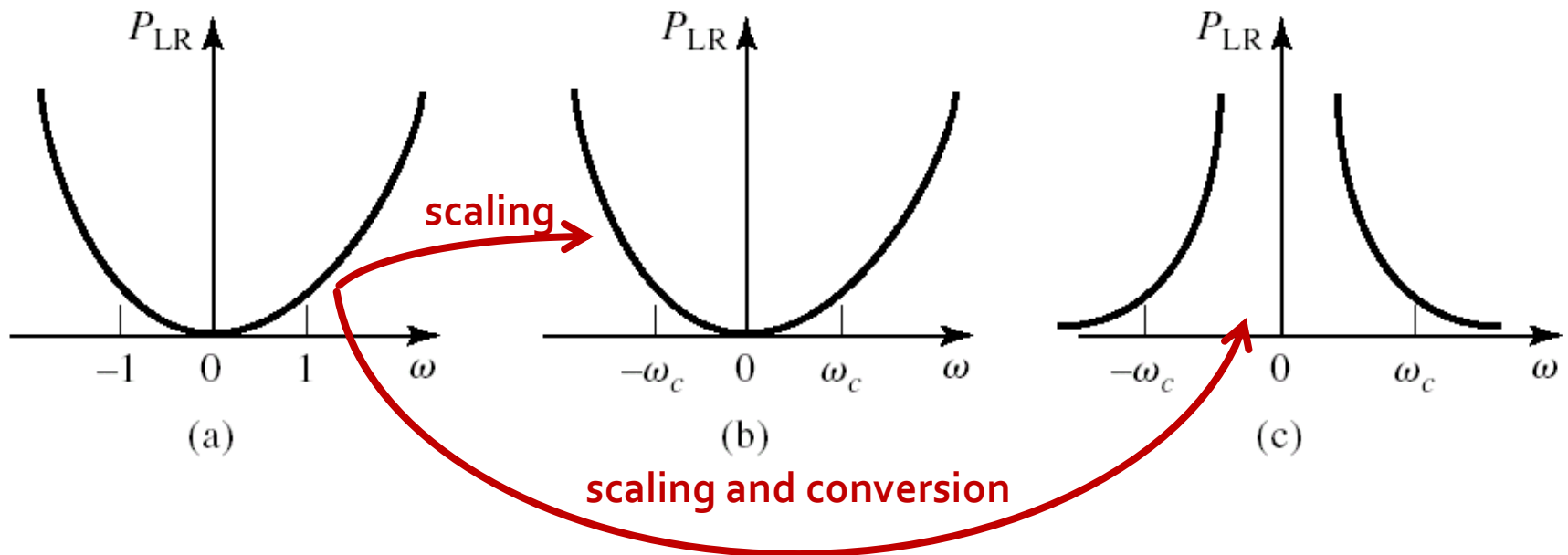
$$R'_L = R_0 \cdot R_L$$

$$L' = R_0 \cdot L$$

$$C' = \frac{C}{R_0}$$

Frequency Scaling

- changing the cutoff frequency – (fig. b)
- changing the type (for example LPF \rightarrow HPF – fig. c) requires also conversion



Summary of Prototype Filter Transformations


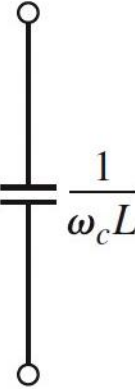
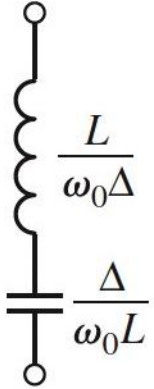
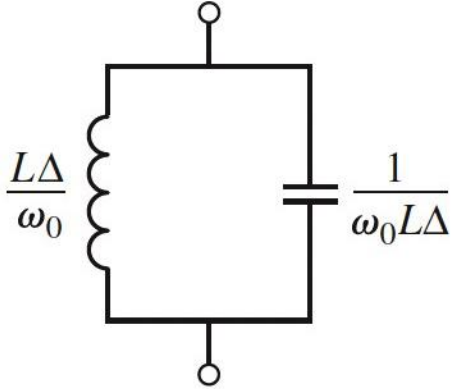
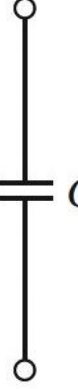
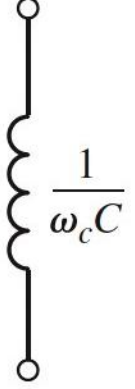
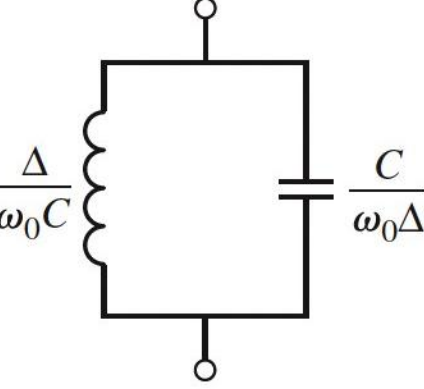
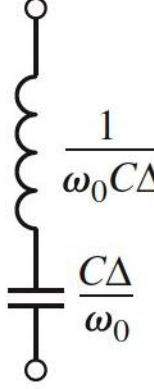
Low-pass	High-pass	Bandpass	Bandstop
 <p style="text-align: center;">L</p>	 <p style="text-align: center;">$\frac{1}{\omega_c L}$</p>	 <p style="text-align: center;">$\frac{L}{\omega_0 \Delta}$ $\frac{\Delta}{\omega_0 L}$</p>	 <p style="text-align: center;">$\frac{L \Delta}{\omega_0}$ $\frac{1}{\omega_0 L \Delta}$</p>
 <p style="text-align: center;">C</p>	 <p style="text-align: center;">$\frac{1}{\omega_c C}$</p>	 <p style="text-align: center;">$\frac{\Delta}{\omega_0 C}$ $\frac{C}{\omega_0 \Delta}$</p>	 <p style="text-align: center;">$\frac{1}{\omega_0 C \Delta}$ $\frac{C \Delta}{\omega_0}$</p>

Table 8.6

Microwave Filters Implementation

- The lumped-element (L, C) filter design generally works well **only** at low frequencies (RF):
 - lumped-element inductors and capacitors are generally available only for a limited range of values, and can be difficult to implement at microwave frequencies
 - difficulty to obtain the (very low) required tolerance for elements

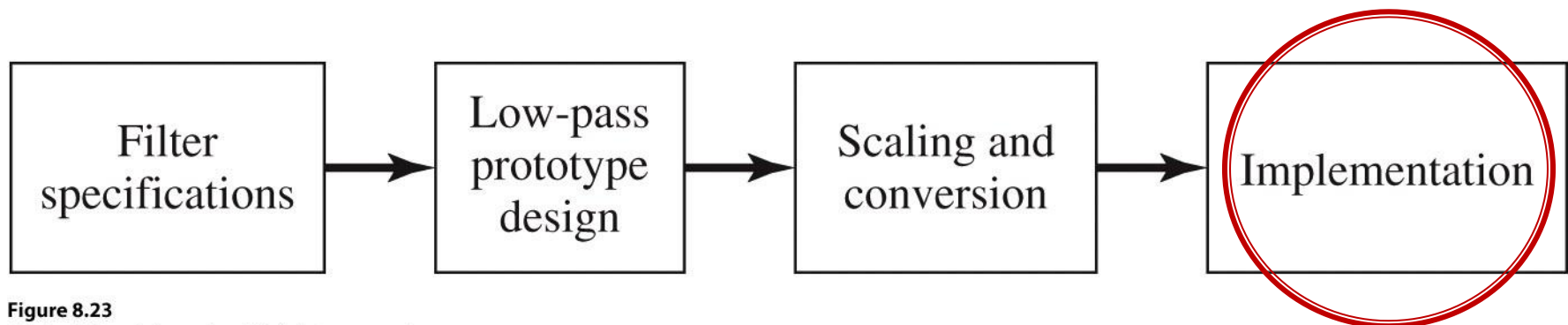
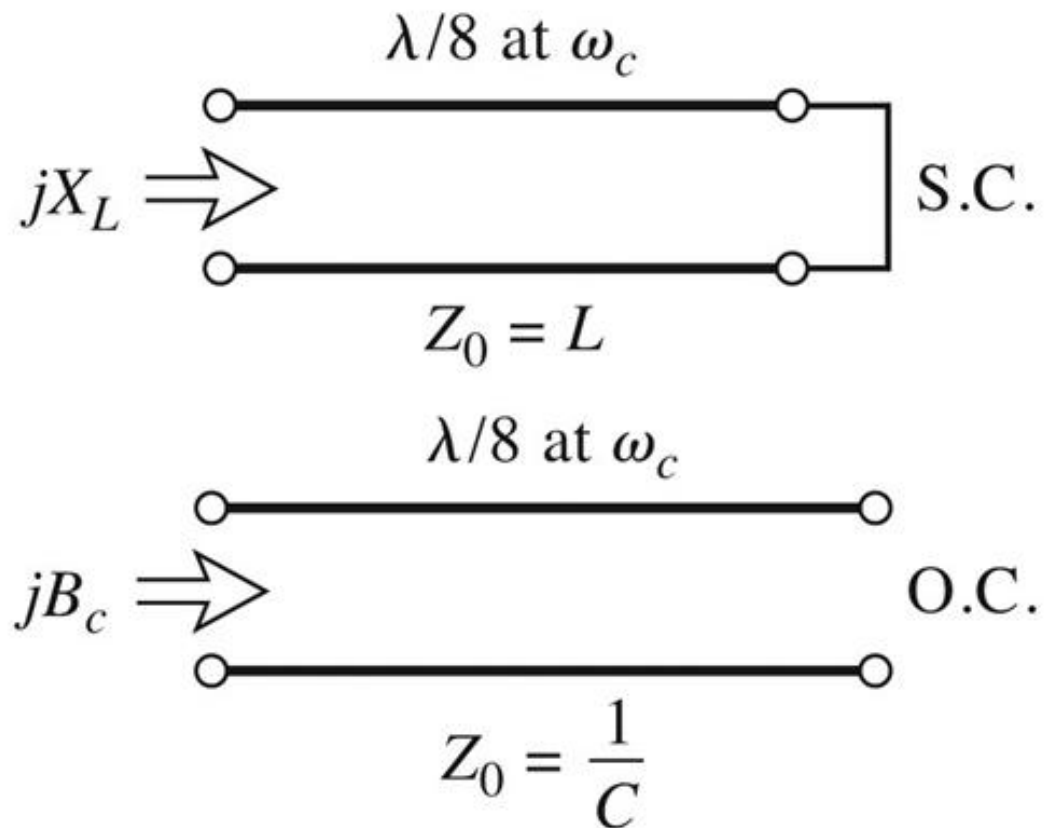
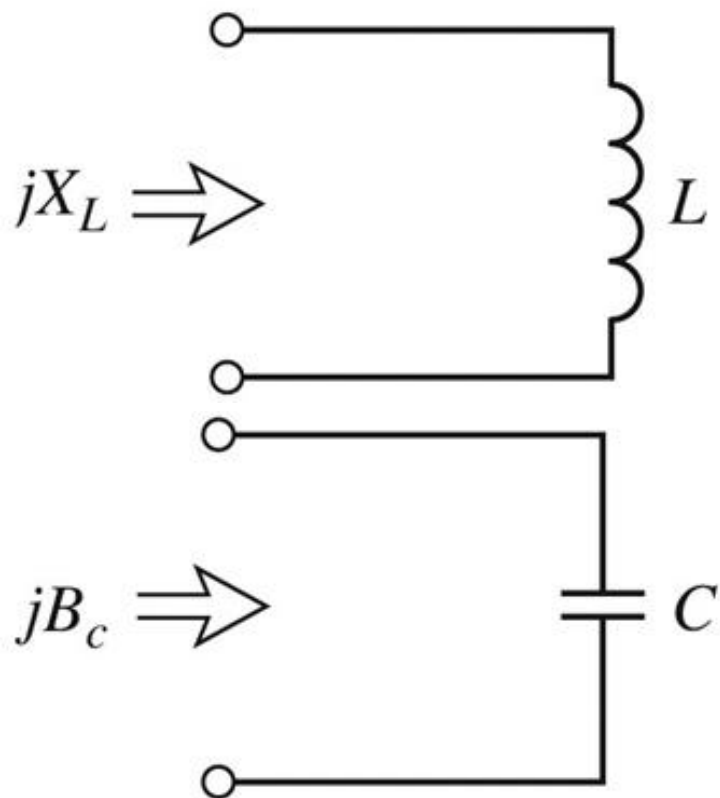


Figure 8.23

Richards' Transformation

- allows implementation of the inductors and capacitors with lines **after** the transformation of the LPF prototype to the required type (LPF/HPF/BPF/BSF)

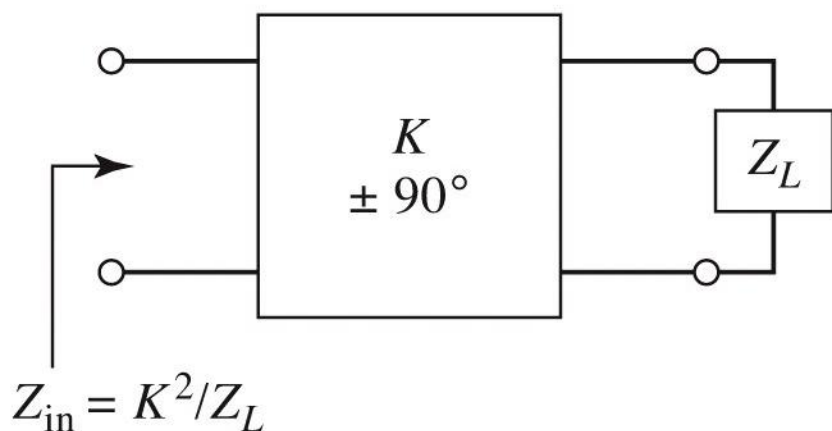


Impedance and Admittance Inverters

- For cases where Richards + Kuroda do not offer practical solutions we use circuits called **impedance and admittance inverters**

$$Z_{in} = \frac{K^2}{Z_L}$$

Impedance inverters



$$Y_{in} = \frac{J^2}{Y_L}$$

Admittance inverters

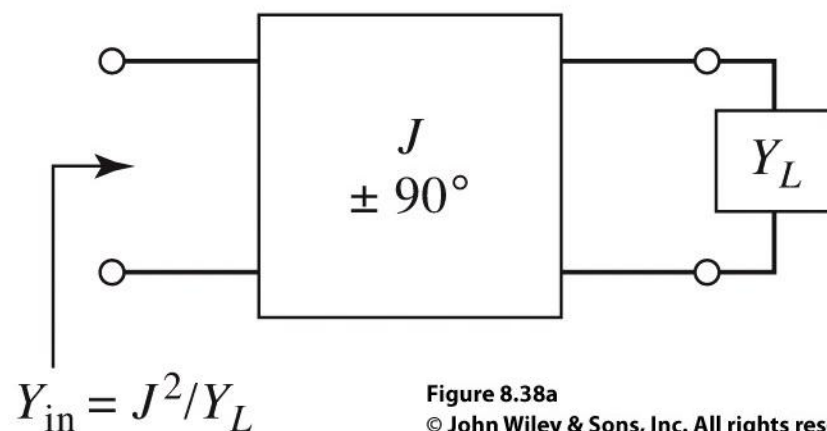


Figure 8.38a

Impedance and Admittance Inverters

- The simplest example of impedance and admittance inverter is the **quarter-wave transformer** (L3)

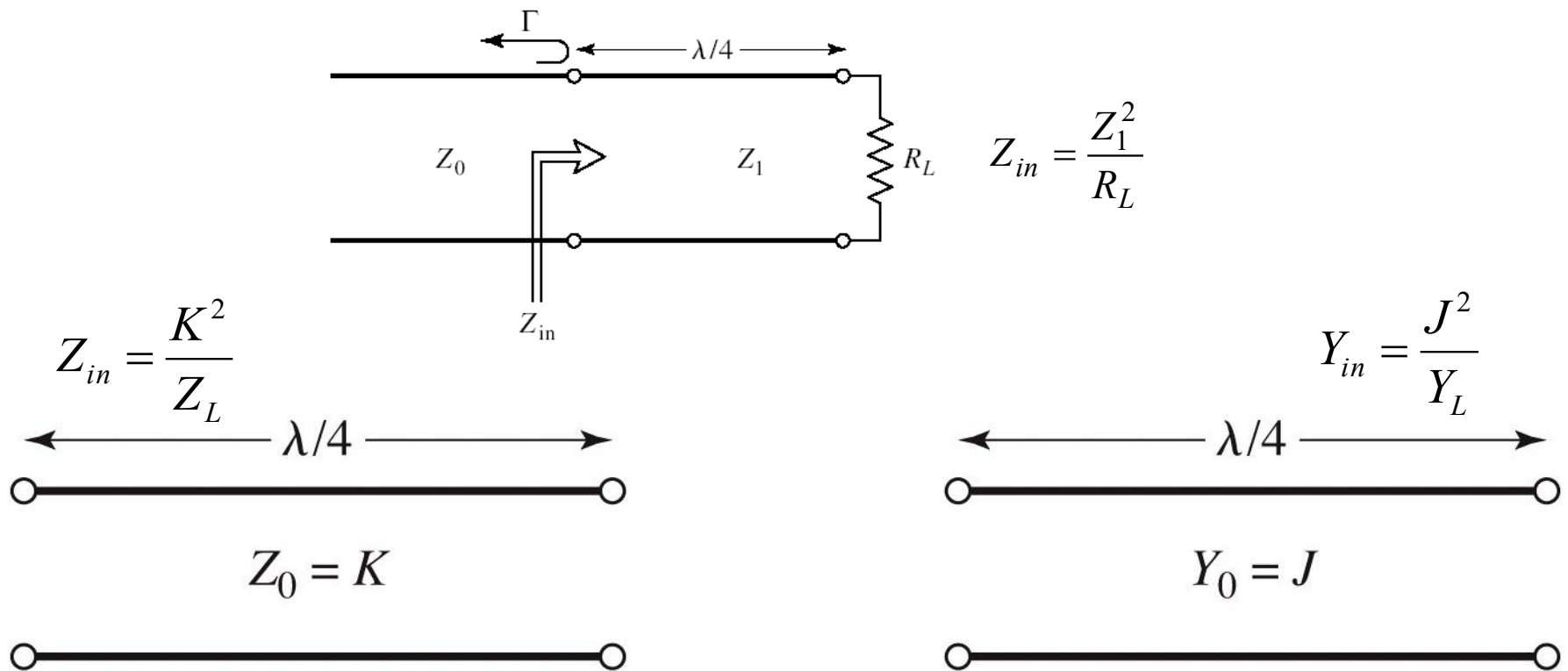
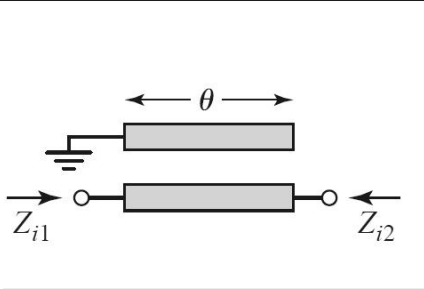
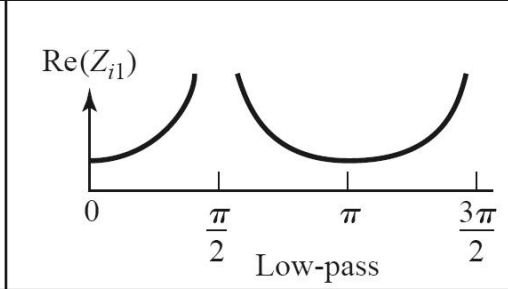
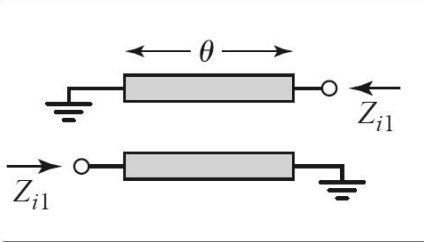
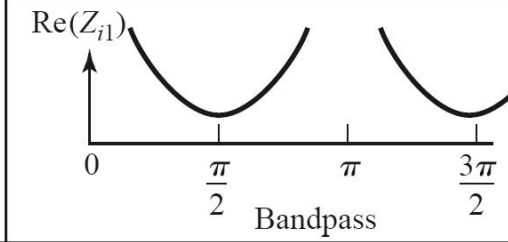
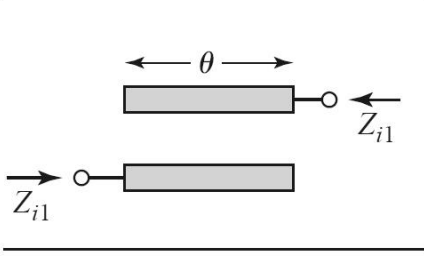
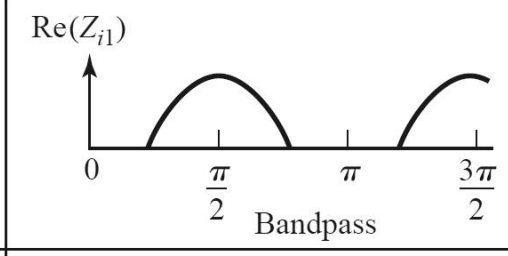
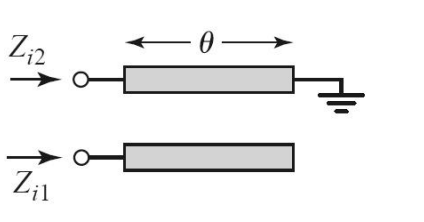
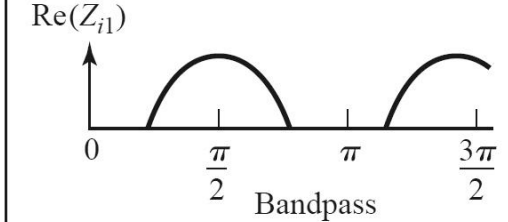


Figure 8.38b
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Coupled Line Filters

Circuit	Image Impedance	Response
	$Z_{i1} = \frac{2Z_{0e}Z_{0o} \cos \theta}{\sqrt{(Z_{0e} + Z_{0o})^2 \cos^2 \theta - (Z_{0e} - Z_{0o})^2}}$ $Z_{i2} = \frac{Z_{0e}Z_{0o}}{Z_{i1}}$	 <p style="text-align: center;">Low-pass</p>
	$Z_{i1} = \frac{2Z_{0e}Z_{0o} \sin \theta}{\sqrt{(Z_{0e} - Z_{0o})^2 - (Z_{0e} + Z_{0o})^2 \cos^2 \theta}}$	 <p style="text-align: center;">Bandpass</p>
	$Z_{i1} = \frac{\sqrt{(Z_{0e} - Z_{0o})^2 - (Z_{0e} + Z_{0o})^2 \cos^2 \theta}}{2 \sin \theta}$	 <p style="text-align: center;">Bandpass</p>
	$Z_{i1} = \frac{\sqrt{Z_{0e}Z_{0o}} \sqrt{(Z_{0e} - Z_{0o})^2 - (Z_{0e} + Z_{0o})^2 \cos^2 \theta}}{(Z_{0e} + Z_{0o}) \sin \theta}$ $Z_{i2} = \frac{Z_{0e}Z_{0o}}{Z_{i1}}$	 <p style="text-align: center;">Bandpass</p>



Coupled Line Filters

- Bandpass filter with resonance at $\theta = \pi/2$ ($l = \lambda/4$)

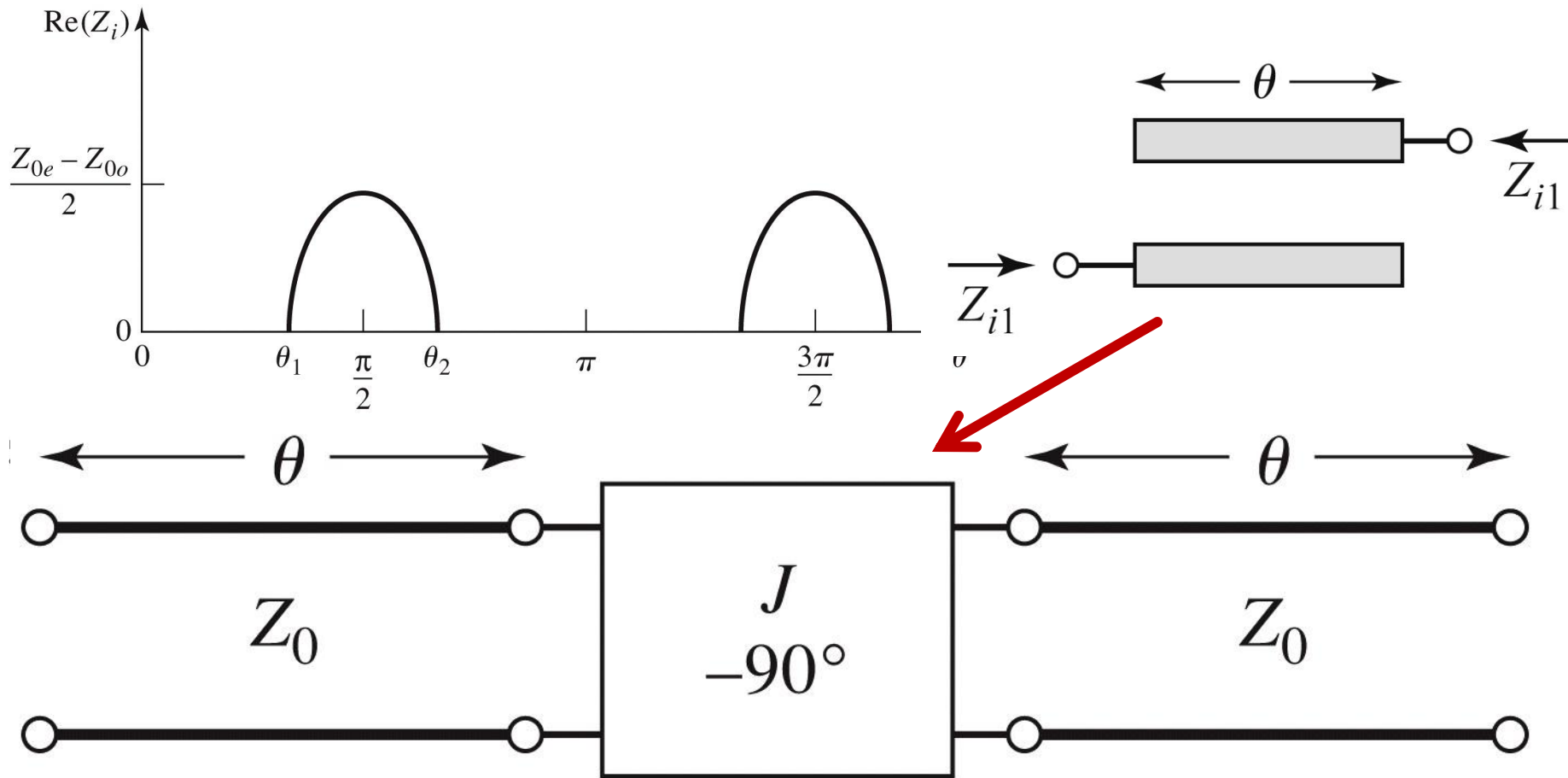
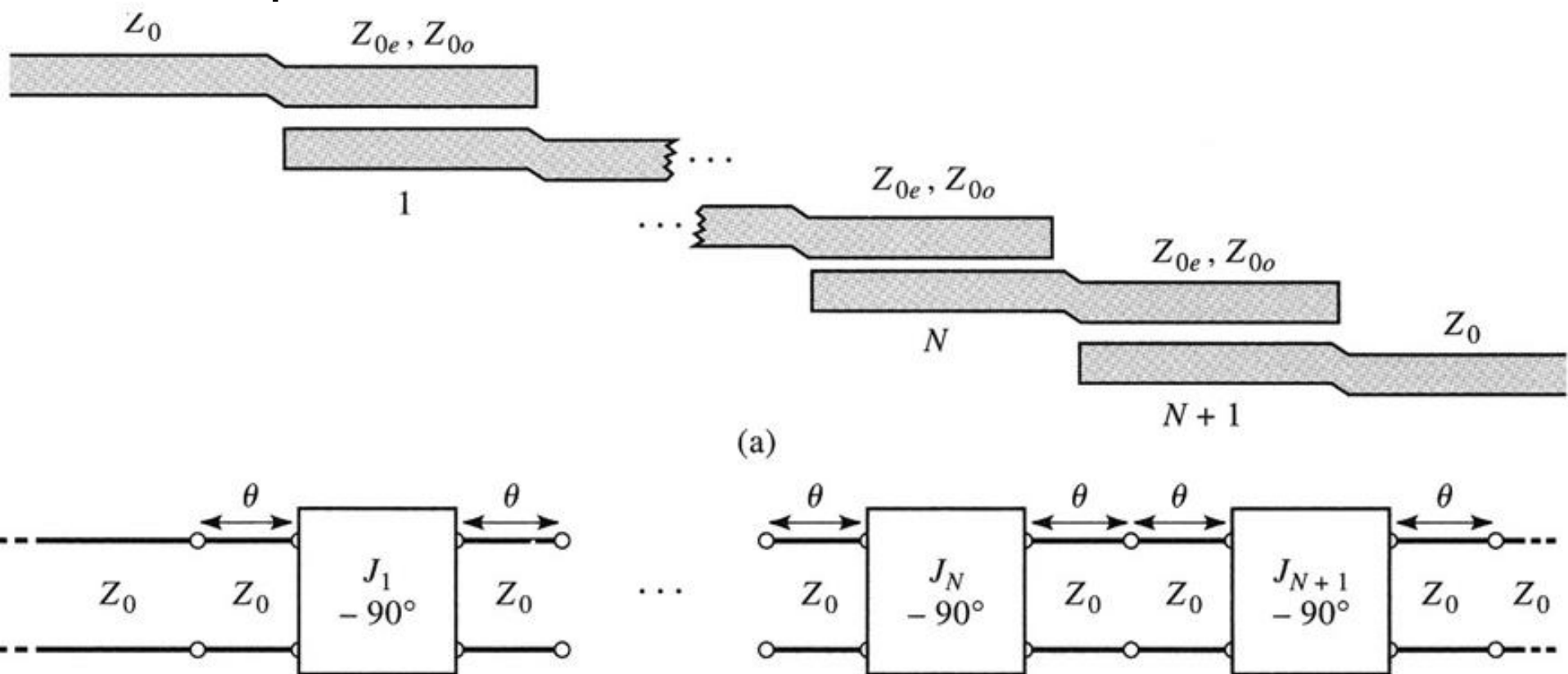


Figure 8.44

Coupled Line Filters

- We get a N^{th} order filter with $N+1$ parallel coupled line section



Example

- Similar to a project assignment
- Follows the amplifier designed as in L10
- **4th** order bandpass filter, $f_0 = 5\text{GHz}$, fractional bandwidth of the passband 10 %
- 0.5dB equal-ripple table for g_n followed by filter design formulas

n	g	ZoJn	Zoe	Zoo
1	1.6703	0.306664	70.04	39.37
2	1.1926	0.111295	56.18	45.05
3	2.3661	0.09351	55.11	45.76
4	0.8419	0.111294	56.18	45.05
5	1.9841	0.306653	70.03	39.37

Continue

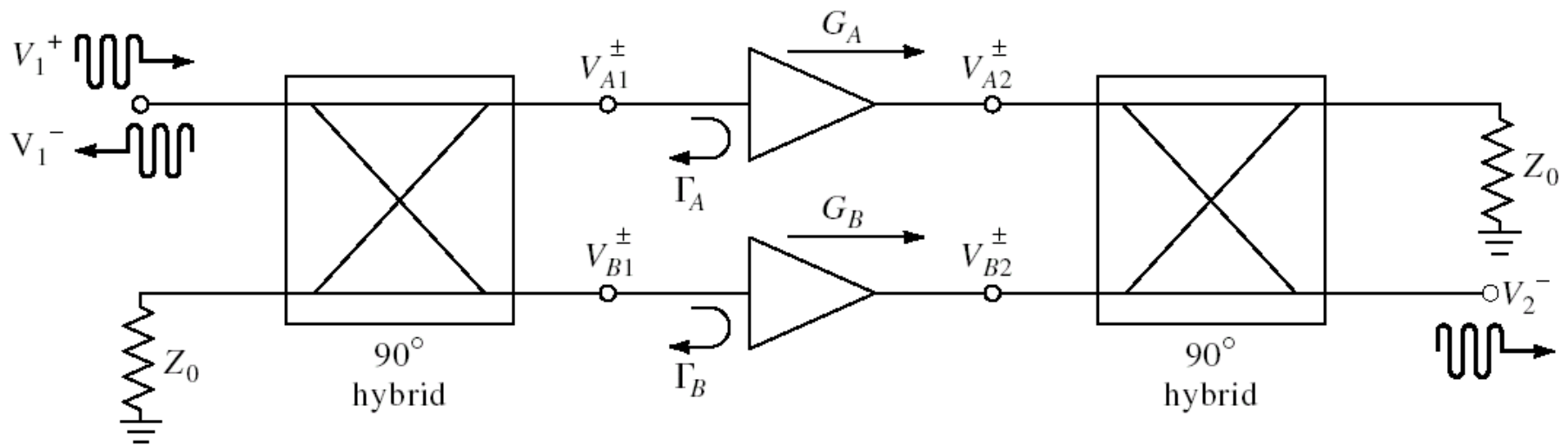
Microwave Amplifiers

Broadband amplifiers

Broadband/Wideband amplifiers

- Achieved by some design techniques (only at the expense of gain, complexity)
 1. Compensated matching networks
 2. Resistive matching networks
 3. Negative feedback
 4. Balanced amplifiers
 5. Distributed amplifiers
 6. Differential amplifiers

Balanced amplifiers



- two identical amplifiers with two hybrid couplers
3 dB / 90° to cancel input and output reflections

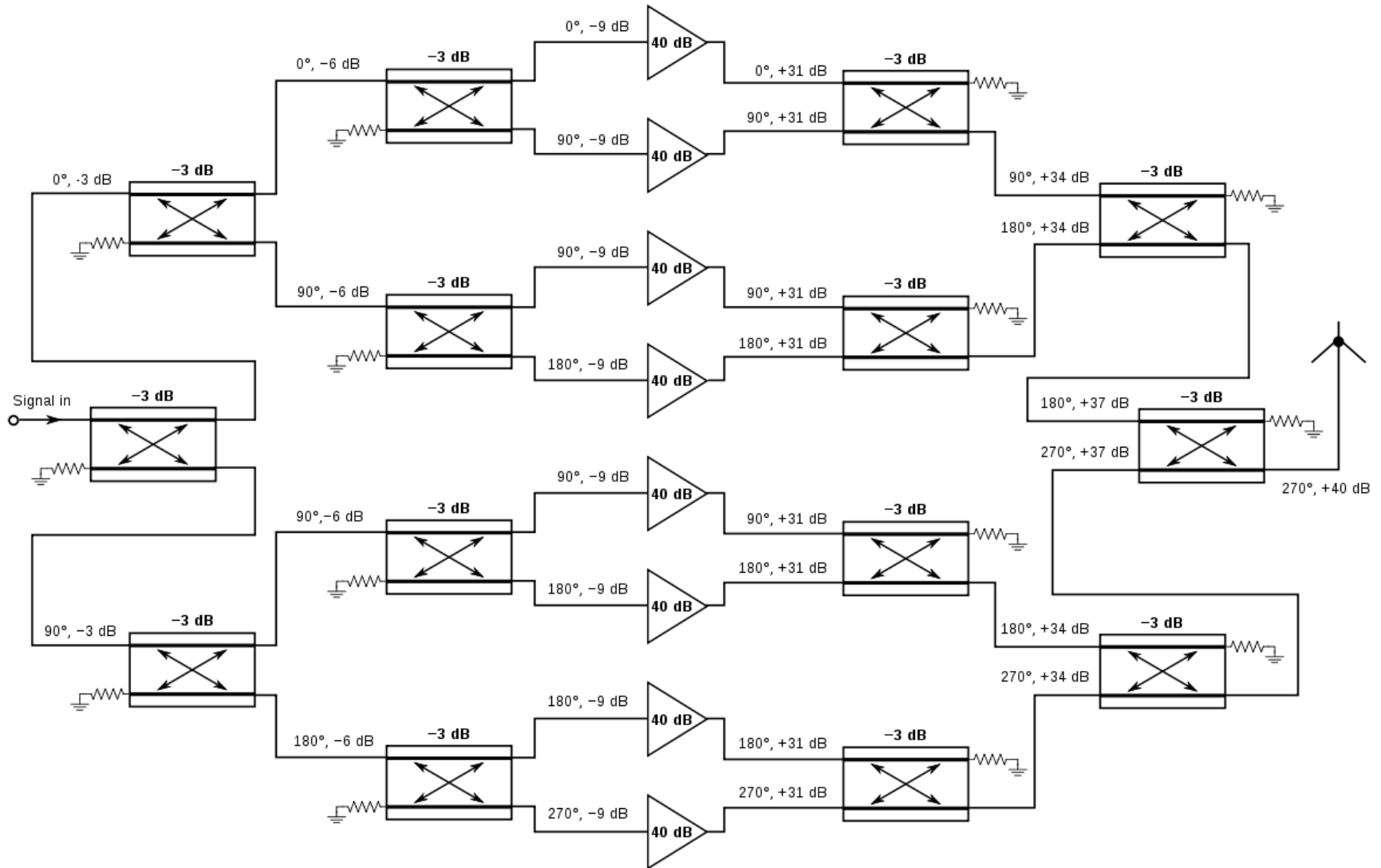
$$S_{21} = \frac{-j}{2} \cdot (G_A + G_B)$$

$$S_{21}|_{A=B} = -j \cdot G$$

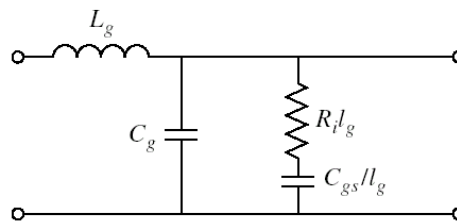
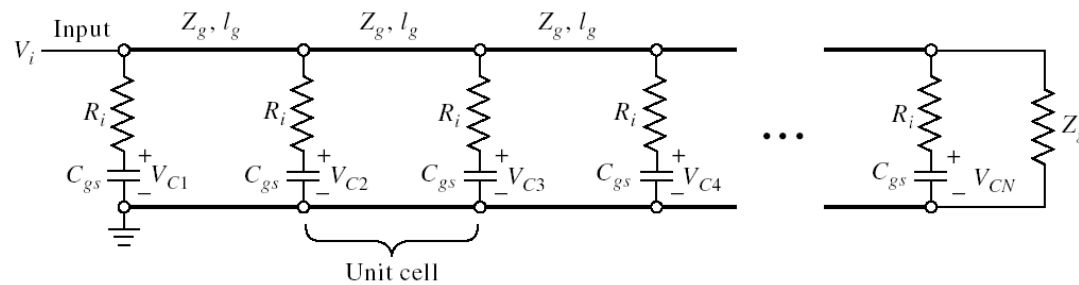
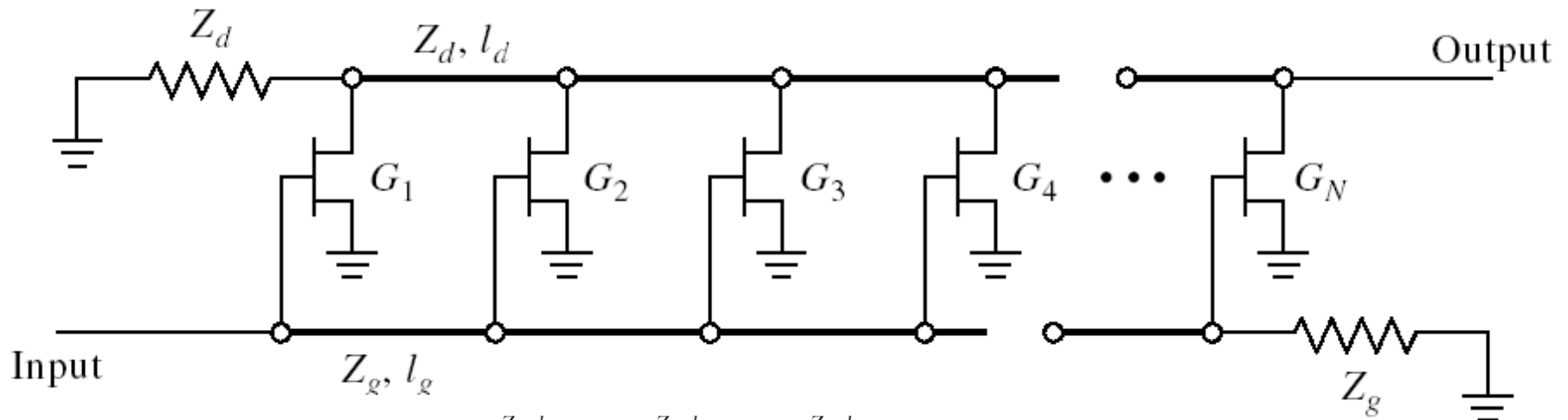
$$S_{11} = \frac{1}{2} \cdot (\Gamma_A - \Gamma_B) \quad F = \frac{1}{2} \cdot (F_A + F_B)$$

$$S_{11}|_{A=B} = 0$$

Balanced amplifiers



Distributed amplifiers



(b)

Distributed amplifiers

- the phase delays on the gate (input) and drain (output) lines are synchronized

$$\gamma_g = \alpha_g + j \cdot \beta_g \quad \gamma_d = \alpha_d + j \cdot \beta_d \quad \beta_g \cdot l_g = \beta_d \cdot l_d$$

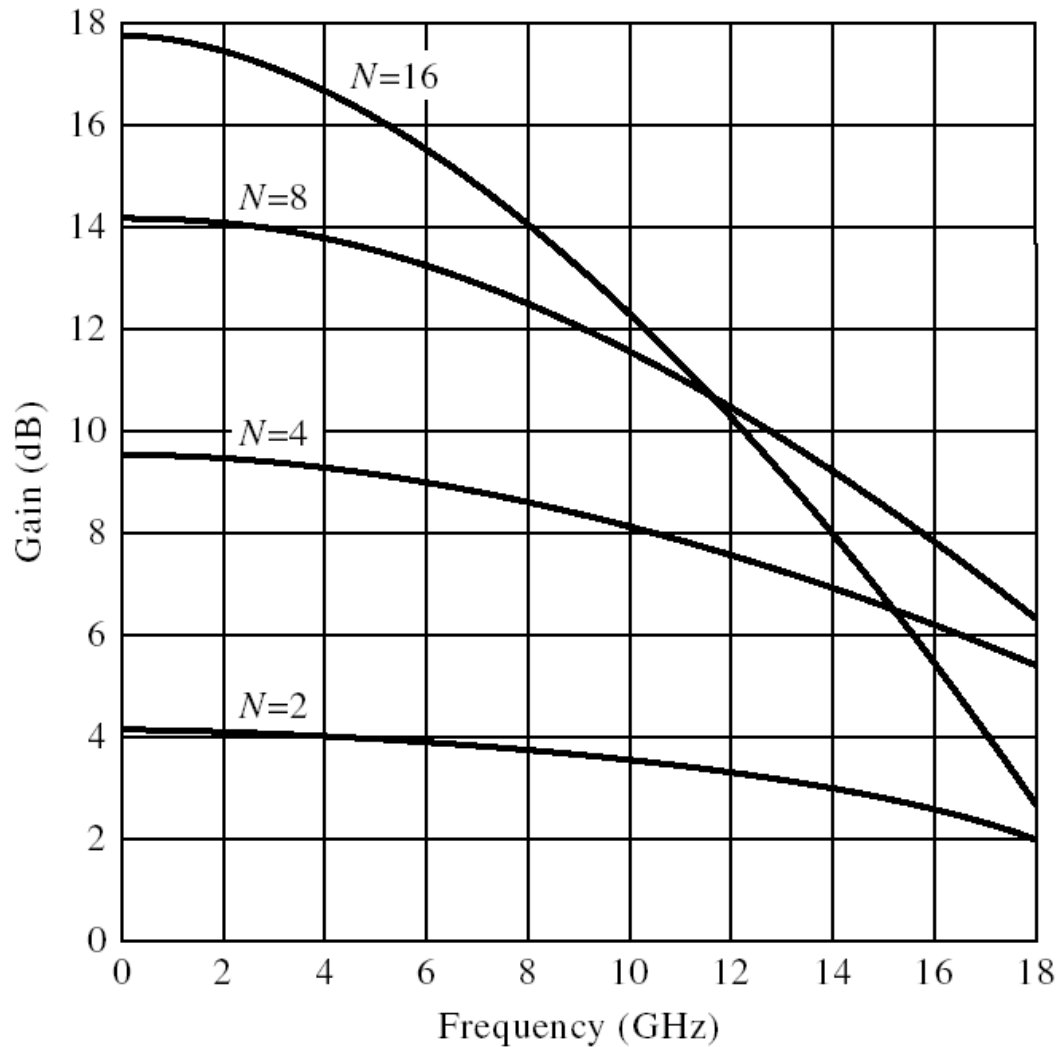
- Power gain

$$G = \frac{g_m^2 \cdot Z_d \cdot Z_g}{4} \cdot \frac{\left(e^{-N \cdot \alpha_g \cdot l_g} - e^{-N \cdot \alpha_d \cdot l_d} \right)^2}{\left(e^{-\alpha_g \cdot l_g} - e^{-\alpha_d \cdot l_d} \right)^2}$$

- Lossless power gain

$$G = \frac{g_m^2 \cdot Z_d \cdot Z_g \cdot N^2}{4}$$

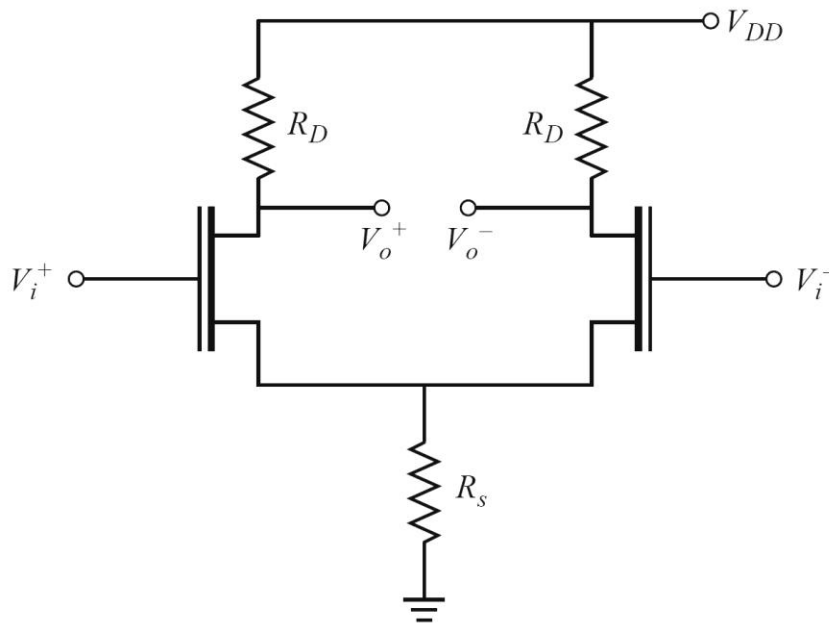
Distributed amplifiers



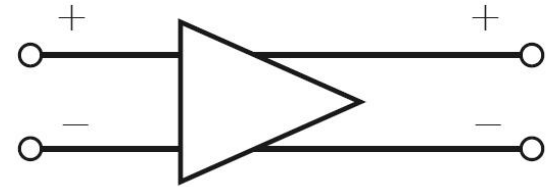
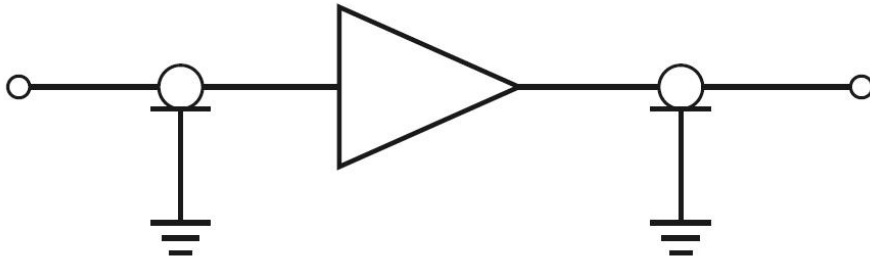
$$N_{opt} = \frac{\ln(\alpha_g \cdot l_g) - \ln(\alpha_d \cdot l_d)}{\alpha_g \cdot l_g - \alpha_d \cdot l_d}$$

Differential amplifiers

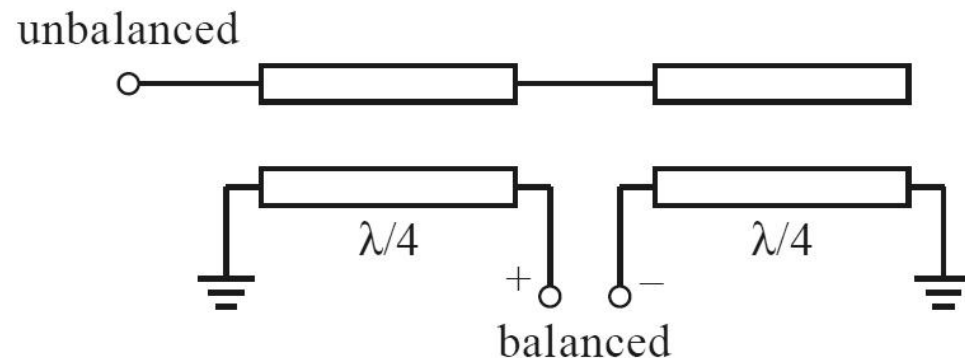
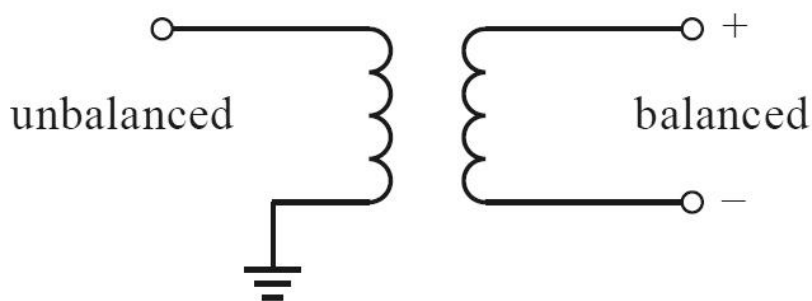
- In differential mode the input capacitances of the two transistors are connected in series
- Unity gain frequency is doubled



Differential amplifiers

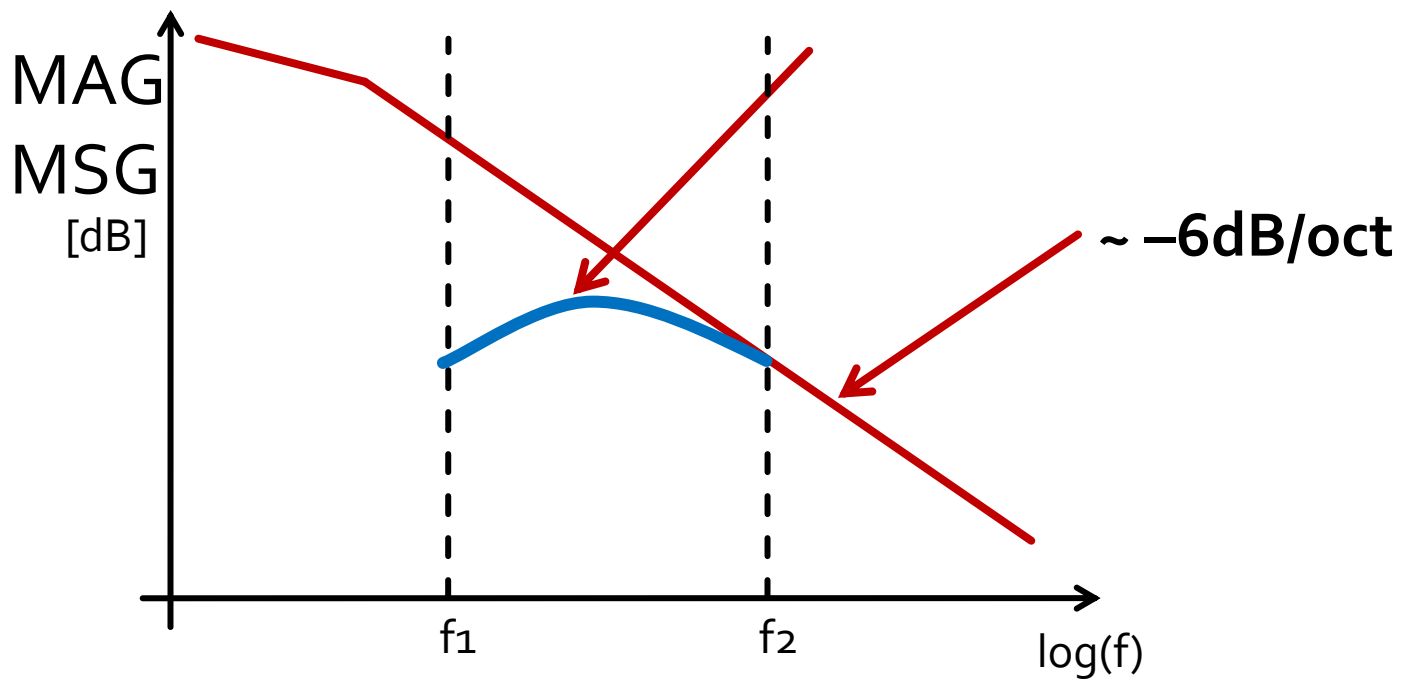


- We use circuits to transition from an unbalanced signal to a balanced signal (or vice versa)
 - hybrid couplers $3\text{dB} / 180^\circ$
 - "balun" (balanced - unbalanced)



Compensated matching networks

- Control the design of the matching networks at more (at least 2) frequencies and impose the same gain

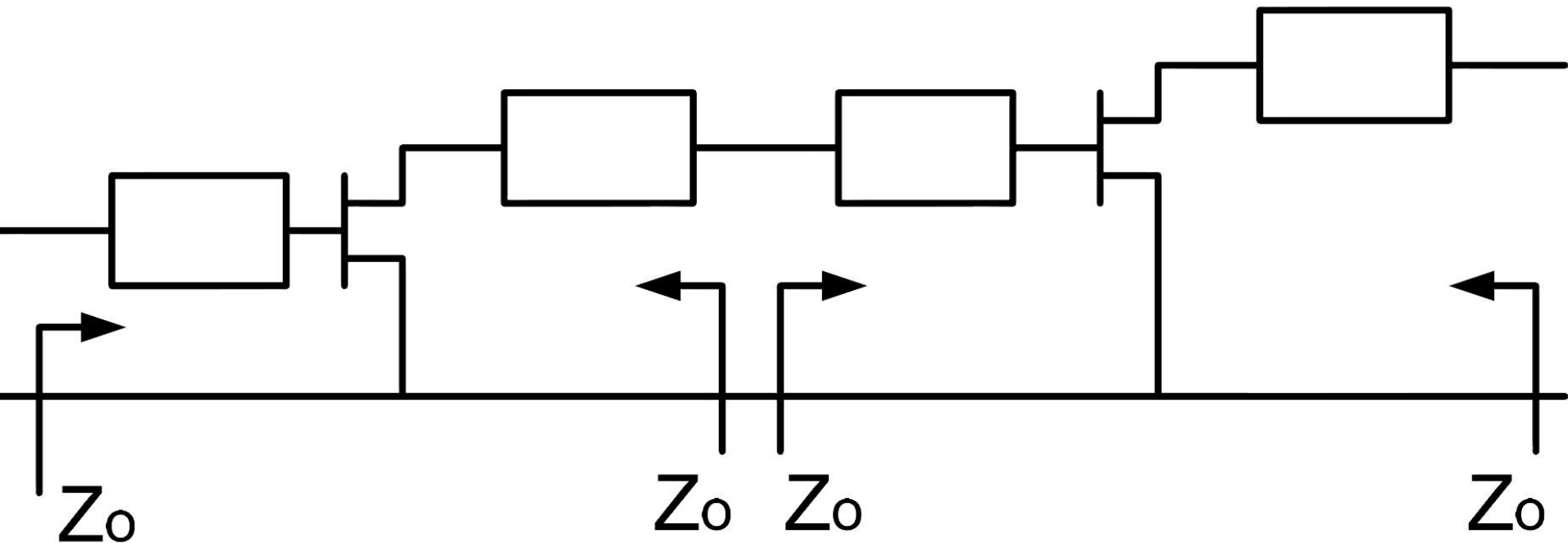


Microwave Amplifiers

Multistage Amplifier Design

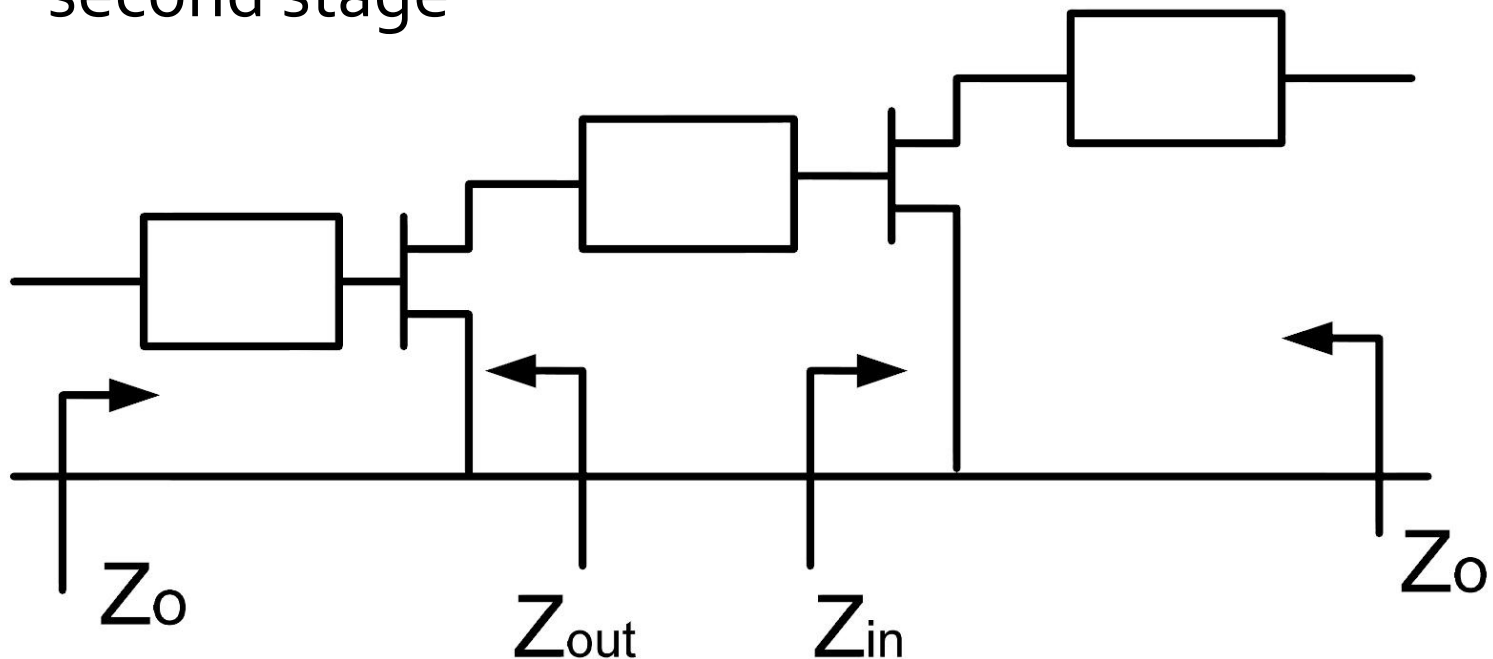
Multistage amplifiers

- Interstage matching can be designed in two modes:
 - Each stage is matched to a virtual $\Gamma = 0$



Multistage amplifiers

- Interstage matching can be designed in two modes:
 - One stage is matched to offer necessary Γ for the second stage

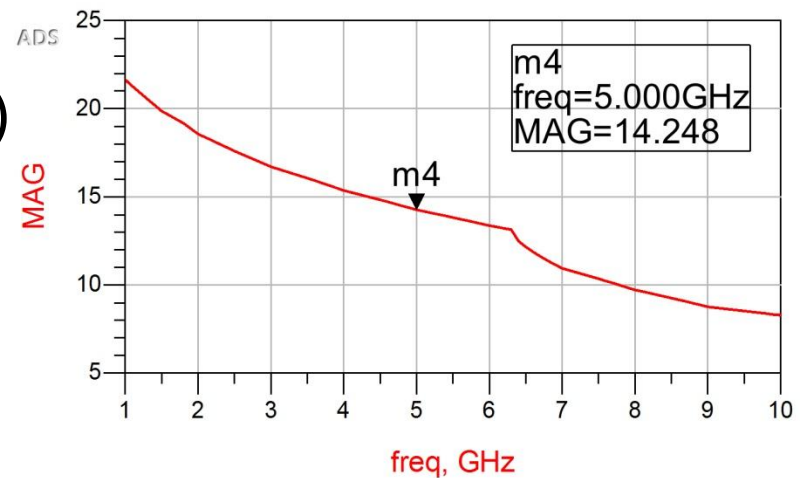
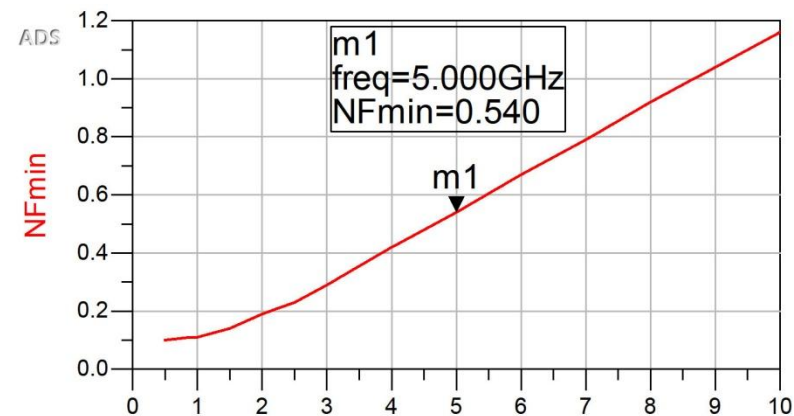


Example multistage LNA

- Similar to the project assignment
- LNA using ATF-34143 providing:
 - $G = 20\text{dB}$
 - $F = 1\text{dB}$
 - $@f = 5\text{GHz}$

Example

- ATF-34143 at $V_{ds}=3V$ $I_d=20mA$.
- @5GHz
 - $S_{11} = 0.64 \angle 139^\circ$
 - $S_{12} = 0.119 \angle -21^\circ$
 - $S_{21} = 3.165 \angle 16^\circ$
 - $S_{22} = 0.22 \angle 146^\circ$
 - $F_{min} = 0.54$ (typically[dB] !)
 - $\Gamma_{opt} = 0.45 \angle 174^\circ$
 - $r_n = 0.03$



Example, LNA @ 5 GHz

- ATF-34143 at $V_{ds}=3V$ $I_d=20mA$.
- @5GHz
 - $S_{11} = 0.64 \angle 139^\circ$
 - $S_{12} = 0.119 \angle -21^\circ$
 - $S_{21} = 3.165 \angle 16^\circ$
 - $S_{22} = 0.22 \angle 146^\circ$
 - $F_{min} = 0.54$ (tipic [dB])
 - $\Gamma_{opt} = 0.45 \angle 174^\circ$
 - $r_n = 0.03$

```
IATF-34143
IS-PARAMETERS at Vds=3V Id=20mA. LAST UPDATED 01-29-99

# ghz s ma r 50

2.0 0.75 -126 6.306 90 0.088 23 0.26 -120
2.5 0.72 -145 5.438 75 0.095 15 0.25 -140
3.0 0.69 -162 4.762 62 0.102 7 0.23 -156
4.0 0.65 166 3.806 38 0.111 -8 0.22 174
5.0 0.64 139 3.165 16 0.119 -21 0.22 146
6.0 0.65 114 2.706 -5 0.125 -35 0.23 118
7.0 0.66 89 2.326 -27 0.129 -49 0.25 91
8.0 0.69 67 2.017 -47 0.133 -62 0.29 67
9.0 0.72 48 1.758 -66 0.135 -75 0.34 46

!FREQ Fopt GAMMA OPT RN/Zo
!GHZ dB MAG ANG -
2.0 0.19 0.71 66 0.09
2.5 0.23 0.65 83 0.07
3.0 0.29 0.59 102 0.06
4.0 0.42 0.51 138 0.03
5.0 0.54 0.45 174 0.03
6.0 0.67 0.42 -151 0.05
7.0 0.79 0.42 -118 0.10
8.0 0.92 0.45 -88 0.18
9.0 1.04 0.51 -63 0.30
10.0 1.16 0.61 -43 0.46
```

Multistage amplifiers

- If we need more power gain than only one transistor can supply
 - design target 20dB
 - $MAG @ 5GHz = 14.248 \text{ dB} < 20\text{dB}$
- We use Friis formula to separate the target:
 - Power gain
 - Noise
- on two amplifier stages

Friis Formula (noise)

$$F_{cas} = F_1 + \frac{F_2 - 1}{G_1} + \frac{F_3 - 1}{G_1 \cdot G_2} + \frac{F_4 - 1}{G_1 \cdot G_2 \cdot G_3} + \dots$$

- Effects of Friis Formula:
 - it's essential that the first stage is as **noiseless** as possible even if that means sacrificing power
 - the second stage can be optimized for power **gain**
- Friis Formula **must** be used in **linear scale!**
- **Avago/Broadcom AppCAD**
 - AppCAD Free Design Assistant Tool for Microsoft Windows → Google

Friis Formula (noise)

$$G_{cas} = G_1 \cdot G_2$$

$$F_{cas} = F_1 + \frac{1}{G_1} (F_2 - 1)$$

- Friis formula
 - first stage: low noise factor, probably resulting in a smaller gain
 - second stage: high gain, probably resulting in higher noise factor
- It's essential to introduce a design margin (reserve: ΔF , ΔG)
 - $G = G_{design} + \Delta G$
 - $F = F_{design} - \Delta F$
- Interpretation of the design target
 - $G > G_{design}$, better, but it's not required to sacrifice other parameters to maximize the gain
 - $F < F_{design}$, better, the smaller the better, we must target **the smallest possible noise** factor as long as the other design parameters **are met**

Friis Formula (noise)

- Friis formula
 - first stage: low noise factor, probably resulting in a smaller gain
 - second stage: high gain, probably resulting in higher noise factor
- Separation of the design parameters on the 2 amplification stages (Estimated!)
 - input stage: $F_1 = 0.7$ dB, $G_1 = 9$ dB
 - output stage: $F_2 = 1.2$ dB, $G_2 = 13$ dB
- To verify the result apply Friis formula
- First transform to **linear scale !**

$$F_1 = 10^{\frac{F_1[dB]}{10}} = 10^{0.07} = 1.175$$

$$F_2 = 10^{\frac{F_2[dB]}{10}} = 10^{0.12} = 1.318$$

$$F_{cas} = F_1 + \frac{1}{G_1} (F_2 - 1) = 1.215$$

$$F_{cas} = 10 \cdot \log(1.215) = 0.846 \text{ dB}$$

$$G_1 = 10^{\frac{G_1[dB]}{10}} = 10^{0.9} = 7.943$$

$$G_2 = 10^{\frac{G_2[dB]}{10}} = 10^{1.3} = 19.953$$

$$G_{cas} = G_1 \cdot G_2 = 158.49$$

$$G_{cas} = 10 \cdot \log(158.49) = 22 \text{ dB}$$

Friis Formula (noise)

- Avago/Broadcom AppCAD

The screenshot shows the AppCAD - [NoiseCalc] software interface. The window title is "AppCAD - [NoiseCalc]". The menu bar includes "File", "Calculate", "Application Examples", "Options", and "Help". The main window is titled "NoiseCalc" and features a "Set Number of Stages" field set to "2" and a "Calculate [F4]" button.

The central table displays the results for two stages:

Stage Data	Units	Stage 1	Stage 2
Stage Name:		Avago Duplexer	Avago ATF-36xxx
Noise Figure	dB	0.7	1.2
Gain	dB	9	13
Output IP3	dBm	100	14.5
dNF/dTemp	dB/°C	0	0
dG/dTemp	dB/°C	0	0
Stage Analysis:			
NF (Temp corr)	dB	0.70	1.20
Gain (Temp corr)	dB	9.00	13.00
Input Power	dBm	-50.00	-41.00
Output Power	dBm	-41.00	-28.00
d NF/d NF	dB/dB	0.97	0.15
d NF/d Gain	dB/dB	-0.03	0.00
d IP3/d IP3	dBm/dBm	0.00	1.00

Below the table, there are three sections for system parameters and analysis:

Enter System Parameters:

Input Power	-50	dBm
Analysis Temperature	25	°C
Noise BW	1	MHz
Ref Temperature	25	°C
S/N (for sensitivity)	10	dB
Noise Source (Ref)	290	*K

System Analysis:

Gain =	22.00	dB
Noise Figure =	0.85	dB
Noise Temp =	82.34	*K
SNR =	63.13	dB
MDS =	-113.13	dBm
Sensitivity =	-103.13	dBm
Noise Floor =	-173.13	dBm/Hz

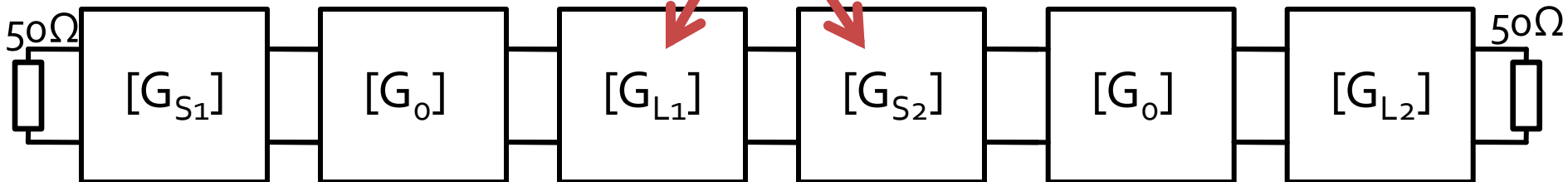
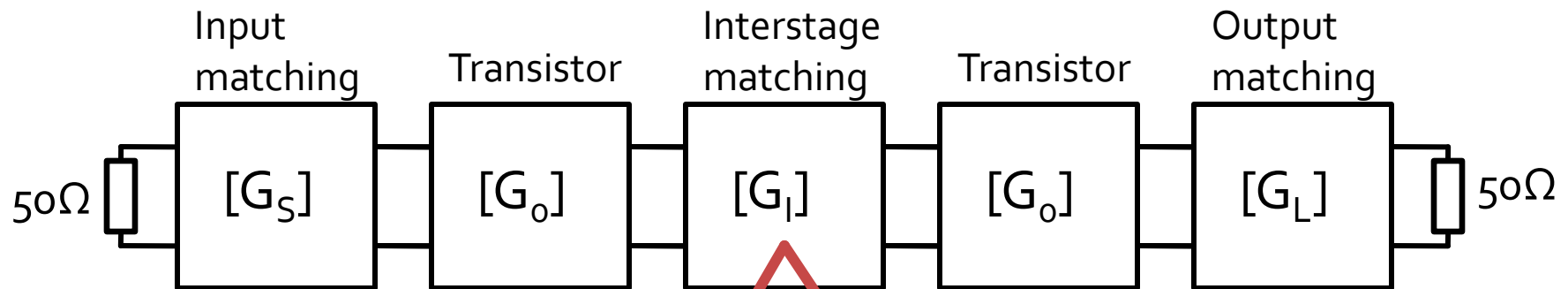
System Analysis (continued):

Input IP3 =	-7.50	dBm
Output IP3 =	14.50	dBm
Input IM level =	-135.00	dBm
Input IM level =	-85.00	dBc
Output IM level =	-113.00	dBm
Output IM level =	-85.00	dBc
SFDR =	70.42	dB

Multistage amplifier design

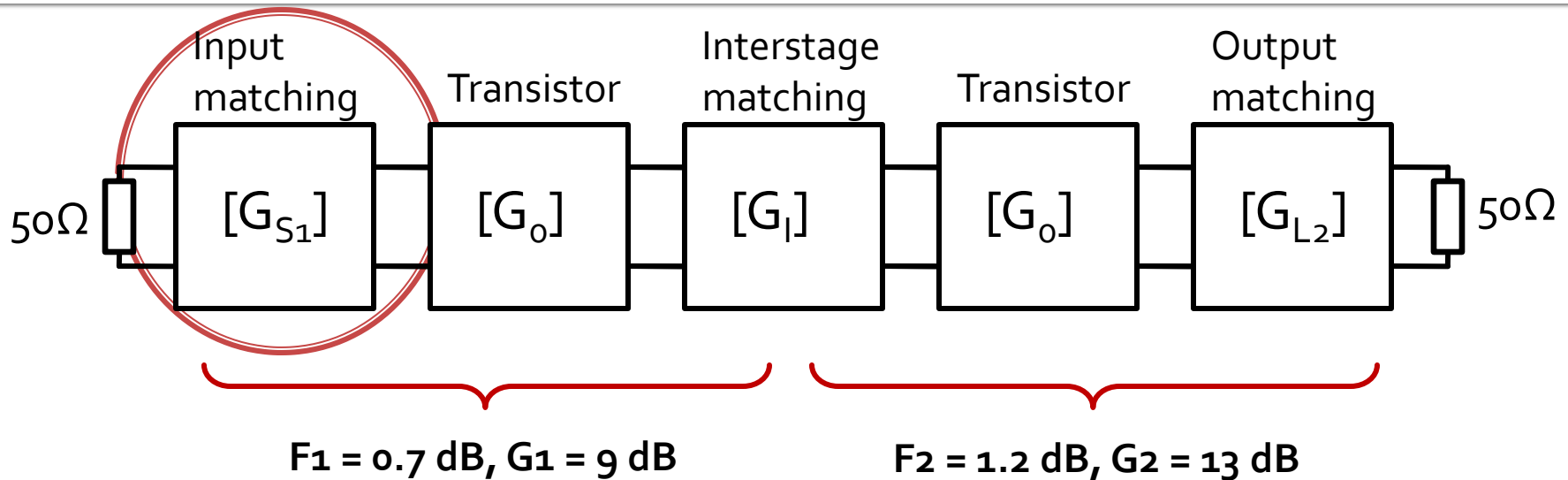
- Separation of the design parameters on the 2 amplification stages (Estimated!)
 - input stage: $F_1 = 0.7$ dB, $G_1 = 9$ dB
 - output stage: $F_2 = 1.2$ dB, $G_2 = 13$ dB
 - total: $F = 0.85$ dB, $G = 22$ dB
- Meets design specifications (with design margin)
- We can reuse some of the results in the single stage LNA design (Lecture 10)
 - input matching can be used for the input of the first stage – very low noise, good enough power gain
 - output matching was designed for maximum gain, can be used for the output of the second stage
 - input and output matching were designed for 50Ω source and load, similar to current conditions

Multistage amplifier design



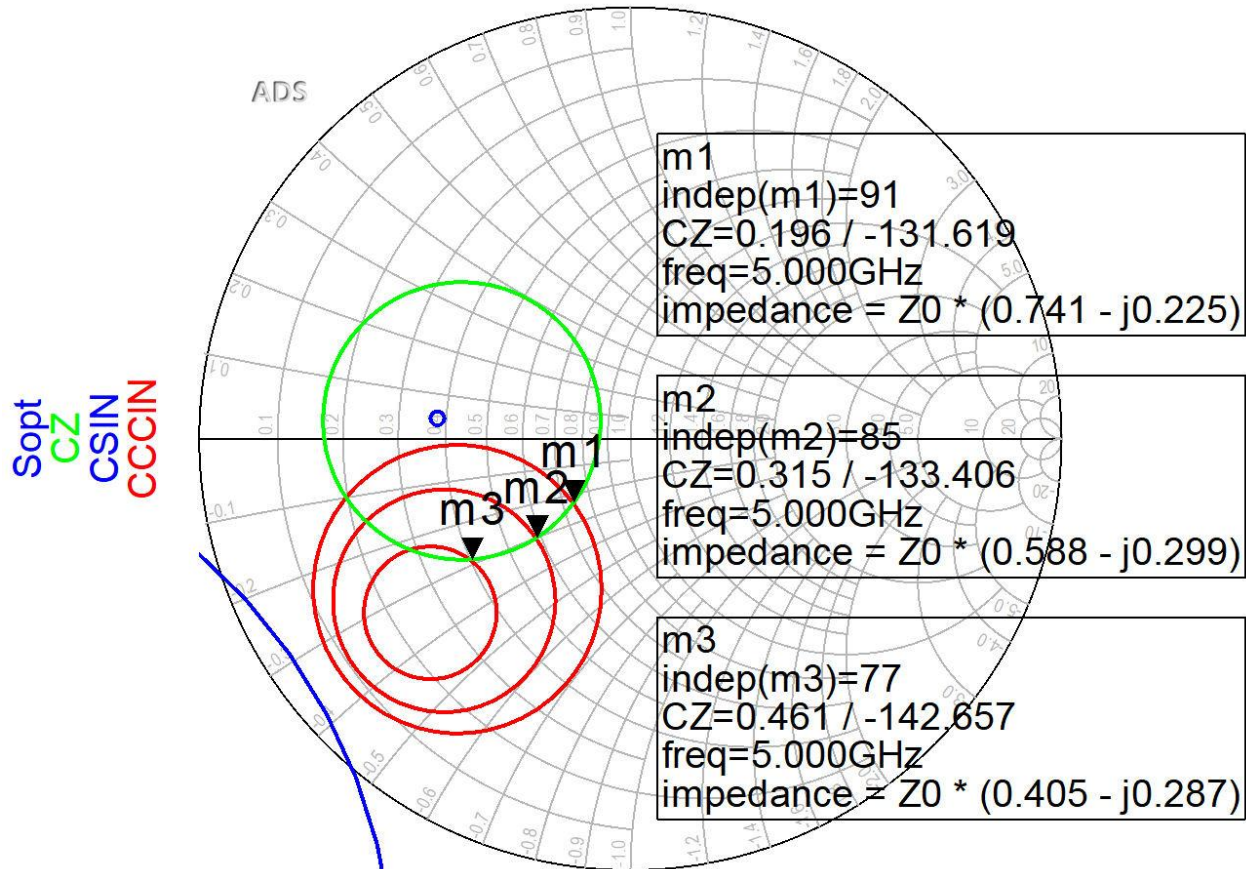
- Gain computation
 - Interstage matching can supplement the gain for both amplifier stages
 - The design for input and output matching must be achieved on a single transistor schematic (recommended: easier)

Input matching stage 1 (S₁)



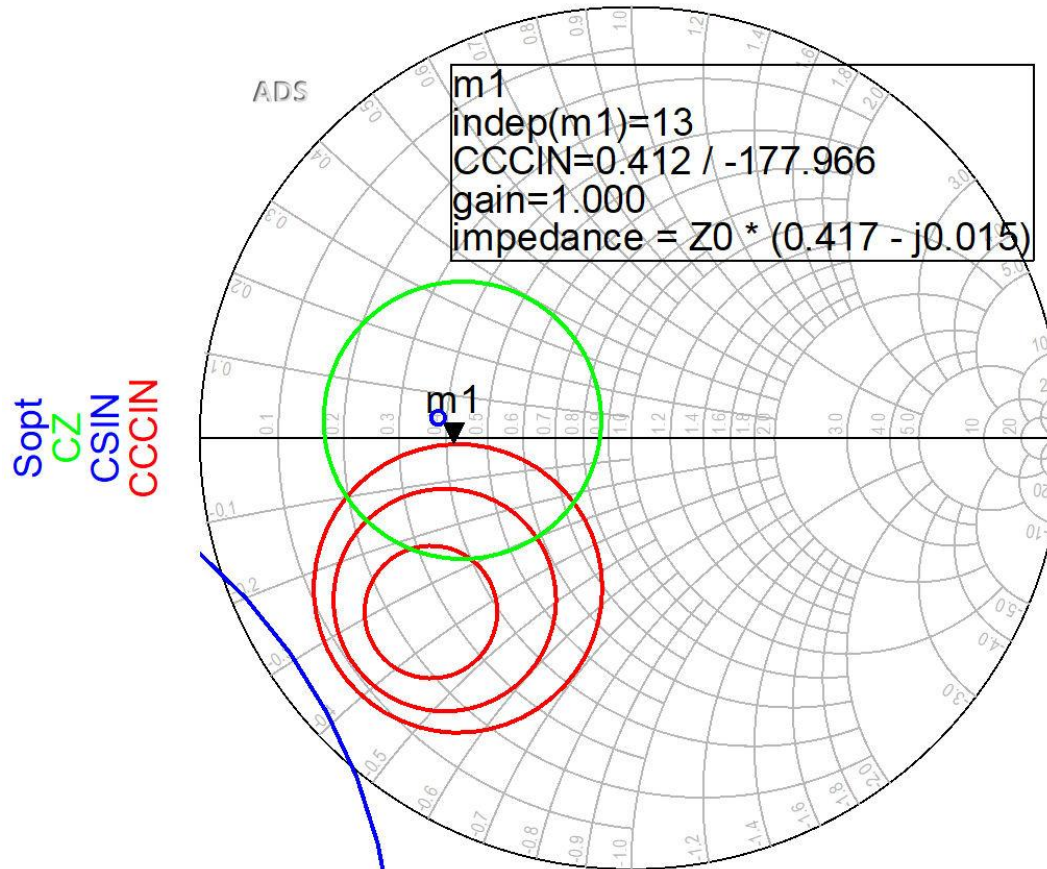
- We favor optimization for **noise** (low/minimum)
- Also considered
 - Power gain (can be lower, but not too much)
 - Bandwidth (through Q , quality factor)
 - Stability

Input matching stage 1 (S₁)



- For the input matching circuit
 - noise circle CZ: 0.75dB
 - input constant gain circles CCCIN: 1dB, 1.5dB, 2 dB
- We choose (small Q → wide bandwidth) position m₁

Input matching stage 1 (S₁)



- If we can afford a 1.2dB decrease of the input gain for better NF, Q (Gs = 1 dB), position m1 above is better
- We favor **better** (smaller) **NF**

Input matching stage 1 (S₁)

- **G_{S1}**: Position m₁ in complex plane, **1dB**

$$\Gamma_S = 0.412 \angle -178^\circ$$

$$|\Gamma_S| = 0.412; \quad \varphi = -178^\circ$$

$$\cos(\varphi + 2\theta) = -|\Gamma_S|$$

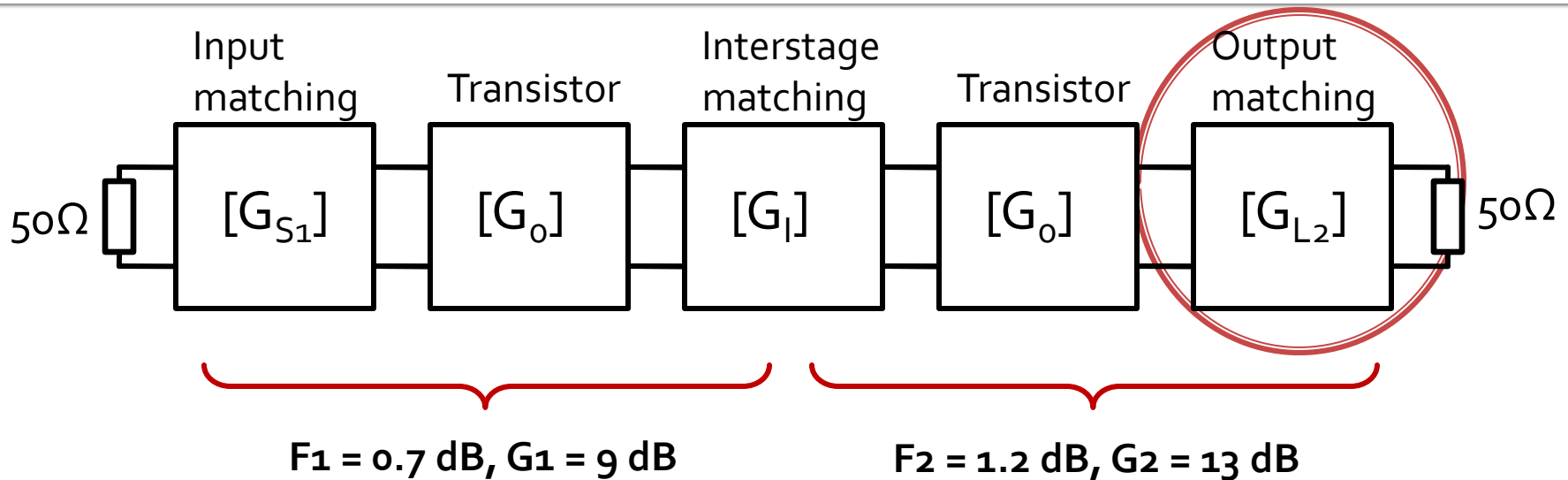
$$\text{Im}[y_S(\theta)] = \frac{\mp 2 \cdot |\Gamma_S|}{\sqrt{1 - |\Gamma_S|^2}}$$

$$\cos(\varphi + 2\theta) = -0.412 \Rightarrow (\varphi + 2\theta) = \pm 114.33^\circ$$

$$\theta_{sp} = \tan^{-1}(\text{Im}[y_S(\theta)]) = \tan^{-1}\left(\frac{\mp 2 \cdot |\Gamma_S|}{\sqrt{1 - |\Gamma_S|^2}}\right)$$

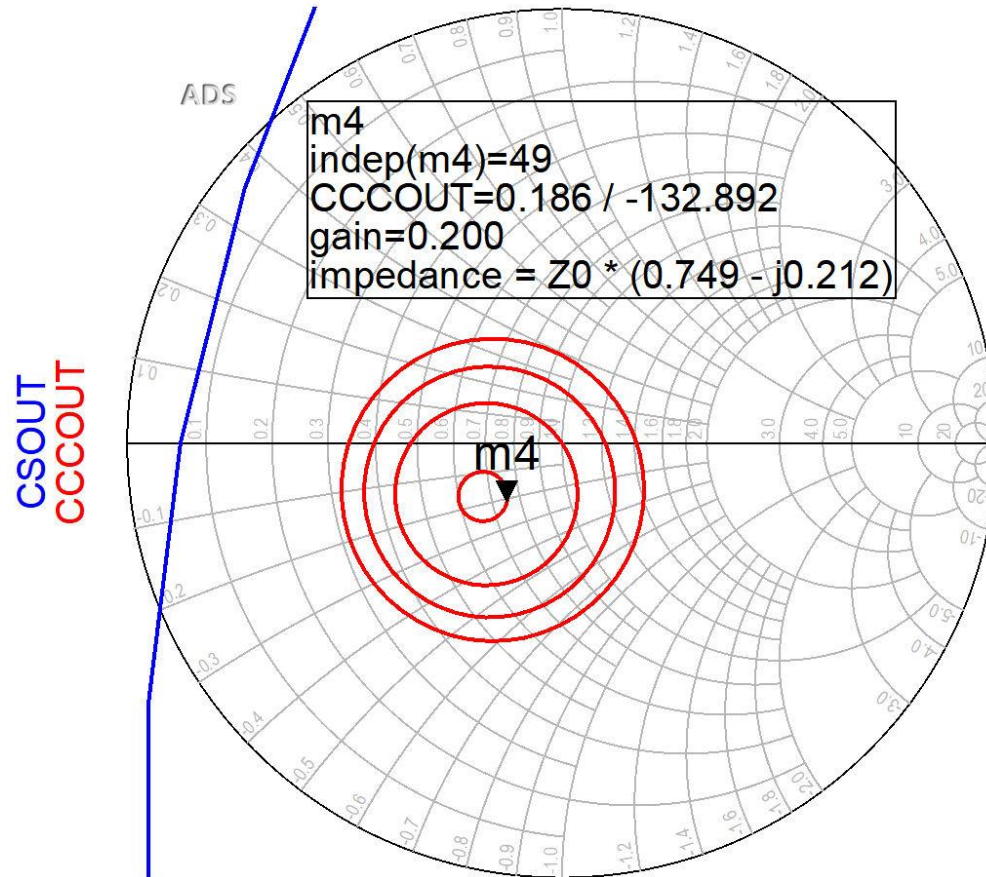
$$(\varphi + 2\theta) = \begin{cases} +114.33^\circ \\ -114.33^\circ \end{cases} \quad \theta = \begin{cases} 146.2^\circ \\ 31.8^\circ \end{cases} \quad \text{Im}[y_S(\theta)] = \begin{cases} -0.904 \\ +0.904 \end{cases} \quad \theta_{sp} = \begin{cases} 137.9^\circ \\ 42.1^\circ \end{cases}$$

Output matching stage 2 (L2)



- We favor optimization for **gain** (high/maximum)
- Also considered
 - Bandwidth (through Q , quality factor)
 - Stability
- noise is **not** an issue, output matching doesn't influence noise factor

Output matching stage 2 (L2)



- output constant gain circles CCCOUT: -0.4dB, -0.2dB, 0dB, +0.2dB
- The lack of noise restrictions allows optimization for better gain (close to maximum – position m4)

Output matching stage 2 (L2)

- $\mathbf{G_{L2}}$: Position m_4 in complex plane, **0.2dB**

$$\Gamma_L = 0.186 \angle -132.9^\circ$$

$$|\Gamma_L| = 0.186; \quad \varphi = -132.9^\circ$$

$$\cos(\varphi + 2\theta) = -|\Gamma_L|$$

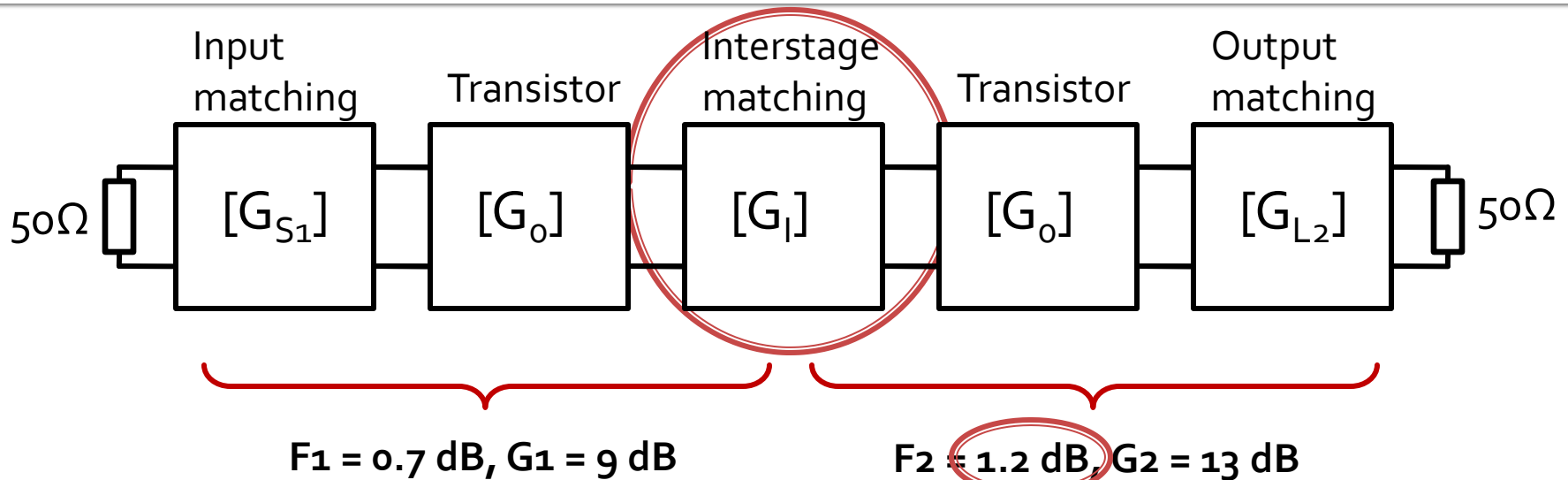
$$\text{Im}[y_L(\theta)] = \frac{-2 \cdot |\Gamma_L|}{\sqrt{1 - |\Gamma_L|^2}} = -0.379$$

$$\cos(\varphi + 2\theta) = -0.186 \Rightarrow (\varphi + 2\theta) = \pm 100.72^\circ$$

$$\theta_{sp} = \tan^{-1}(\text{Im}[y_L(\theta)]) = \tan^{-1}\left(\frac{\mp 2 \cdot |\Gamma_L|}{\sqrt{1 - |\Gamma_L|^2}}\right)$$

$$(\varphi + 2\theta) = \begin{cases} +100.72^\circ \\ -100.72^\circ \end{cases} \quad \theta = \begin{cases} 116.8^\circ \\ 16.1^\circ \end{cases} \quad \text{Im}[y_L(\theta)] = \begin{cases} -0.379 \\ +0.379 \end{cases} \quad \theta_{sp} = \begin{cases} 159.3^\circ \\ 20.7^\circ \end{cases}$$

Interstage matching (I)



- We take into account **gain** (high) but also **noise**
- Also considered
 - Bandwidth (through Q, quality factor)
 - Stability
- We influence the noise factor of the second stage, the noise must be considered but with less restrictive conditions (Friis shows that higher noise is acceptable).

Multistage amplifier

- Power gain

$$G_T [dB] = G_{S1} [dB] + G_0 [dB] + G_I [dB] + G_0 [dB] + G_{L2} [dB]$$

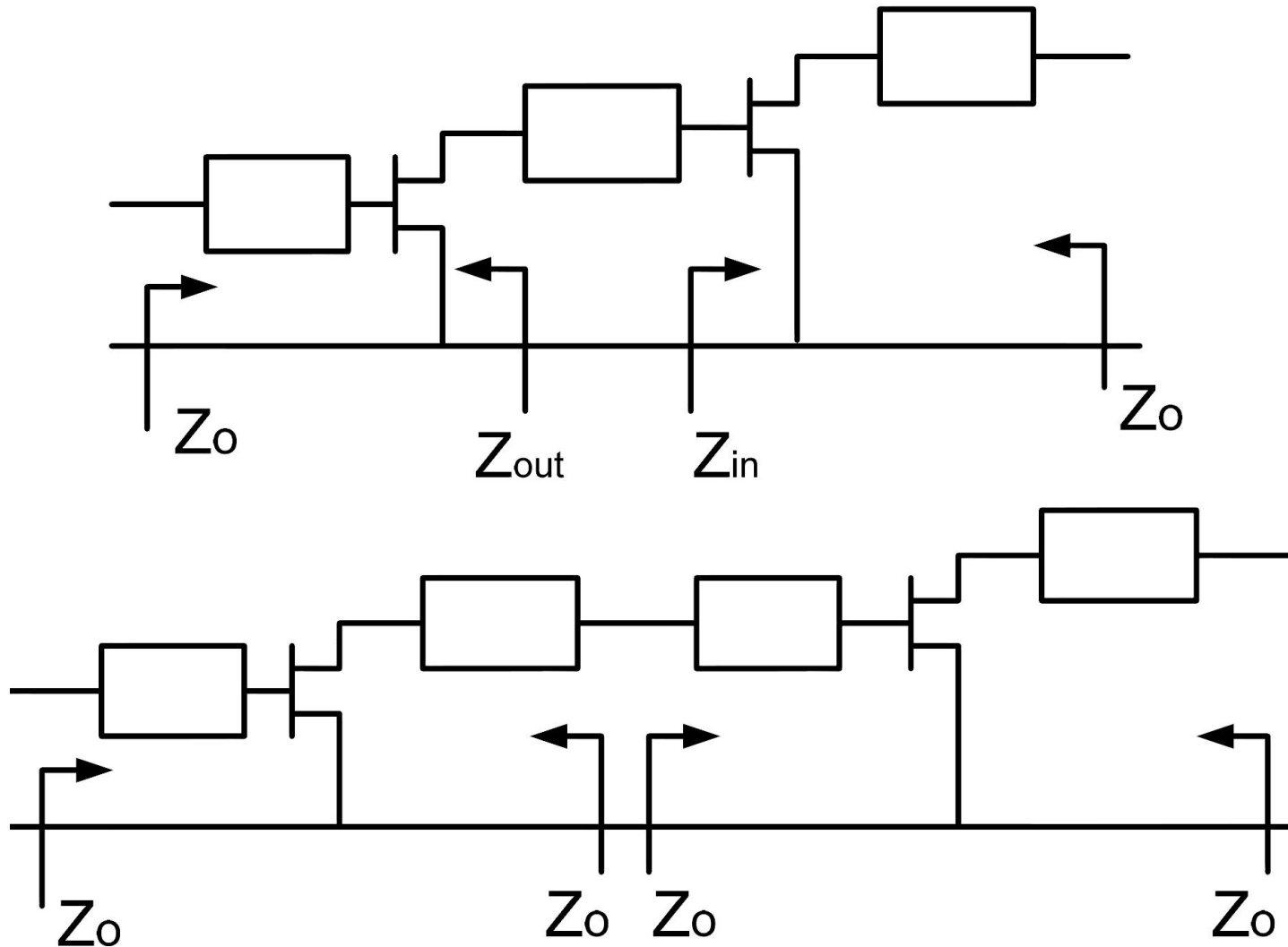
$$G_0 = |S_{21}|^2 = 10.017 = 10.007 \text{ dB}$$

$$G_T [dB] = 1 \text{ dB} + 10 \text{ dB} + G_I [dB] + 10 \text{ dB} + 0.2 \text{ dB}$$

$$G_T [dB] = 21.2 \text{ dB} + G_I [dB]$$

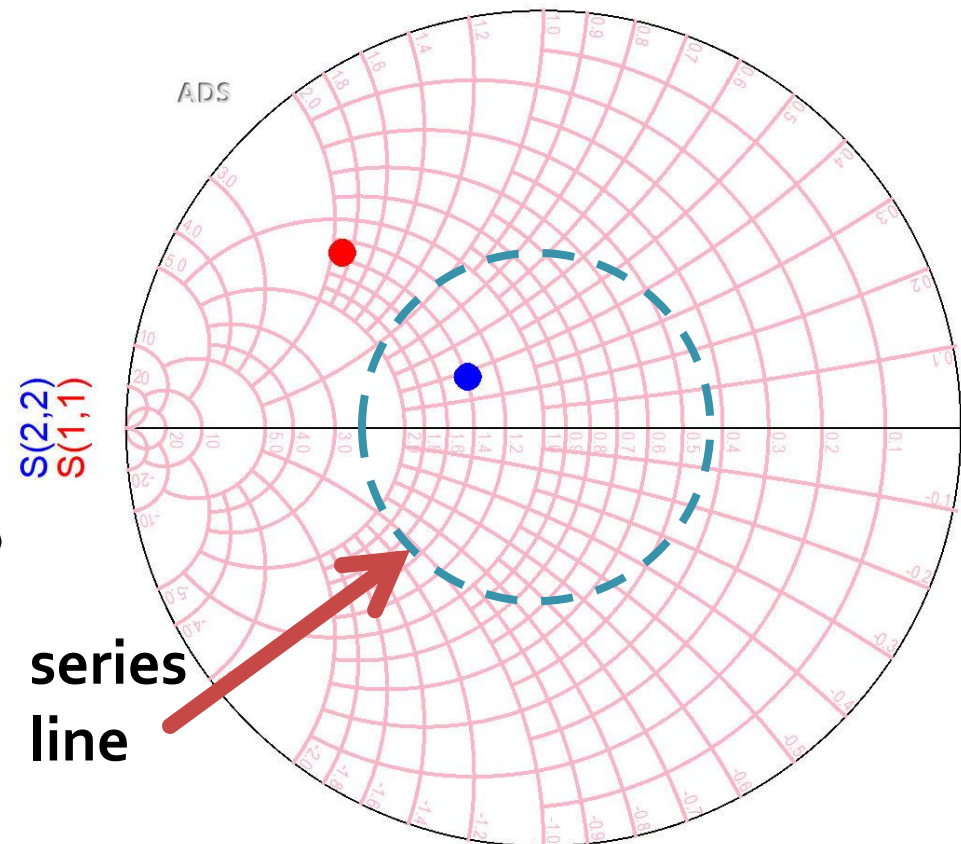
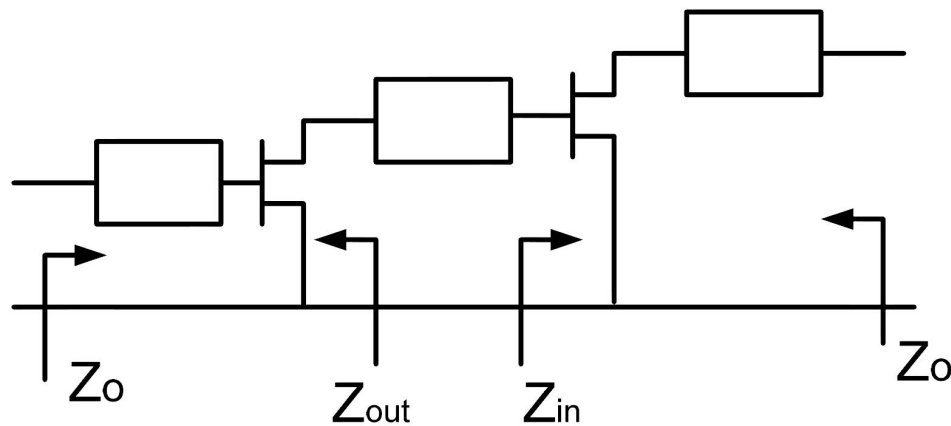
- Interstage match design must provide at least 0.8dB gain to meet specifications, by better match for the output of the first transistor and for the input of the second transistor

Interstage matching 1/2



Interstage matching 1

- A single transmission line keeps constant the magnitude of the reflection coefficient
 - a circle around the Smith Chart center

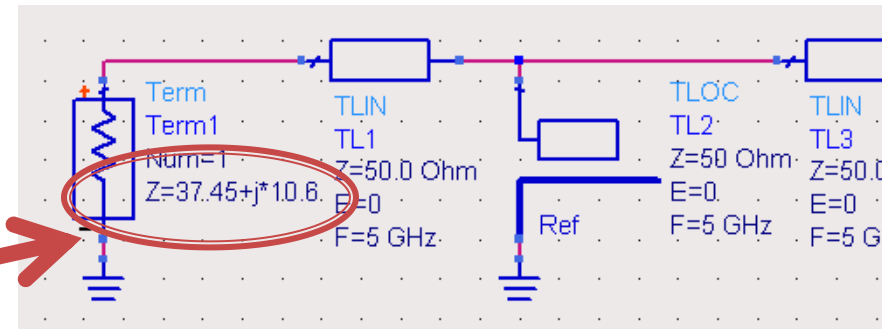
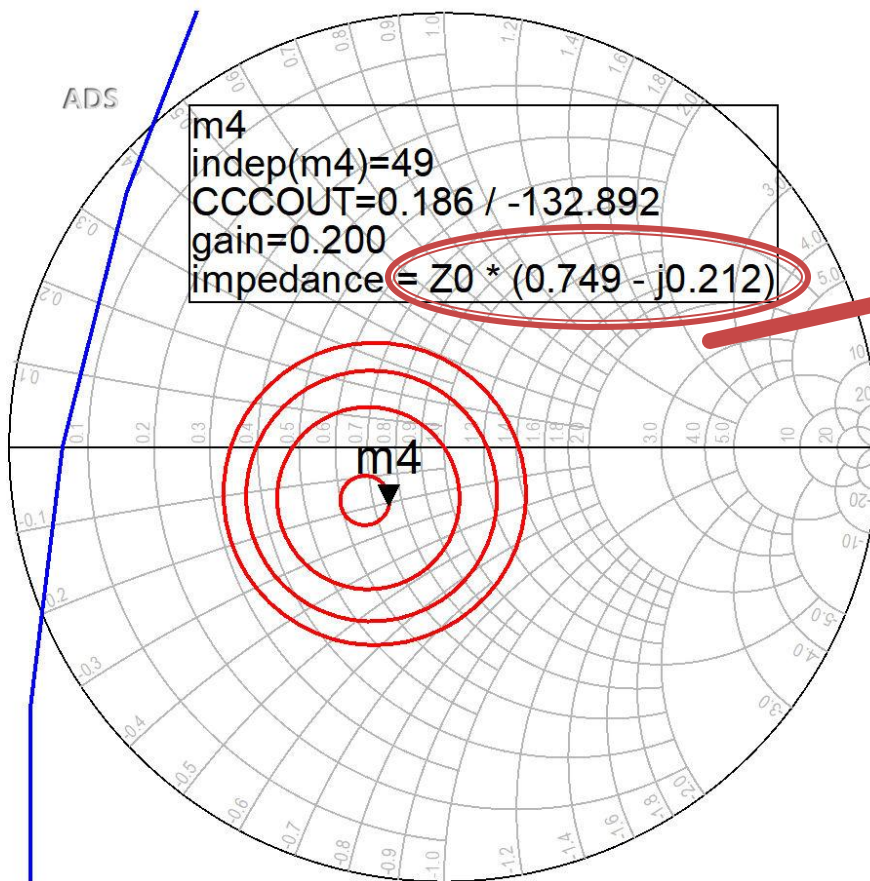


Interstage matching 1

- Can be designed in two ways:
 - starting from the output of the first stage (reflection coefficient S_{22}^*) towards the circles (drawn for the second stage):
 - stability
 - gain
 - noise
 - starting from the input of the second stage (reflection coefficient S_{11}^*) towards the circles (drawn for the first stage):
 - stability
 - gain
- First design direction has the advantage to offer control over the noise introduced by the second stage

Interstage matching 1

- Starting point – complex conjugate



$$Z = 50\Omega \cdot (0.749 - j \cdot 0.212)$$

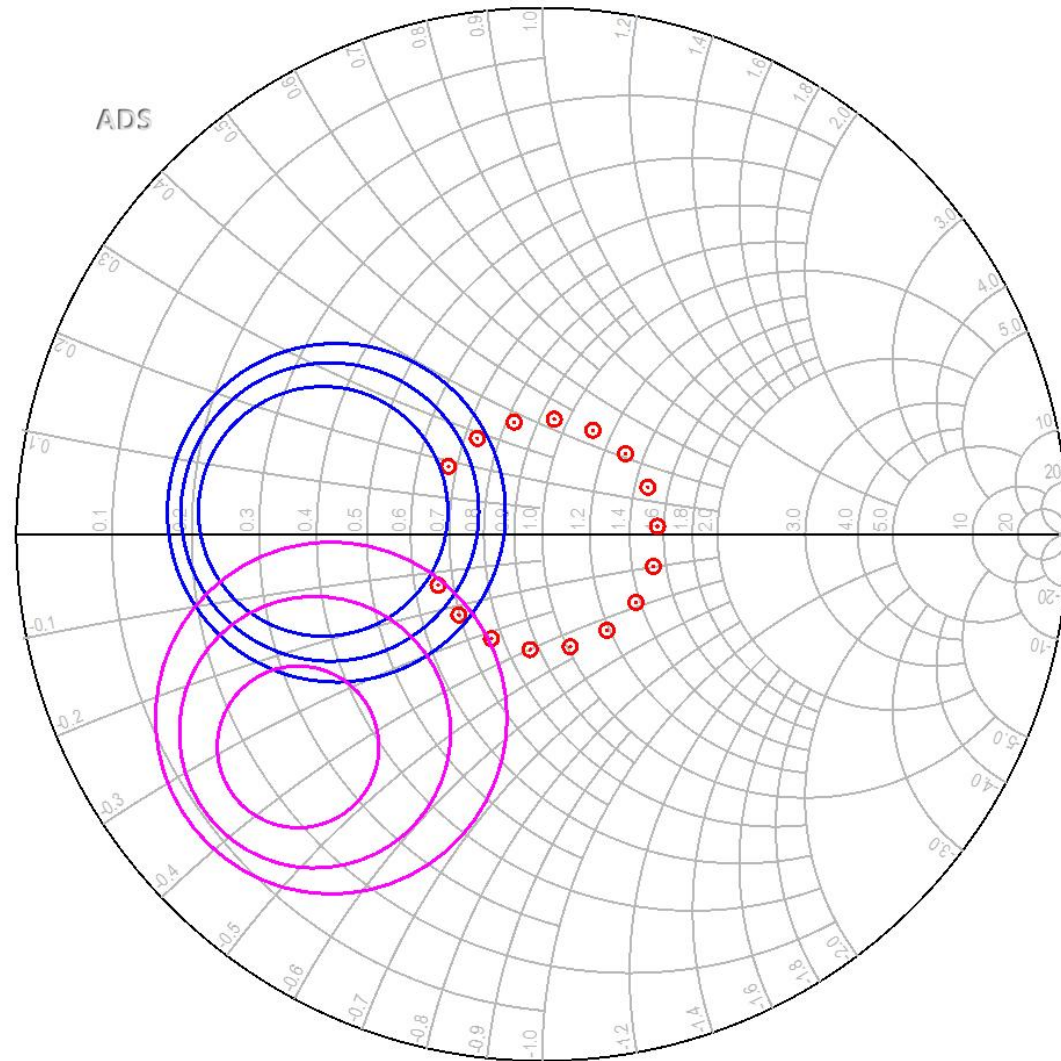
$$Z = 37.45\Omega - j \cdot 10.6\Omega$$

$$Z^* = 37.45\Omega + j \cdot 10.6\Omega$$

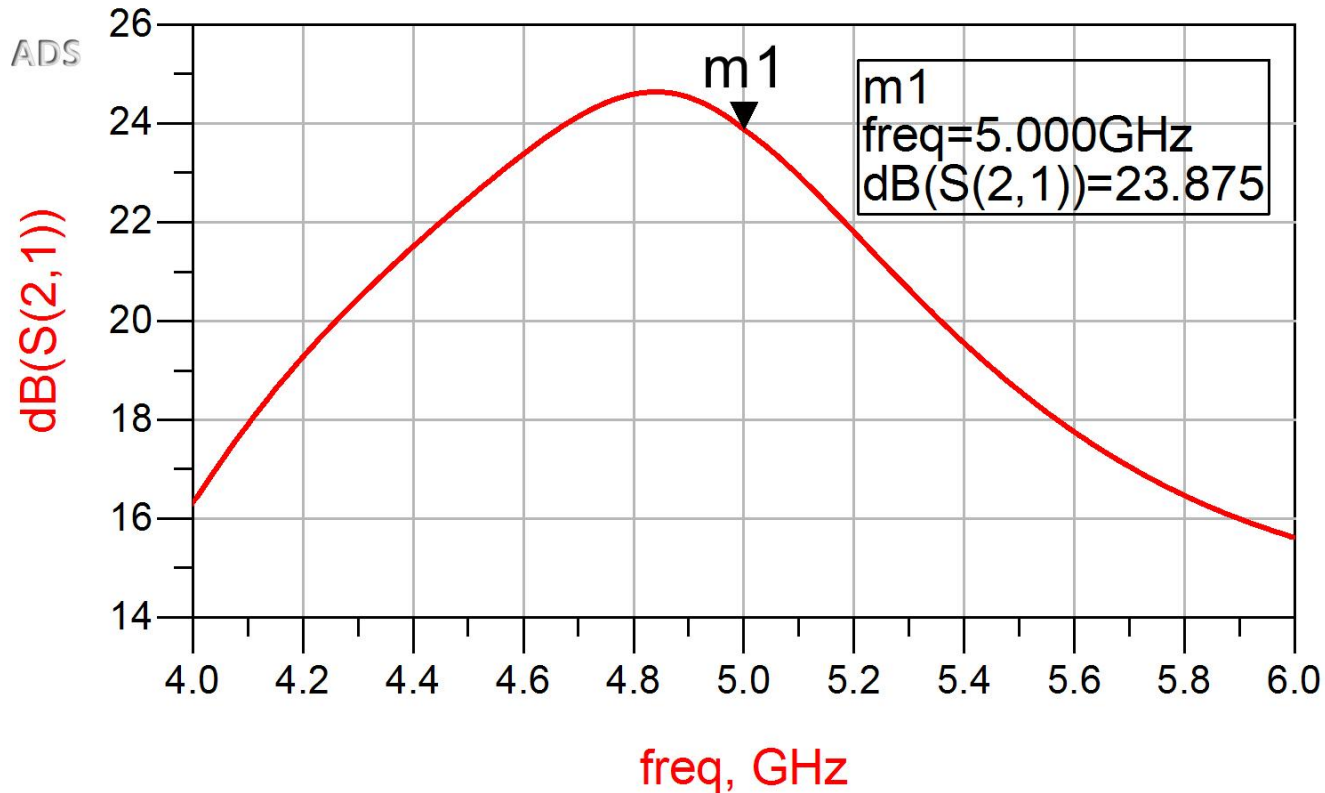
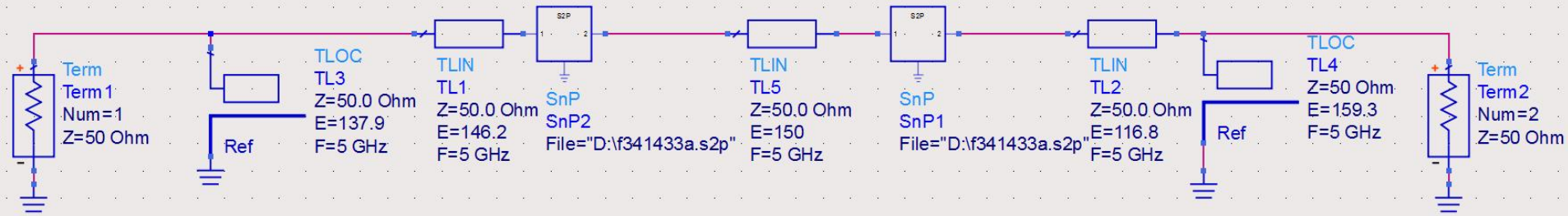
Interstage matching 1

- A **single** transmission line allows reaching a point that cannot be optimized
 - $G_{L1} = 0.2 \text{ dB}$
 - $G_{S2} = 1 \text{ dB}$
 - $F_2 = 0.7 \text{ dB}$
- Only one parameter is available for wide band performance tuning

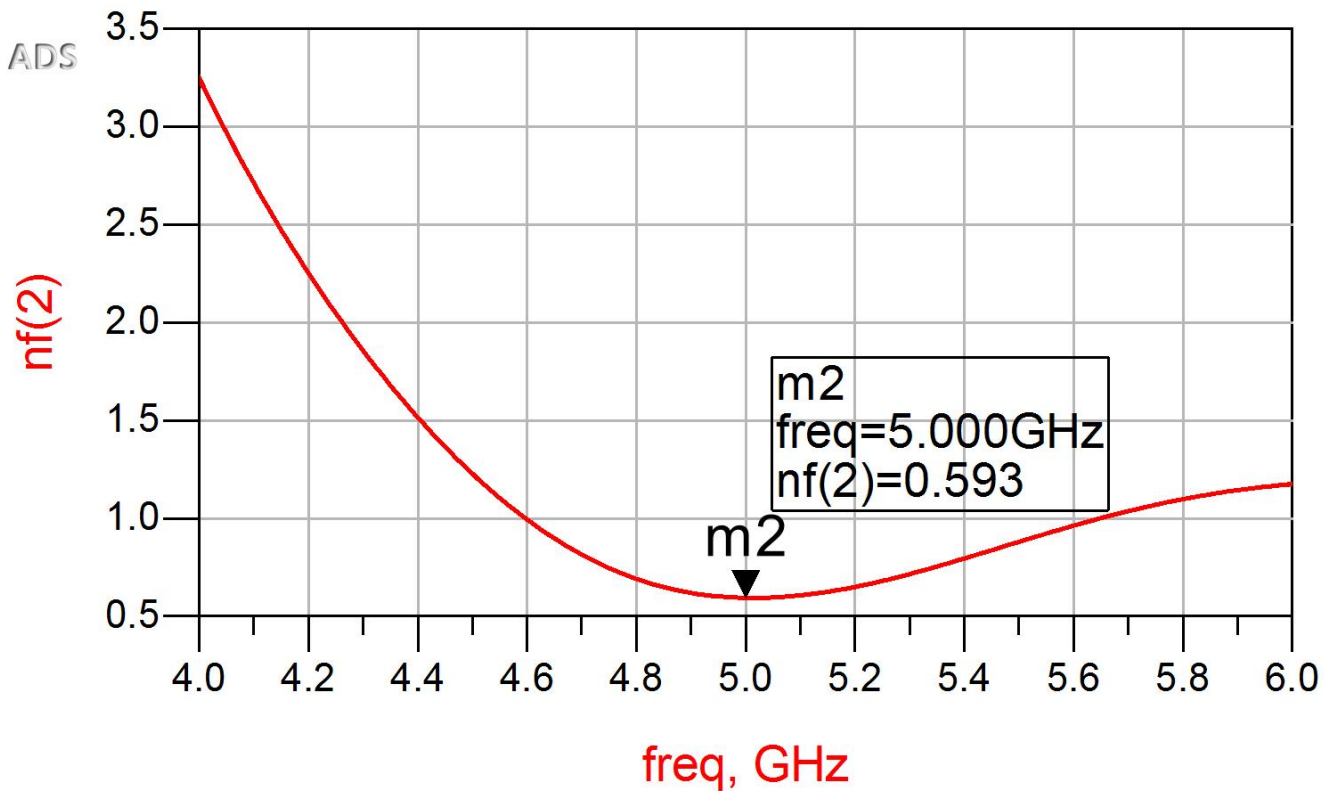
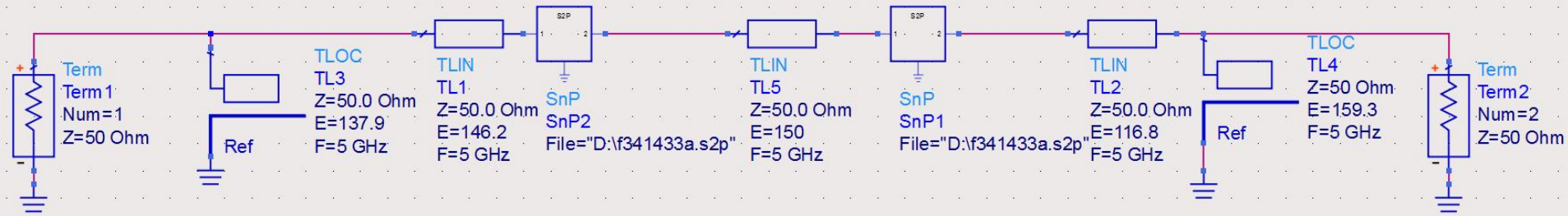
ref..CCCIN
ref..CZ
S(2,2)



ADS

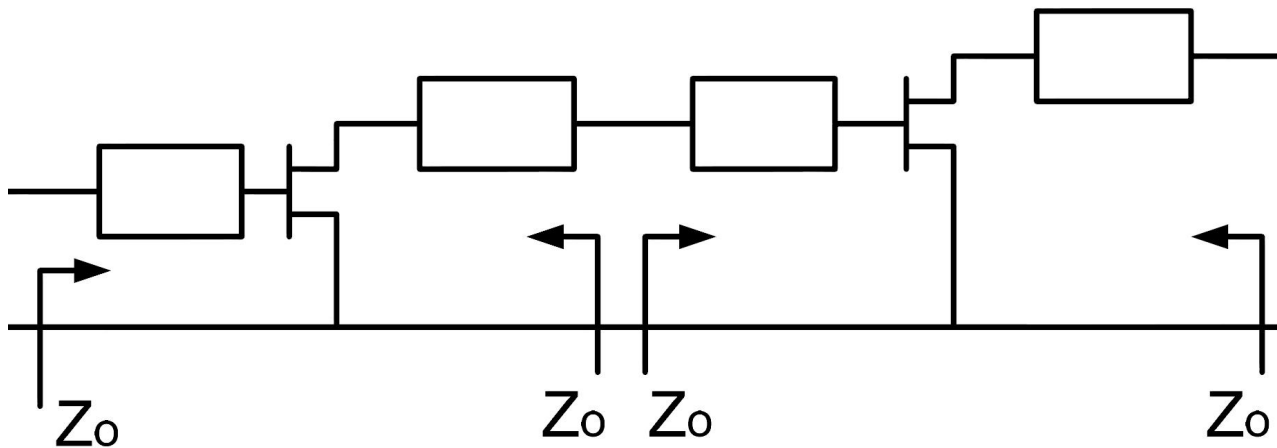


ADS

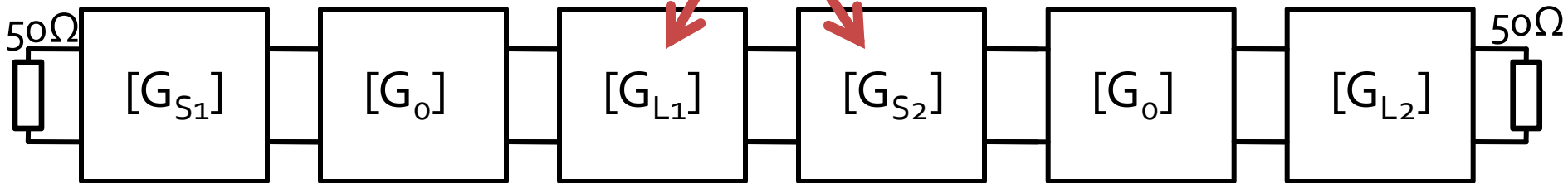
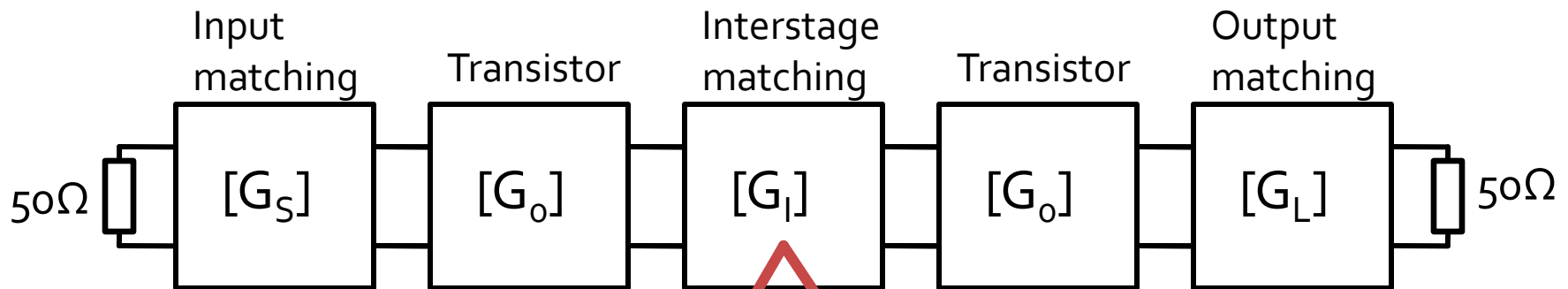


Interstage matching 2

- Using multiple transmission lines for matching each stage to a intermediate $\Gamma=0$ (virtual) allows detailed control over final reflection coefficient (and thus gain/noise)



Interstage matching 2



- Instead of a single match design we have to design two matching networks
- However both matching networks are anchored to a fixed point (50Ω , $\Gamma=0$) so we can use design **formulas** (Impedance Matching with Stubs)
- Also, due to the presence of multiple networks, we can target **precise** positions (reflection coefficients) on both stages

Multistage amplifier

- Power gain

$$G_T [dB] = G_{S1} [dB] + G_0 [dB] + G_{L1} [dB] + G_{S2} [dB] + G_0 [dB] + G_{L2} [dB]$$

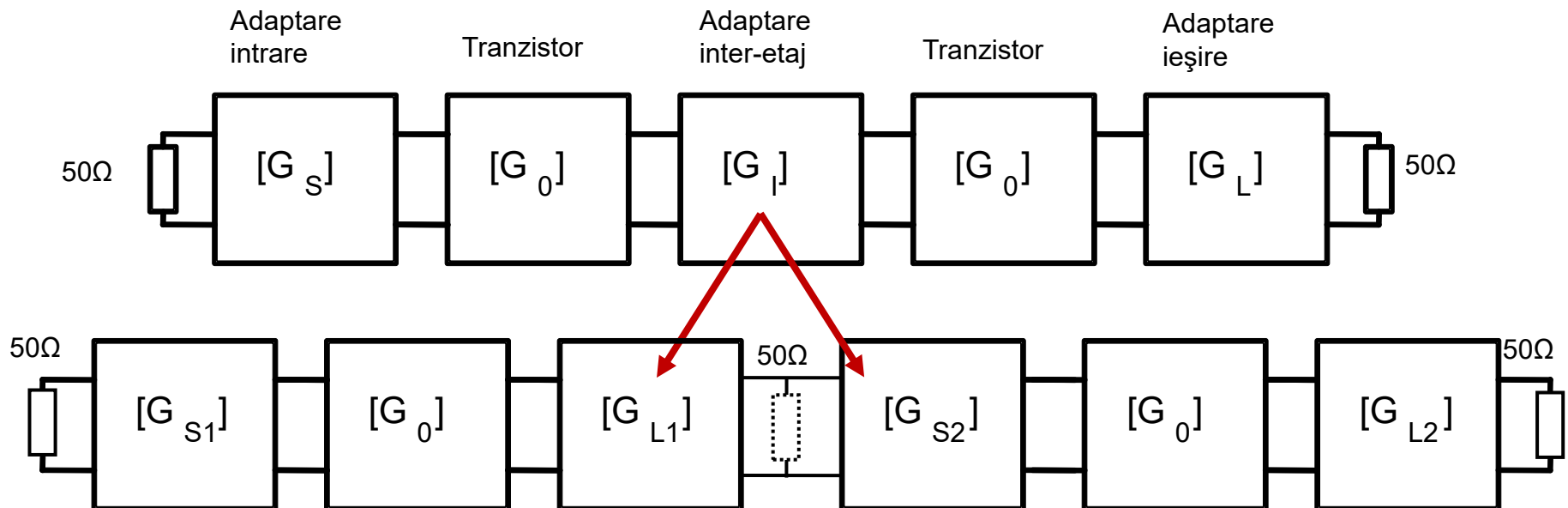
$$G_T [dB] = 1 \text{ dB} + 10 \text{ dB} + G_{L1} [dB] + G_{S2} [dB] + 10 \text{ dB} + 0.2 \text{ dB}$$

$$G_T [dB] = 21.2 \text{ dB} + \underbrace{G_{L1} [dB] + G_{S2} [dB]}$$

- Interstage match design must provide at least 0.8dB **in total** gain to meet specifications, by separately better matching the output of the first transistor and for the input of the second transistor

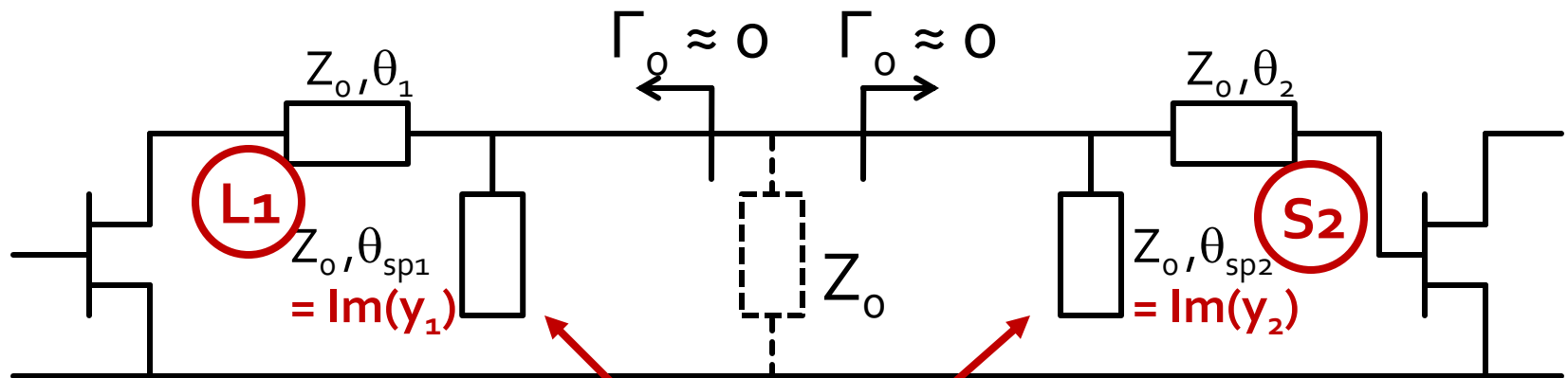
Interstage matching 2

- Using multiple transmission lines for matching each stage to a intermediate $\Gamma=0$ (virtual) allows detailed control over reflection coefficient on both stages



Interstage matching 2

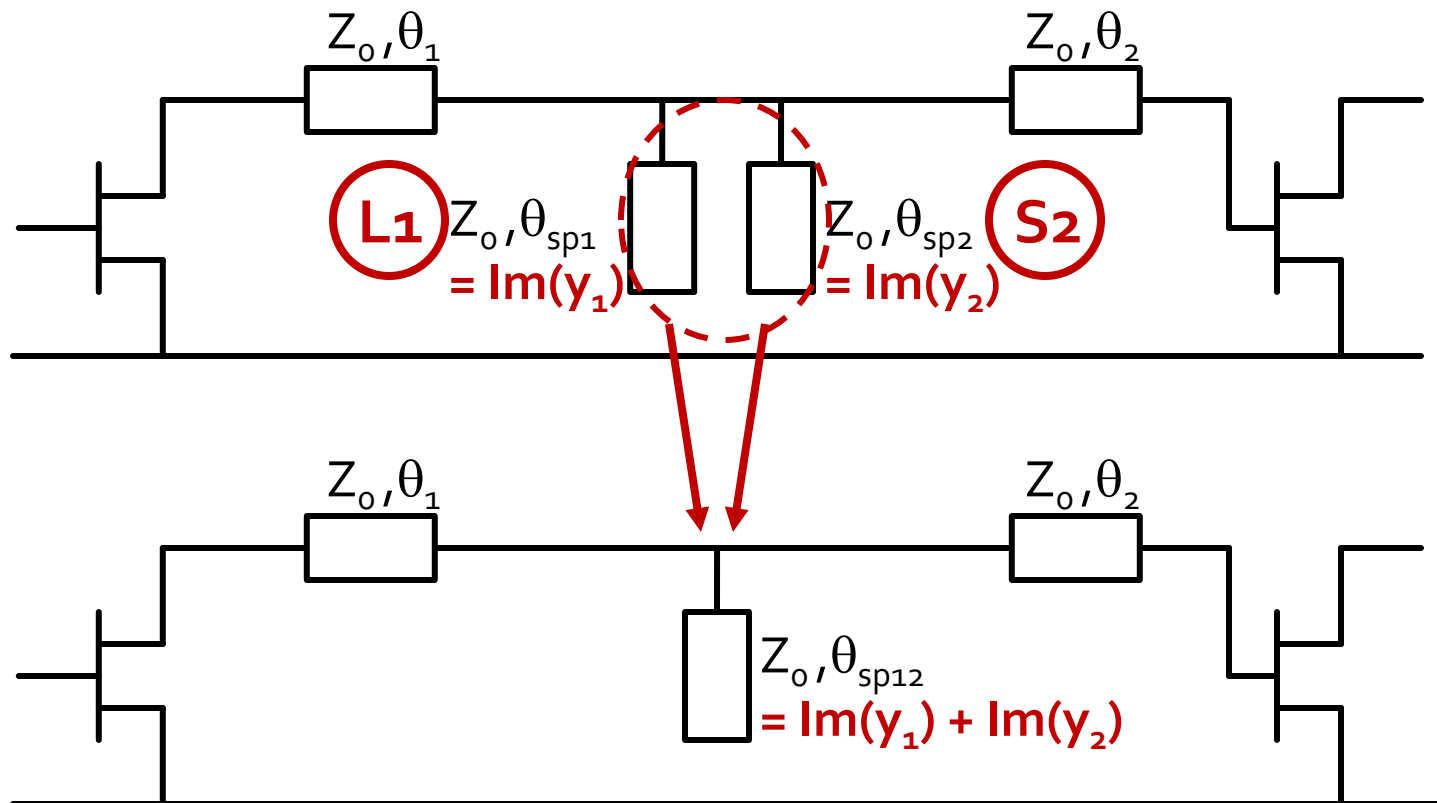
- One of the stages **creates** through its matching network a reflection coefficient $\Gamma=0$ towards which the other stage is matched



The two shunt stubs combine into a single one

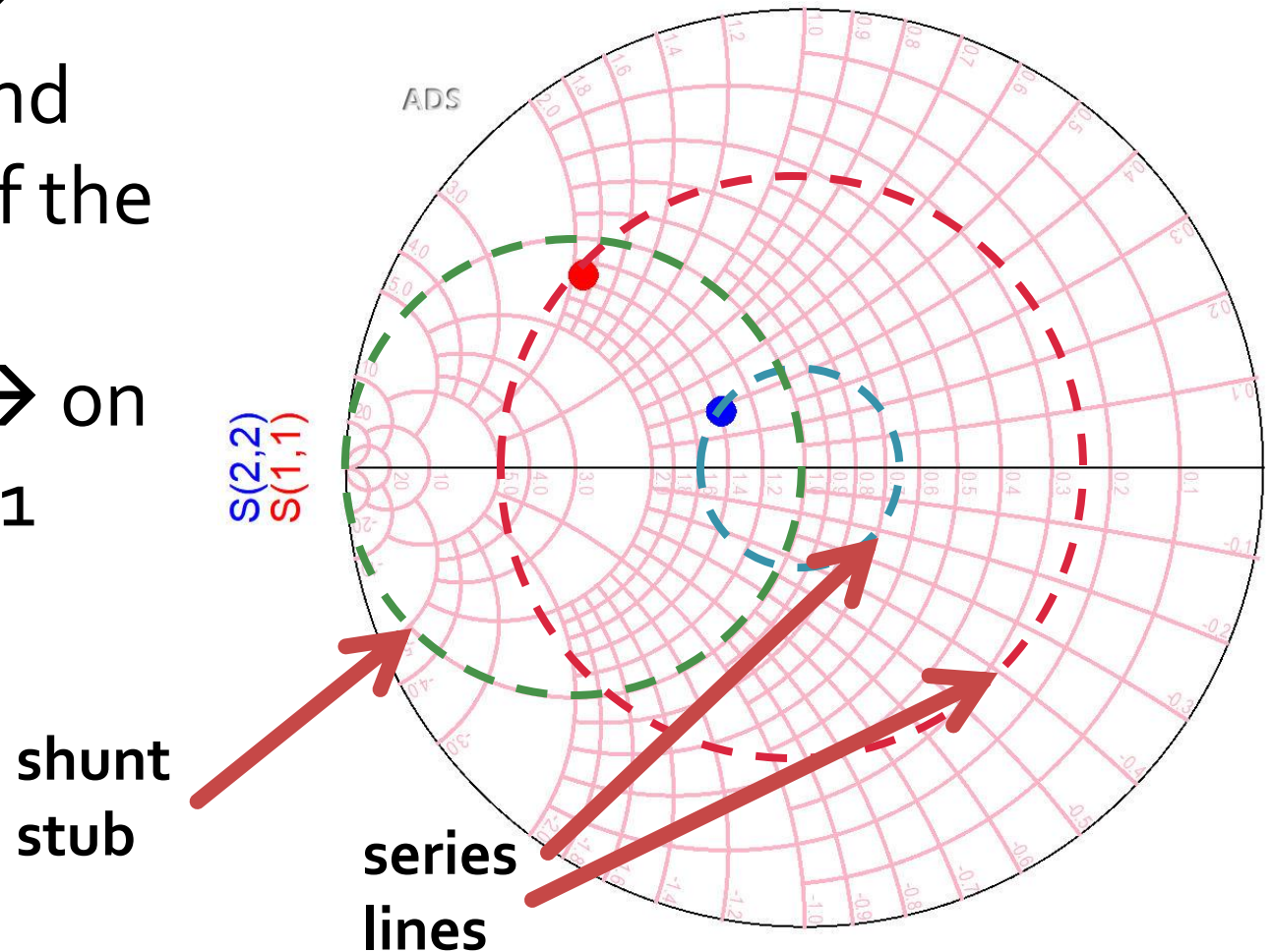
Interstage matching 2

- The two shunt stubs combine into a single one



Interstage matching 2

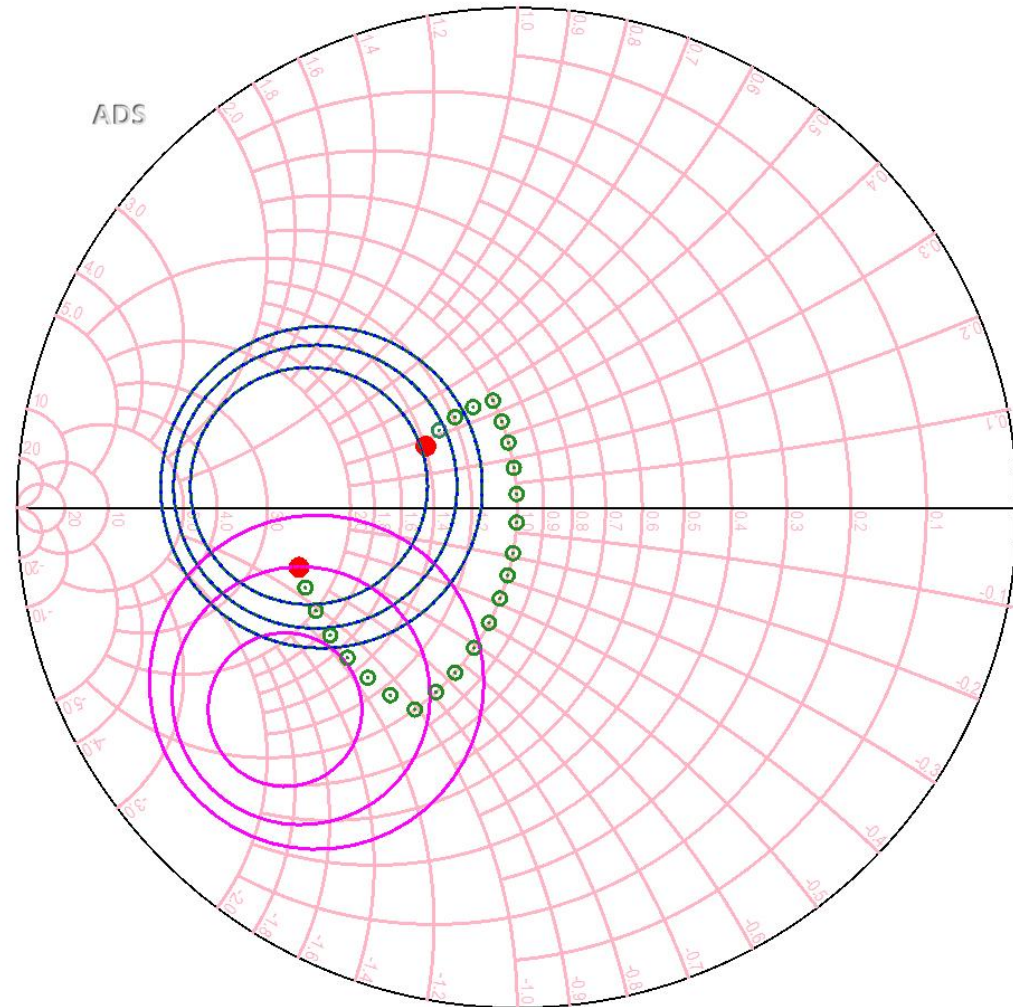
- series line \rightarrow moves around the center of the SC
- shunt stub \rightarrow on the circle $g=1$



Interstage matching 2

- For every stage we use a series line and a shunt stub
 - the series line moves the reflection coefficient from the desired starting point on the unity conductance circle $g=1$
 - the shunt stub moves the point to the center of the Smith Chart (Z_0 match)
- The two shunt stubs will then combine into one

ref..CCCIN
ref..CZ
S(2,2)



Output matching stage 1 (L1)

- G_{L1} (we use the same point <- output L2), **0.2dB**

$$\Gamma_L = 0.186 \angle -132.9^\circ$$

$$|\Gamma_L| = 0.186; \quad \varphi = -132.9^\circ$$

$$\cos(\varphi + 2\theta) = -|\Gamma_L| \qquad \text{Im}[y_L(\theta)] = \frac{-2 \cdot |\Gamma_L|}{\sqrt{1 - |\Gamma_L|^2}} = -0.379$$

$$\cos(\varphi + 2\theta) = -0.186 \Rightarrow (\varphi + 2\theta) = \pm 100.72^\circ$$

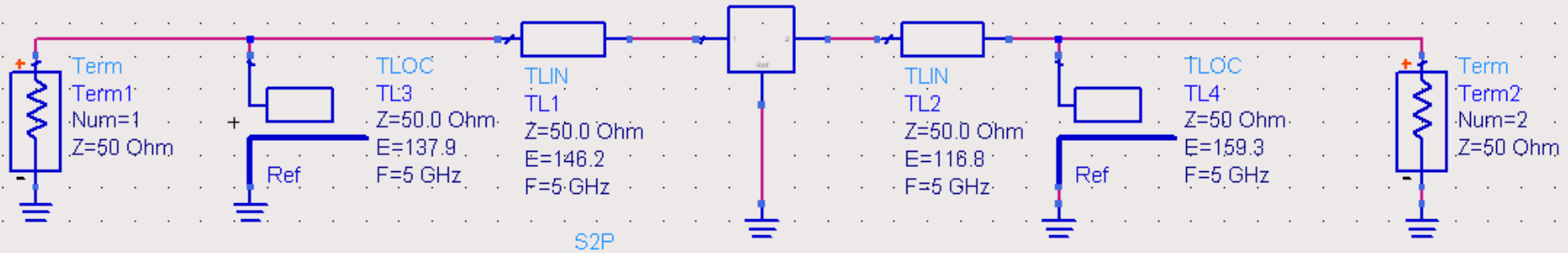
- the length of the shunt stub θ_{sp} is not calculated because it is **not** needed

$$(\varphi + 2\theta) = \begin{cases} +100.72^\circ \\ -100.72^\circ \end{cases} \quad \theta = \begin{cases} 116.8^\circ \\ 16.1^\circ \end{cases} \quad \text{Im}[y_L(\theta)] = \begin{cases} -0.379 \\ +0.379 \end{cases}$$

Output matching stage 1 (L1)

Equation	Solution L1A	Solution L1B
$\Phi+2\theta$	$+100.72^\circ$	-100.72°
θ	116.8°	16.1°
$\text{Im}[y(\theta)]$	-0.379	$+0.379$

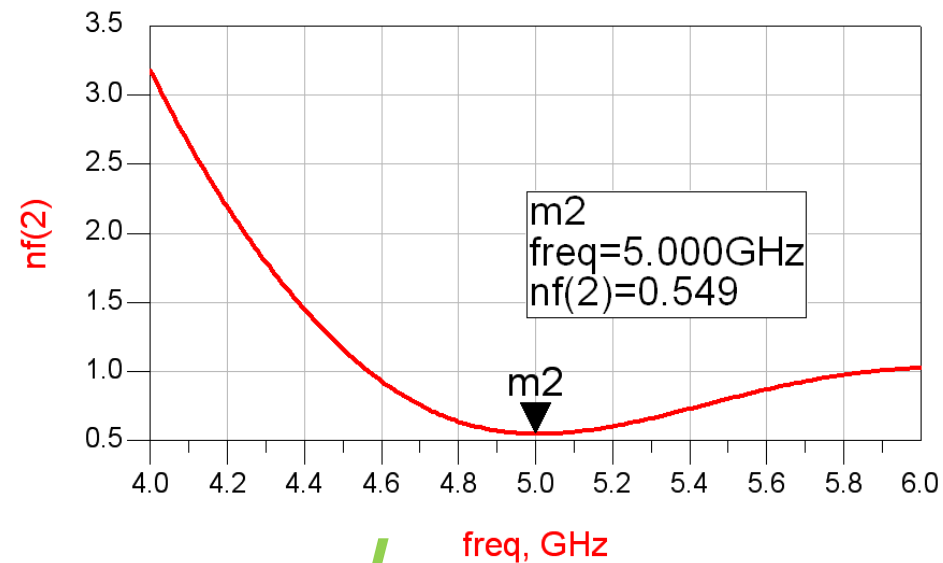
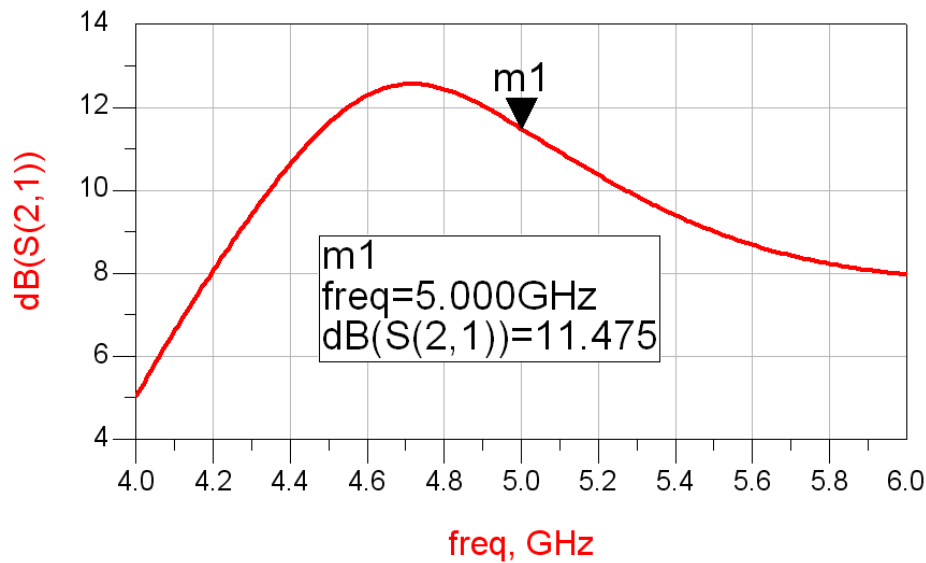
Verify stage 1



G_{S1}

G_0

G_{L1}



$F_1 < 0.7 \text{ dB}, G_1 > 9 \text{ dB}$ ✓

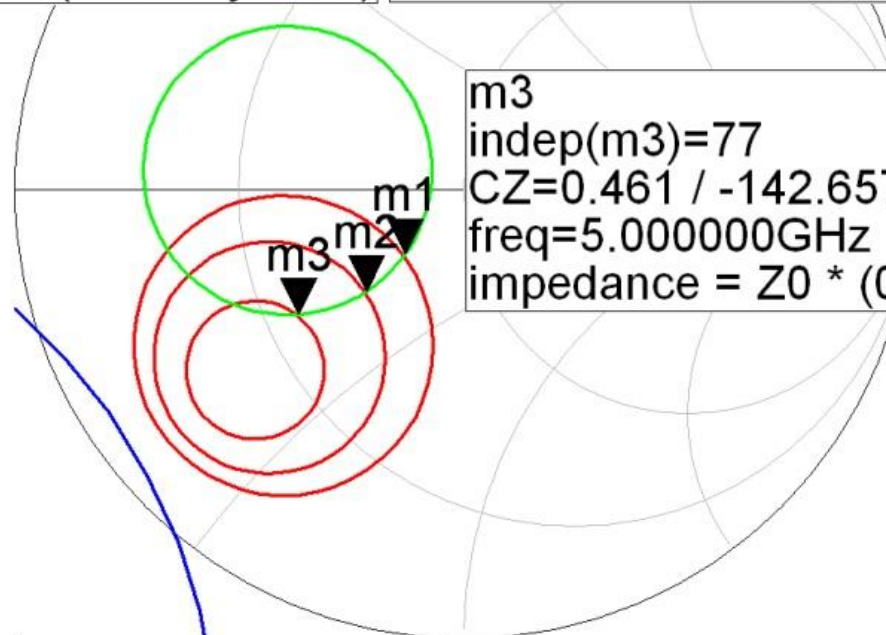
Input matching stage 2 (S2)

- G_{S_2} (moving from Γ_{S_2} we choose towards complex plane origin – **m3** – gain 2dB)

m1
indep(m1)=91
CZ=0.196 / -131.619
freq=5.000000GHz
impedance = $Z_0 * (0.741 - j0.225)$

m2
indep(m2)=85
CZ=0.315 / -133.406
freq=5.000000GHz
impedance = $Z_0 * (0.588 - j0.299)$

CZ
CSIN
CCCIN



m3
indep(m3)=77
CZ=0.461 / -142.657
freq=5.000000GHz
impedance = $Z_0 * (0.405 - j0.287)$

Input matching stage 2 (S2)

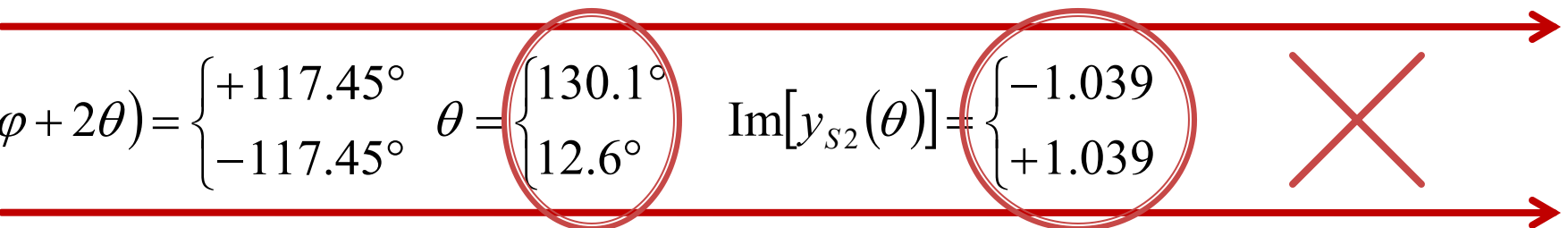
- G_{S2} (going from m_3 towards origin), **2dB**

$$\Gamma_{S2} = 0.461 \angle -142.66^\circ \quad |\Gamma_{S2}| = 0.461; \quad \varphi = -142.66^\circ$$

$$\cos(\varphi + 2\theta) = -|\Gamma_{S2}| \quad \text{Im}[y_{S2}(\theta)] = \frac{\mp 2 \cdot |\Gamma_{S2}|}{\sqrt{1 - |\Gamma_{S2}|^2}}$$

$$\cos(\varphi + 2\theta) = -0.461 \Rightarrow (\varphi + 2\theta) = \pm 117.45^\circ$$

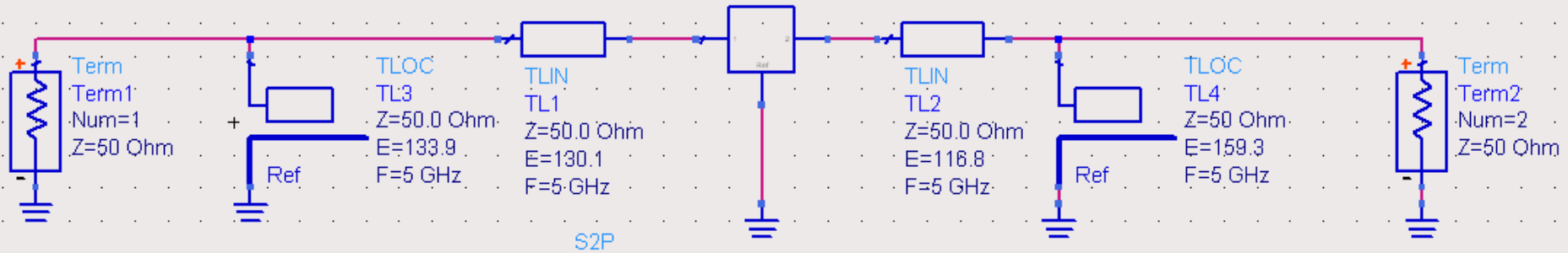
- the length of the shunt stub θ_{sp} is not calculated because it is **not** needed


$$(\varphi + 2\theta) = \begin{cases} +117.45^\circ \\ -117.45^\circ \end{cases} \quad \theta = \begin{cases} 130.1^\circ \\ 12.6^\circ \end{cases} \quad \text{Im}[y_{S2}(\theta)] = \begin{cases} -1.039 \\ +1.039 \end{cases}$$

Input matching stage 2 (S2)

Equation	Solution S2A	Solution S2B
$\Phi+2\theta$	$+117.45^\circ$	-117.45°
θ	130.1°	12.6°
$\text{Im}[y(\theta)]$	-1.039	$+1.039$

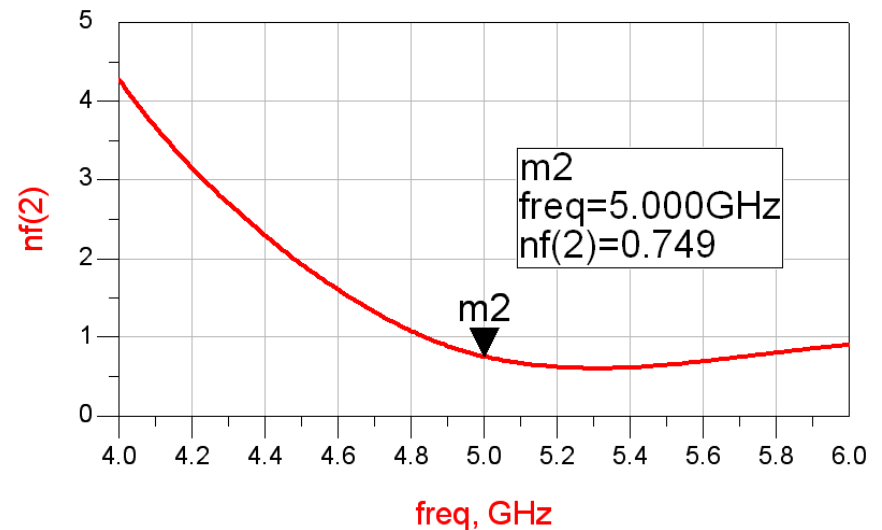
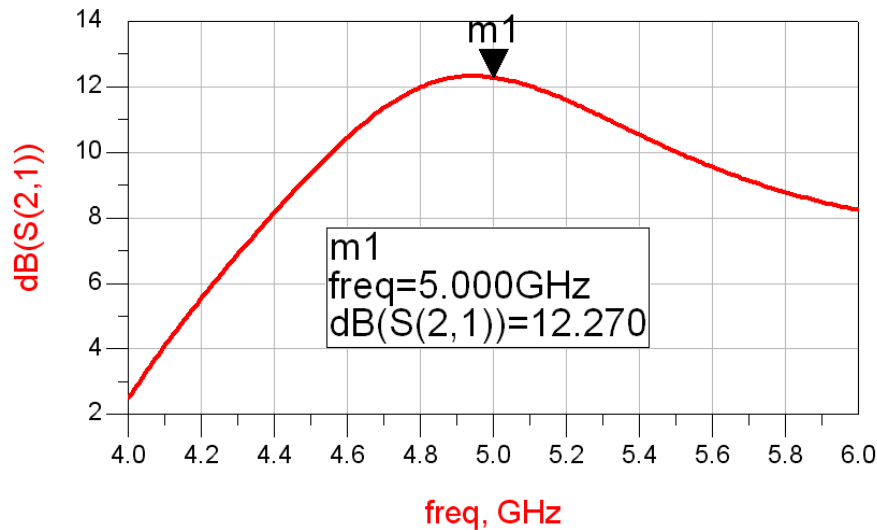
Verify stage 2



G_{S1}

G_0

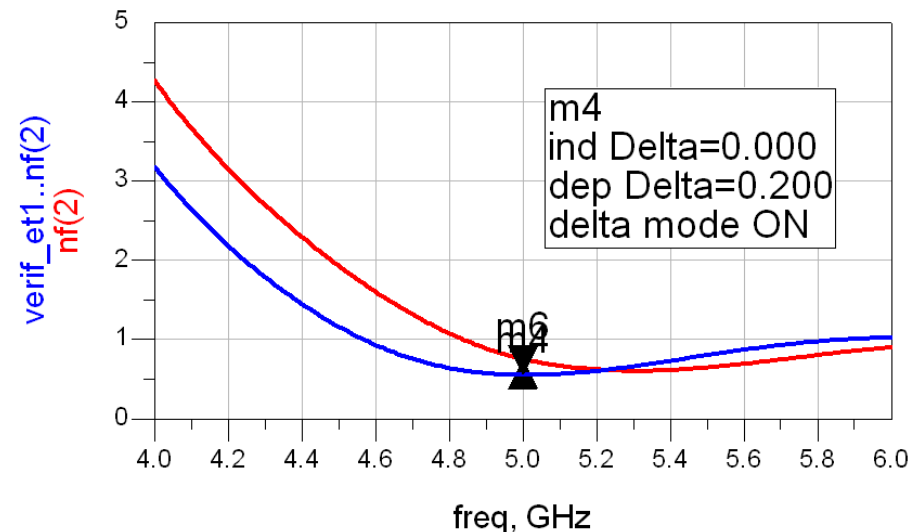
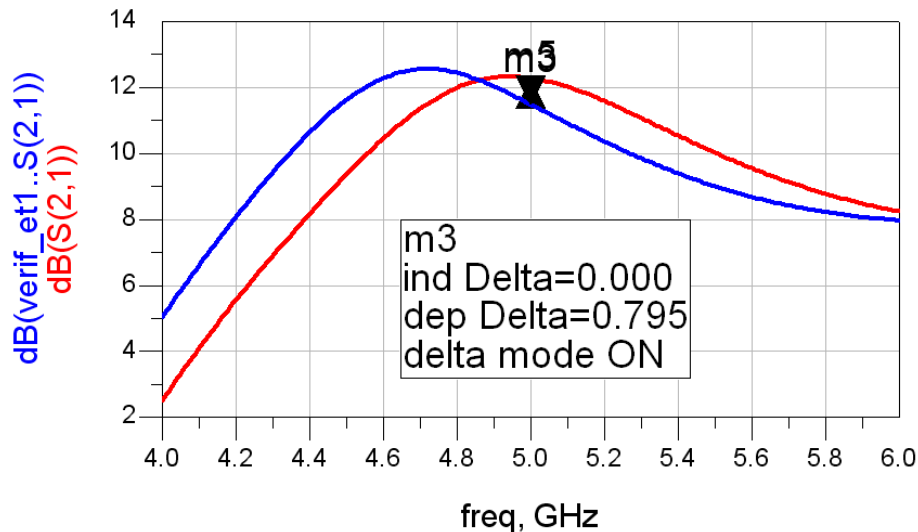
G_{L1}



$F_2 < 1.2 \text{ dB}, G_2 < 13 \text{ dB}$ **X** $G_1 = 11.5 \text{ dB}, G_2 = 12.3 \text{ dB}, G_1 + G_2 > 22 \text{ dB}$ **✓**

Stage 1/2

- According to the conclusions of the Friis formula, the second stage obtains a higher gain because a higher noise is acceptable.



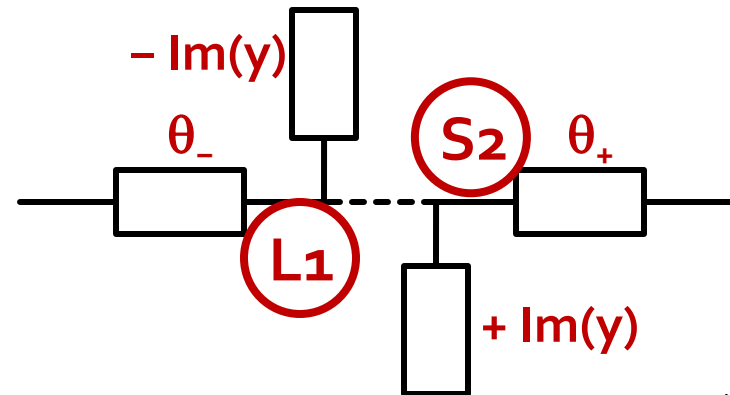
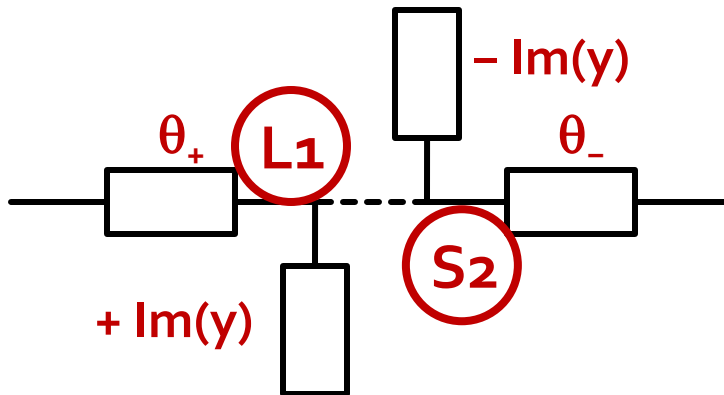
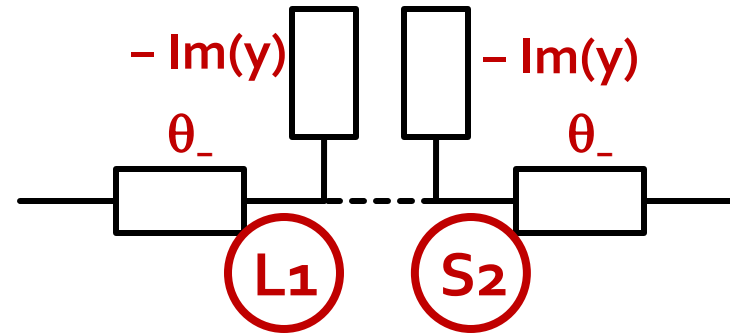
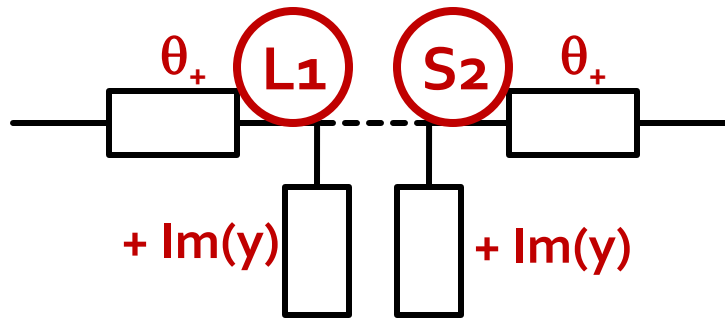
Merging the two shunt stubs

- **The two shunt stubs merge into a single one**
- There are **4 possible combinations** depending on how we chose the electrical length for the two series lines
 - for each chosen electric length (θ) the corresponding $\text{Im}[y(\theta)]$ must be used
- Ex:

$$\theta_{L1} = 116.8^\circ \quad \theta_{S2} = 130.1^\circ \quad \text{Im}[y_{sp}] = \text{Im}[y_{L1}(\theta)] + \text{Im}[y_{S2}(\theta)] = -1.418$$
$$\theta_{sp} = \tan^{-1}(\text{Im}[y_{sp}]) \quad \theta_{sp} = 125.2^\circ$$

Merging the two shunt stubs

- 4 possible combinations
 - the **admittances** are in parallel and **add** up, not the electrical lengths



$$Im[y_{sp}] = Im[y_{L1}(\theta)] + Im[y_{S2}(\theta)]$$

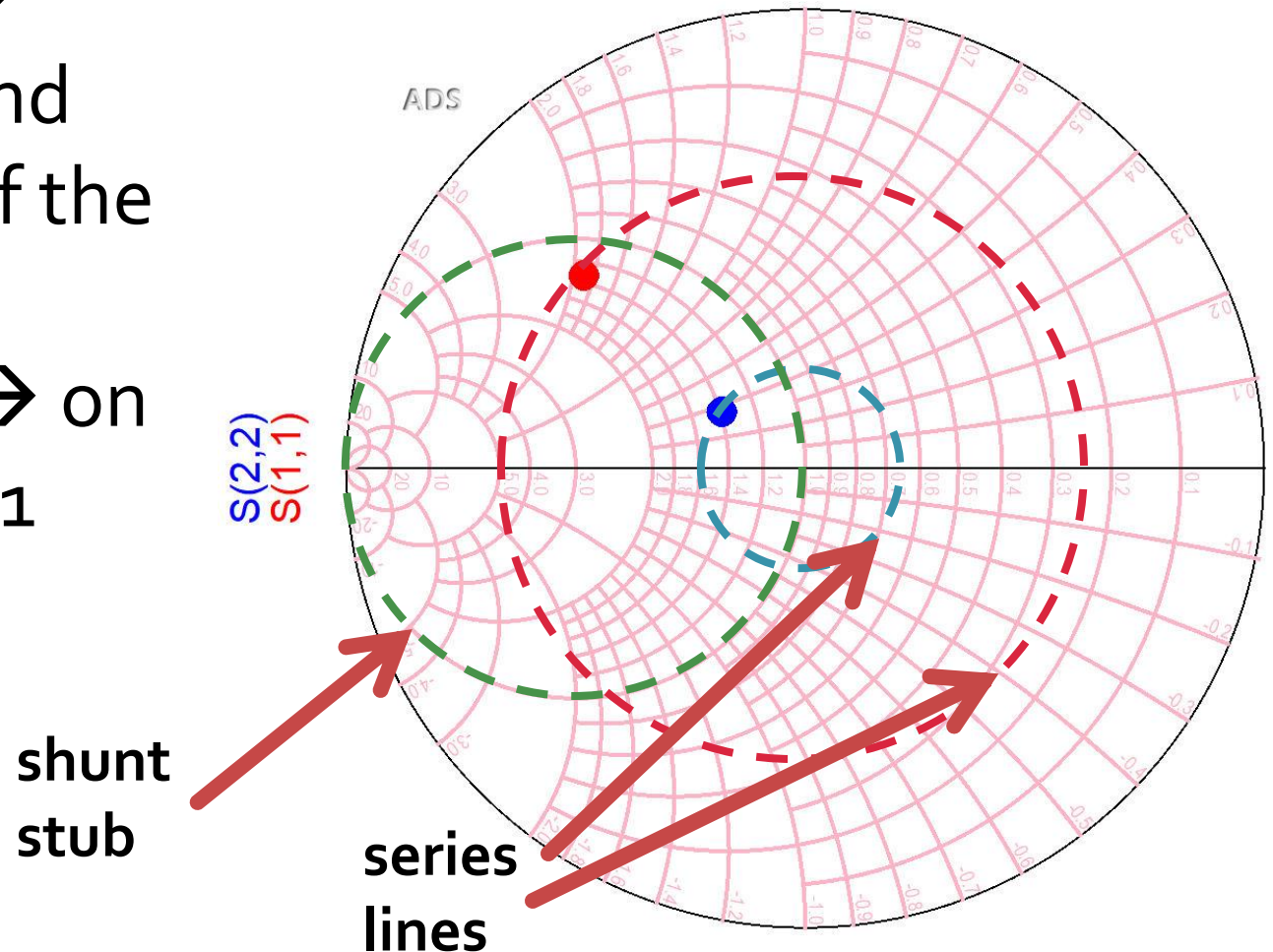
$$\theta_{sp} = \tan^{-1}(Im[y_{sp}])$$

Merging the two shunt stubs

		Solution S2A	Solution S2B
		$\theta = 130.1^\circ$ $\text{Im}[y(\theta)] = -1.039$	$\theta = 12.6^\circ$ $\text{Im}[y(\theta)] = +1.039$
Solution L1A	$\theta = 116.8^\circ$ $\text{Im}[y(\theta)] = -0.379$	$\theta_{L1} = 116.8^\circ$ $\text{Im}[y(\theta)] = -1.418$ $\theta_p = 125.2^\circ$ $\theta_{S2} = 130.1^\circ$	$\theta_{L1} = 116.8^\circ$ $\text{Im}[y(\theta)] = +0.66$ $\theta_p = 33.4^\circ$ $\theta_{S2} = 12.6^\circ$
Solution L1B	$\theta = 16.1^\circ$ $\text{Im}[y(\theta)] = +0.379$	$\theta_{L1} = 16.1^\circ$ $\text{Im}[y(\theta)] = -0.66$ $\theta_p = 146.6^\circ$ $\theta_{S2} = 130.1^\circ$	$\theta_{L1} = 16.1^\circ$ $\text{Im}[y(\theta)] = 1.418$ $\theta_p = 54.8^\circ$ $\theta_{S2} = 12.6^\circ$

Smith Chart

- series line \rightarrow
moves around
the center of the
SC
- shunt stub \rightarrow on
the circle $g=1$



Merge 1, Smith Chart

$$\theta_{L1} = 116.8^\circ \quad \theta_{S2} = 130.1^\circ$$

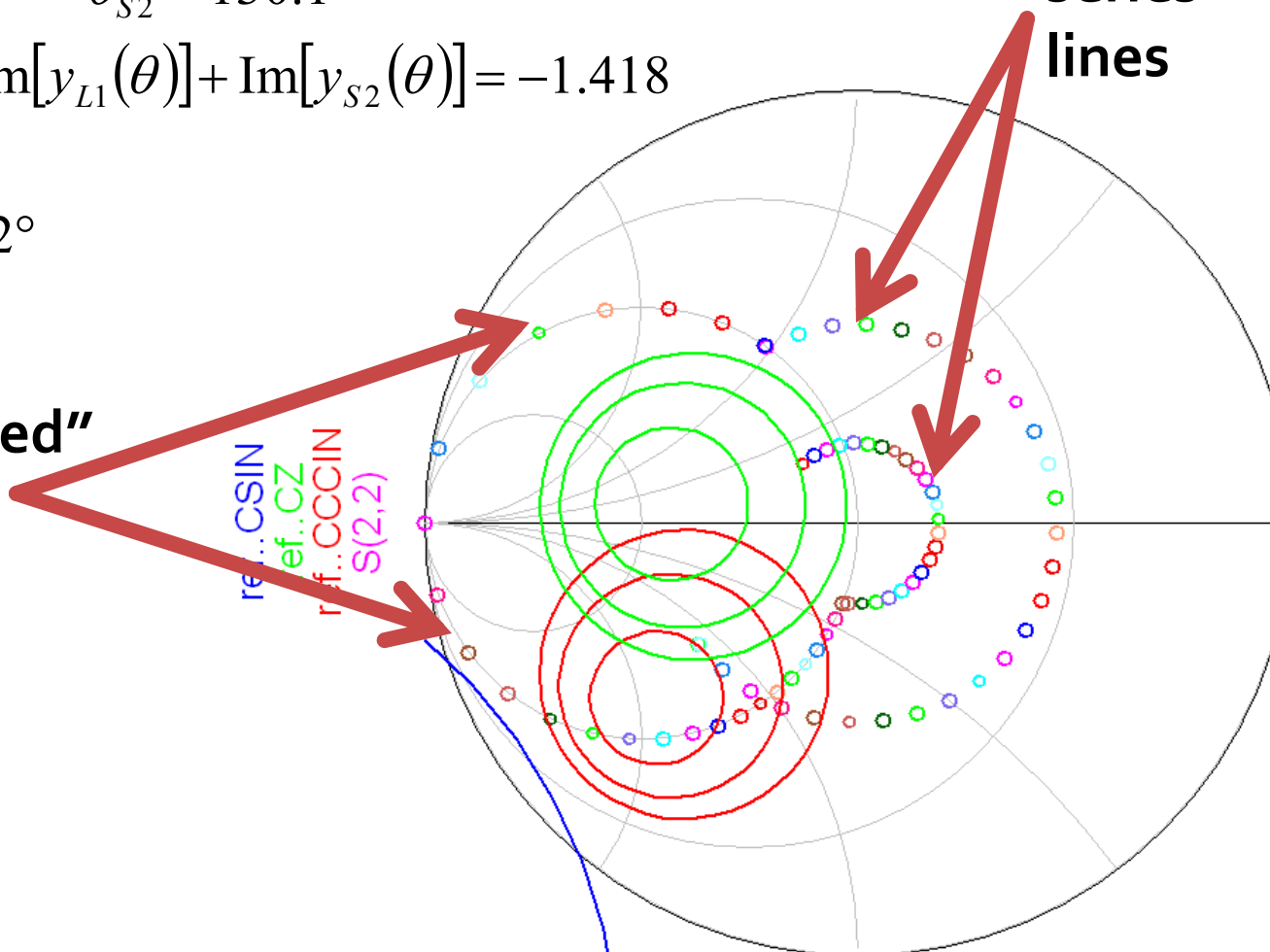
$$\text{Im}[y_{sp}] = \text{Im}[y_{L1}(\theta)] + \text{Im}[y_{S2}(\theta)] = -1.418$$

$$\theta_{sp} = 125.2^\circ$$

“combined”
stub

ref..CSIN
ref..CZ
ref..CCIN
S(2,2)

series
lines



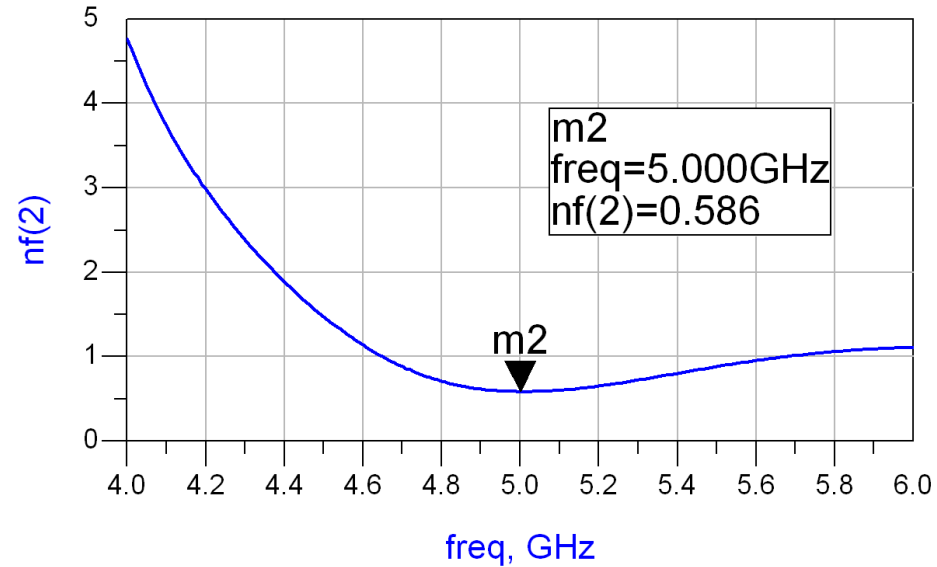
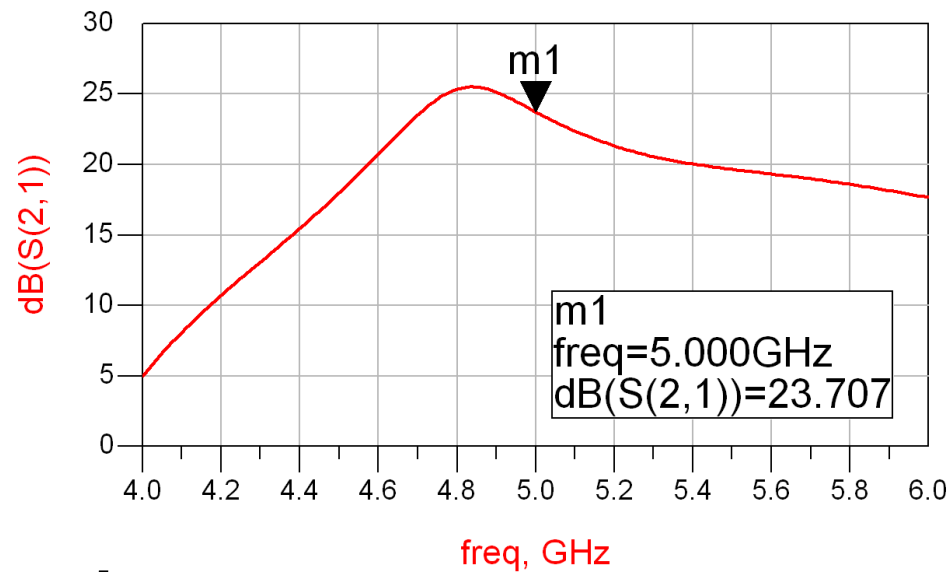
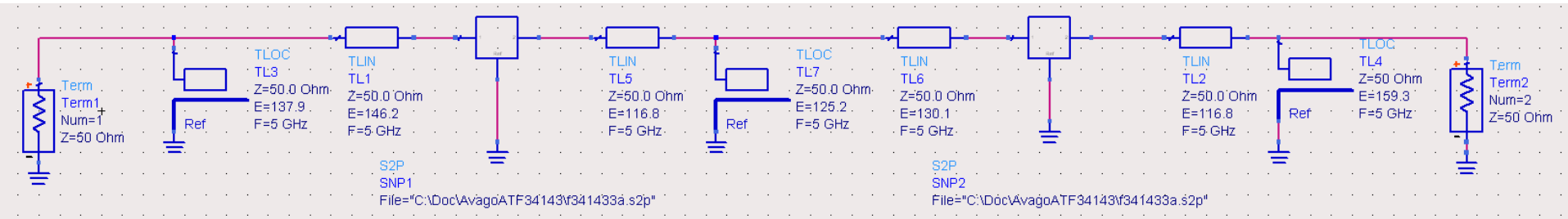
Tune Control

Select a parameter to tune by clicking on it

Simulate:

Trace History:

Merge 1, ADS



Merge 2, Smith Chart

$$\theta_{L1} = 116.8^\circ \quad \theta_{S2} = 12.6^\circ$$

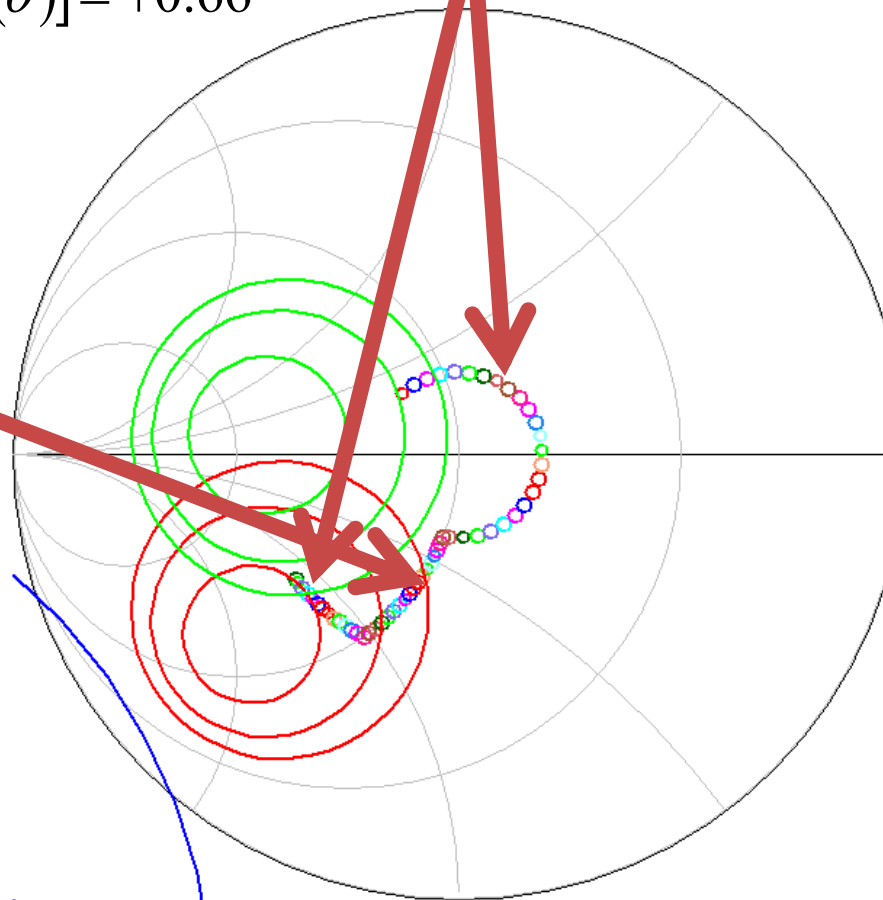
$$\text{Im}[y_{sp}] = \text{Im}[y_{L1}(\theta)] + \text{Im}[y_{S2}(\theta)] = +0.66$$

$$\theta_{sp} = 33.4^\circ$$

“combined”
stub

ref..CSIN
ref..CZ
ref..CCCN
S(2,2)

series
lines



Tune Control

Select a parameter to tune by clicking on it

Simulate:

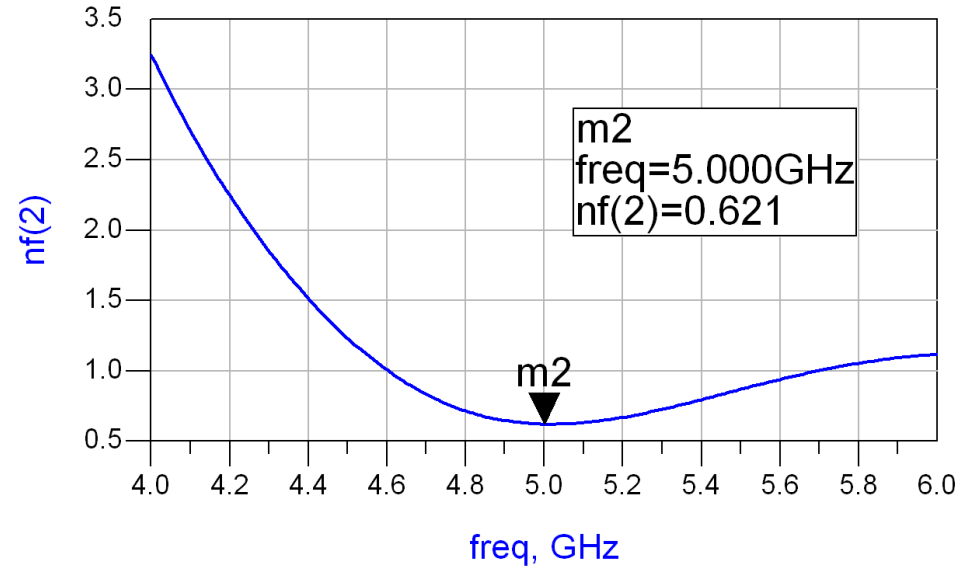
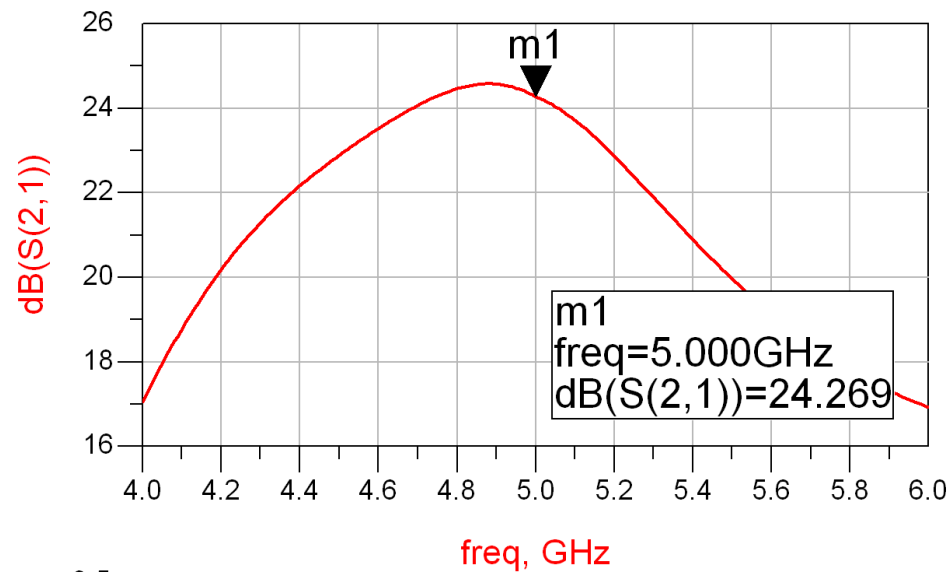
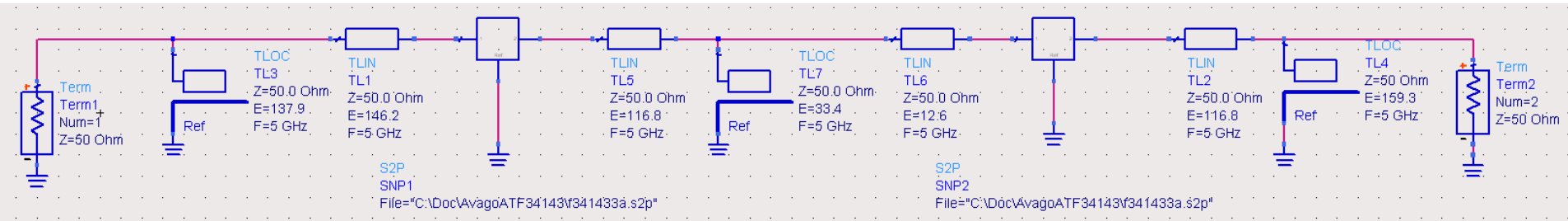
Trace History:

linii_inter_smith2.TL1.E

linii_inter_smith2.TL2.E

linii_inter_smith2.TL3.E

Merge 2, ADS



Merge 3, Smith Chart

$$\theta_{L1} = 16.1^\circ \quad \theta_{S2} = 130.1^\circ$$

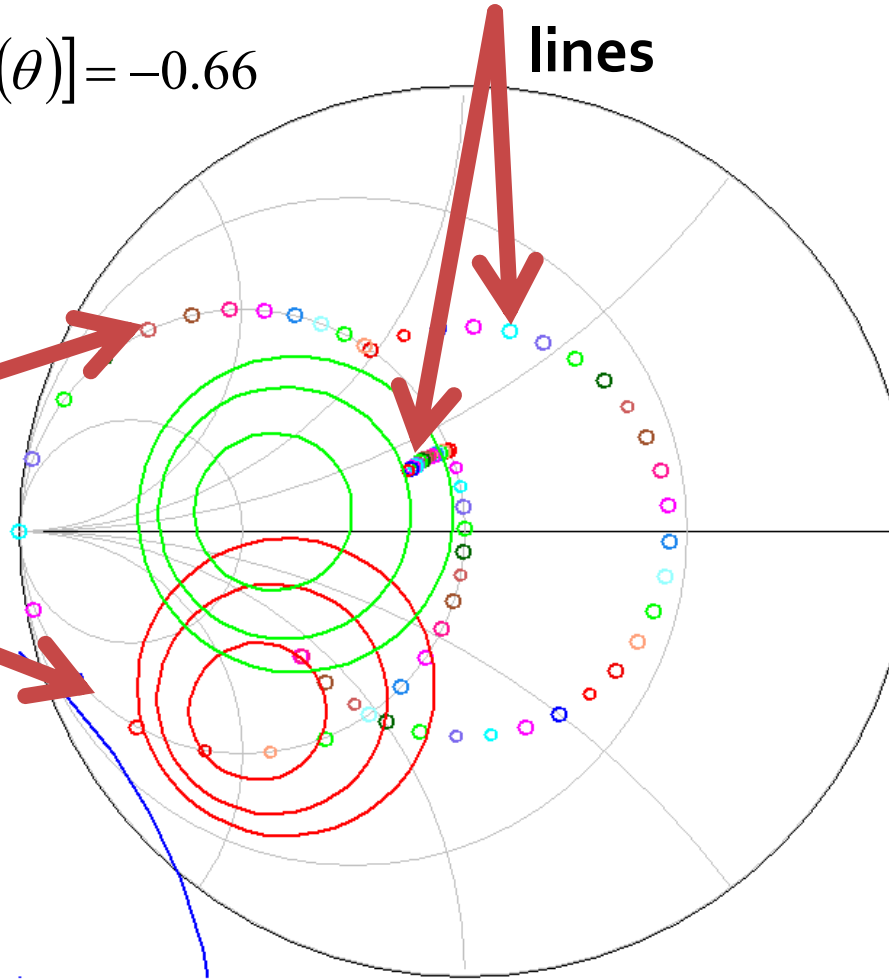
$$\text{Im}[y_{sp}] = \text{Im}[y_{L1}(\theta)] + \text{Im}[y_{S2}(\theta)] = -0.66$$

$$\theta_{sp} = 146.6^\circ$$

“combined”
stub

ref..CSIN
ref..CZ
ef..CCIN
S(2,2)

series
lines



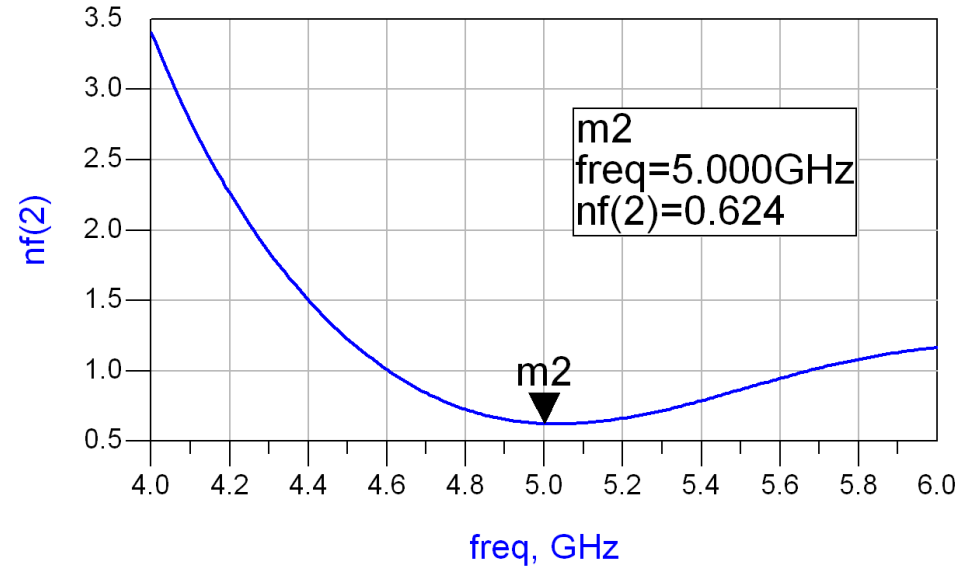
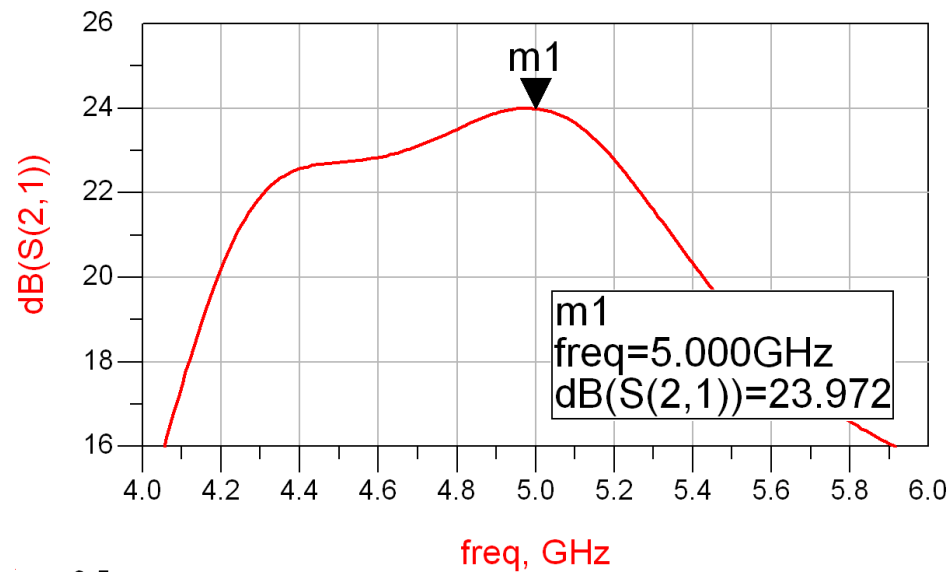
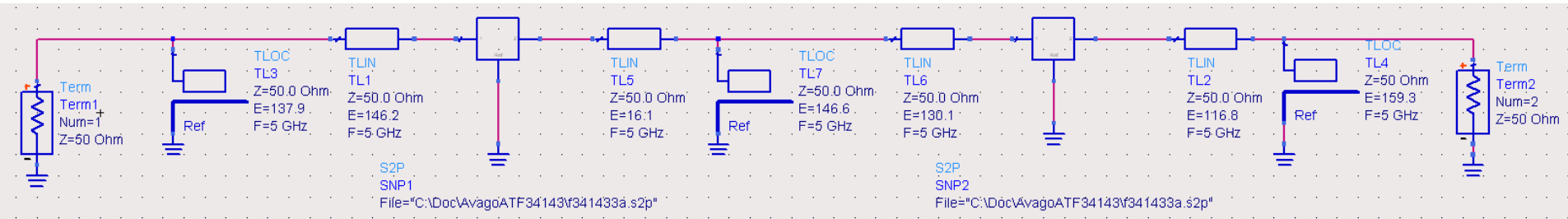
Tune Control

Select a parameter to tune by clicking on it

Simulate:

Trace History:

Merge 3, ADS



Merge 4, Smith Chart

$$\theta_{L1} = 16.1^\circ \quad \theta_{S2} = 12.6^\circ$$

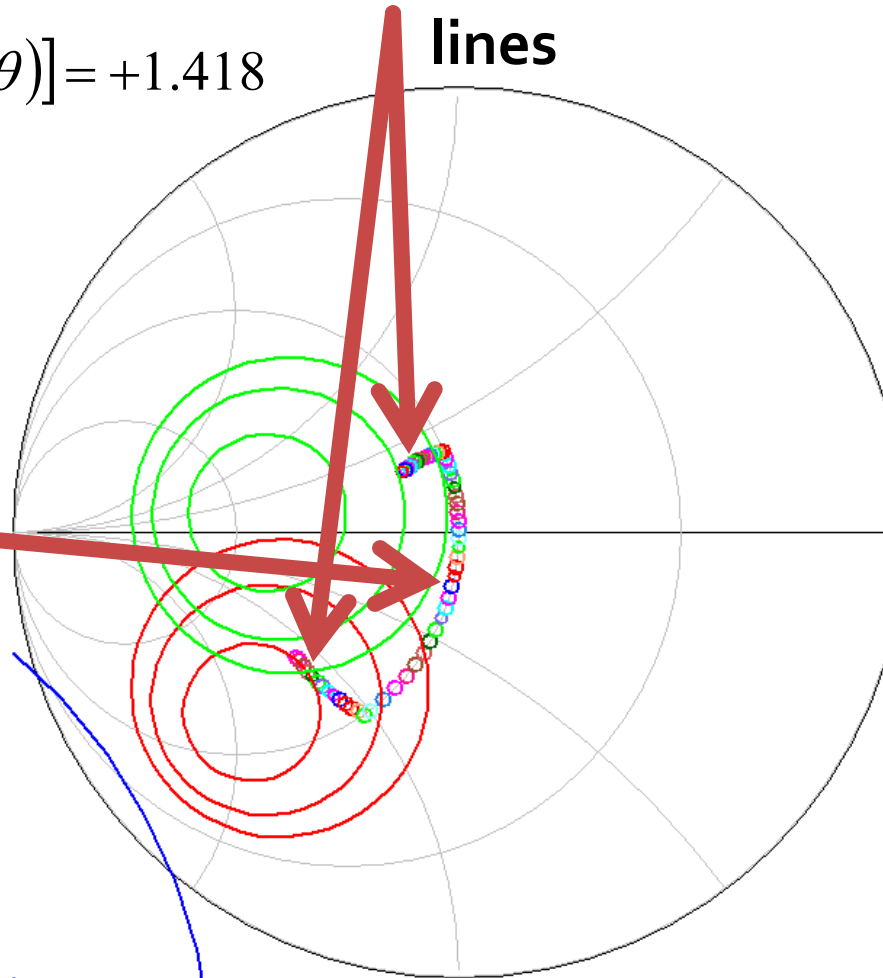
$$\text{Im}[y_{sp}] = \text{Im}[y_{L1}(\theta)] + \text{Im}[y_{S2}(\theta)] = +1.418$$

$$\theta_{sp} = 54.8^\circ$$

“combined”
stub

ref.:CSIN
ref.:CZ
ref.:CCIN
S(1,2)

series
lines



Tune Control

Select a parameter to tune by clicking on it

Simulate:

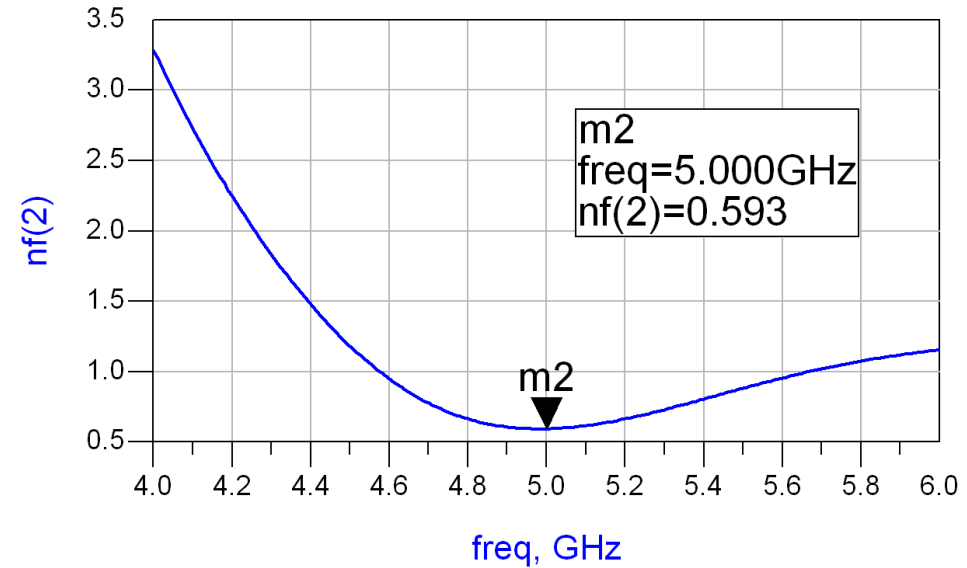
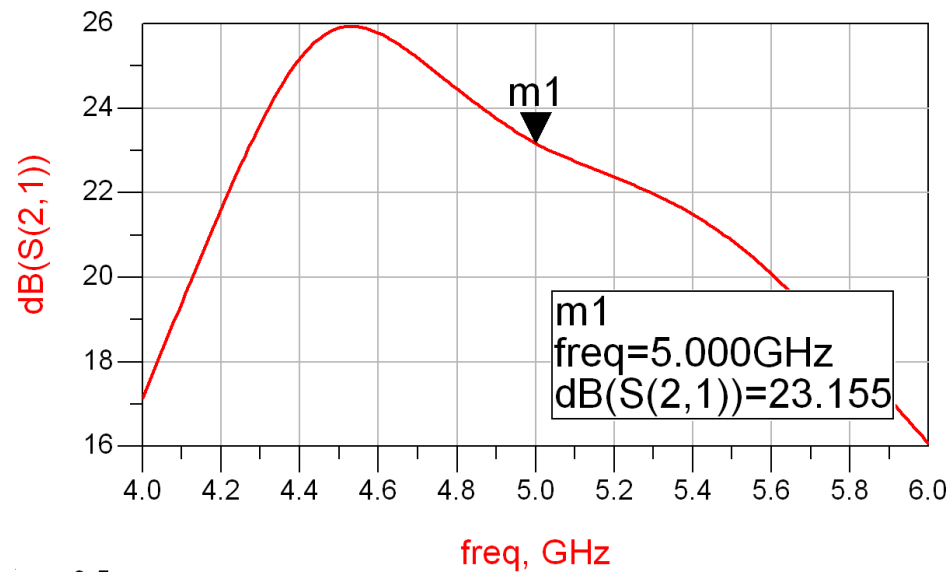
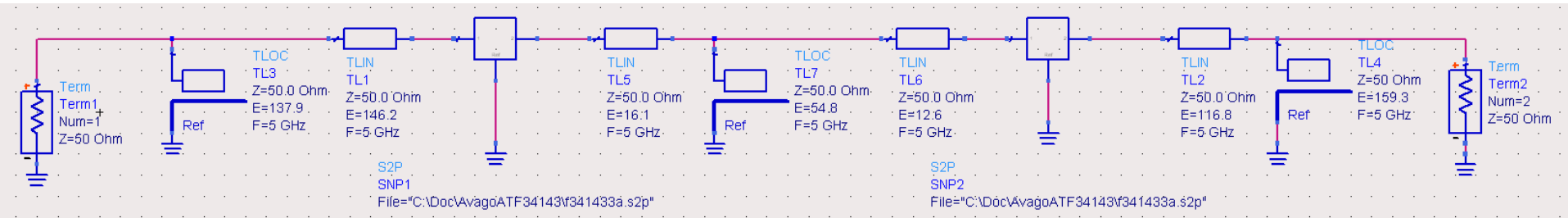
Trace History:

lini_inter_smith2.TL1.E

lini_inter_smith2.TL2.E

lini_inter_smith2.TL3.E

Merge 4, ADS



Interstage matching 2

- All the combinations obtained meet the target conditions for gain and noise
- Choose a convenient one depending on:
 - the physical dimensions of the lines $l = \frac{\theta}{360^\circ} \cdot \lambda$
 - frequency bandwidth/flatness
 - stability
 - performance (noise/gain)
 - input and output reflection
 - etc.

Supplement Mini Project

Implementation in microstrip technology

- microstrip lines
 - dielectric layer
 - plane metallization (ground plane)
 - traces which will control:
 - characteristic impedance
 - physical/electrical length

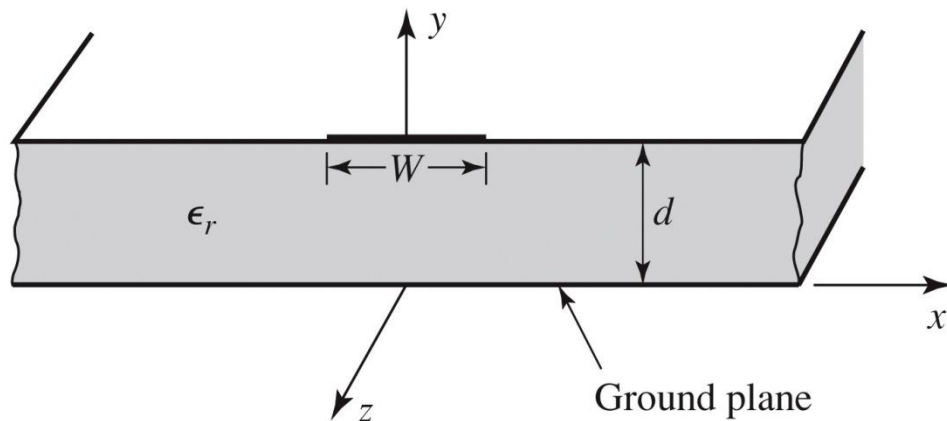


Figure 3.25a
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Implementation in microstrip technology

- quasi TEM line

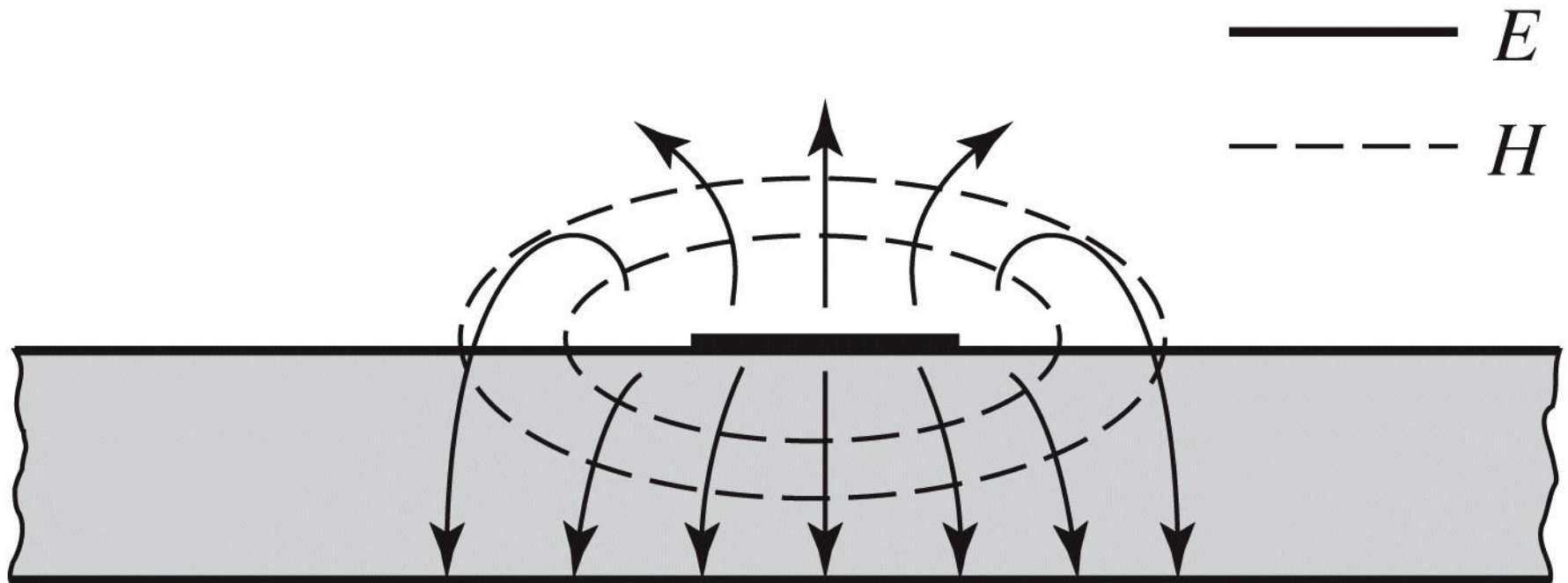
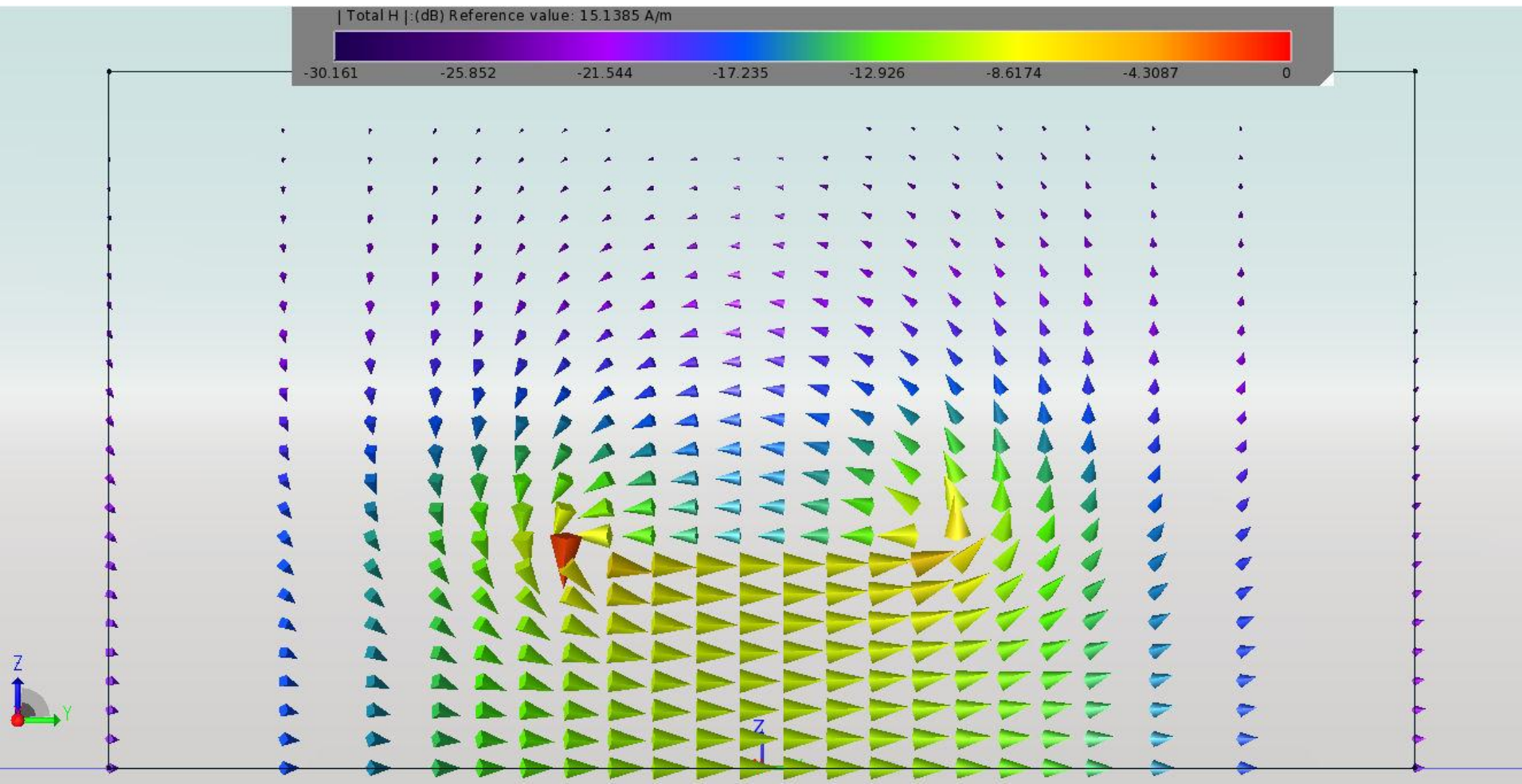


Figure 3.25b
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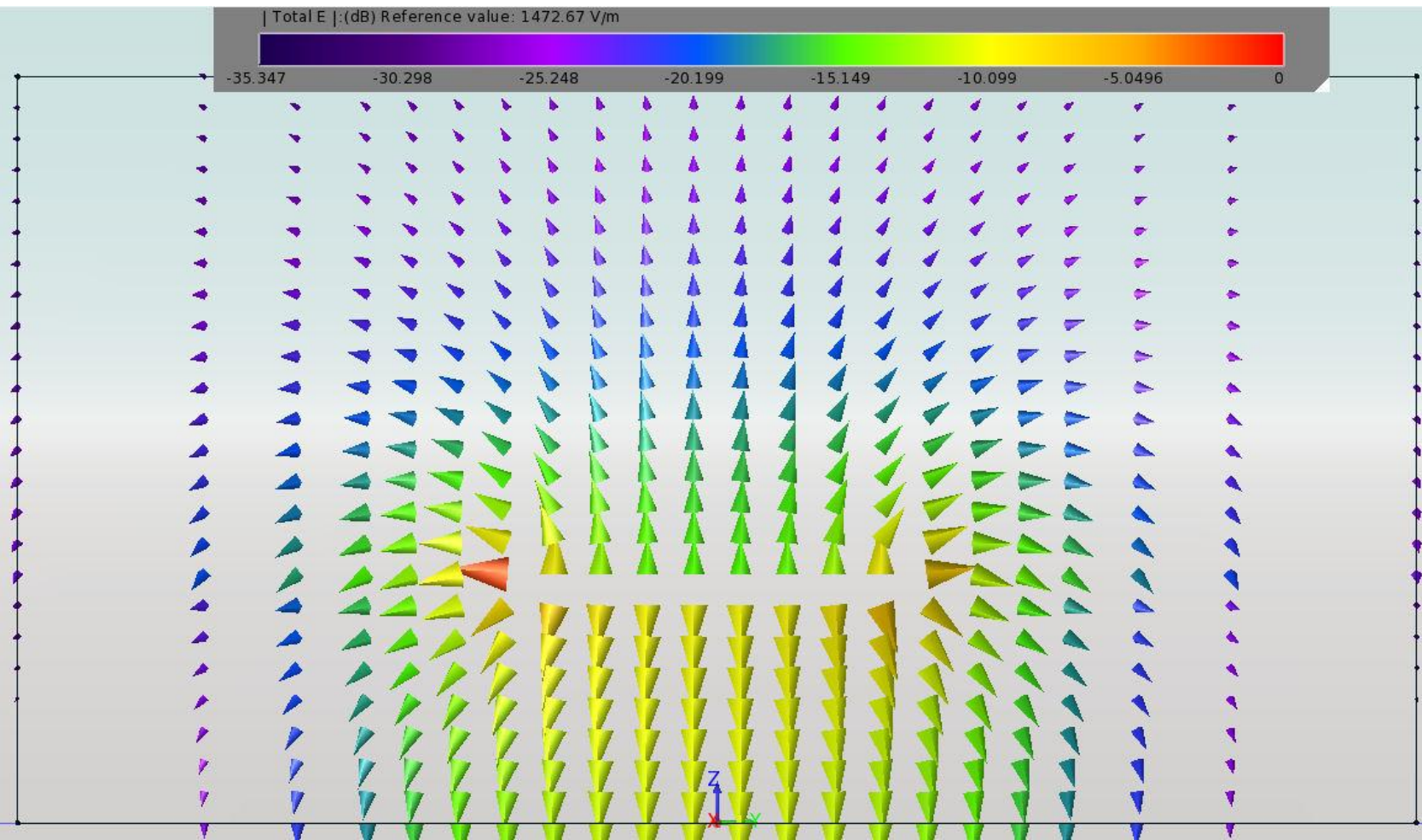
Implementation in microstrip technology

- quasi TEM line, EmPro



Implementation in microstrip technology

- quasi TEM line, EmPro

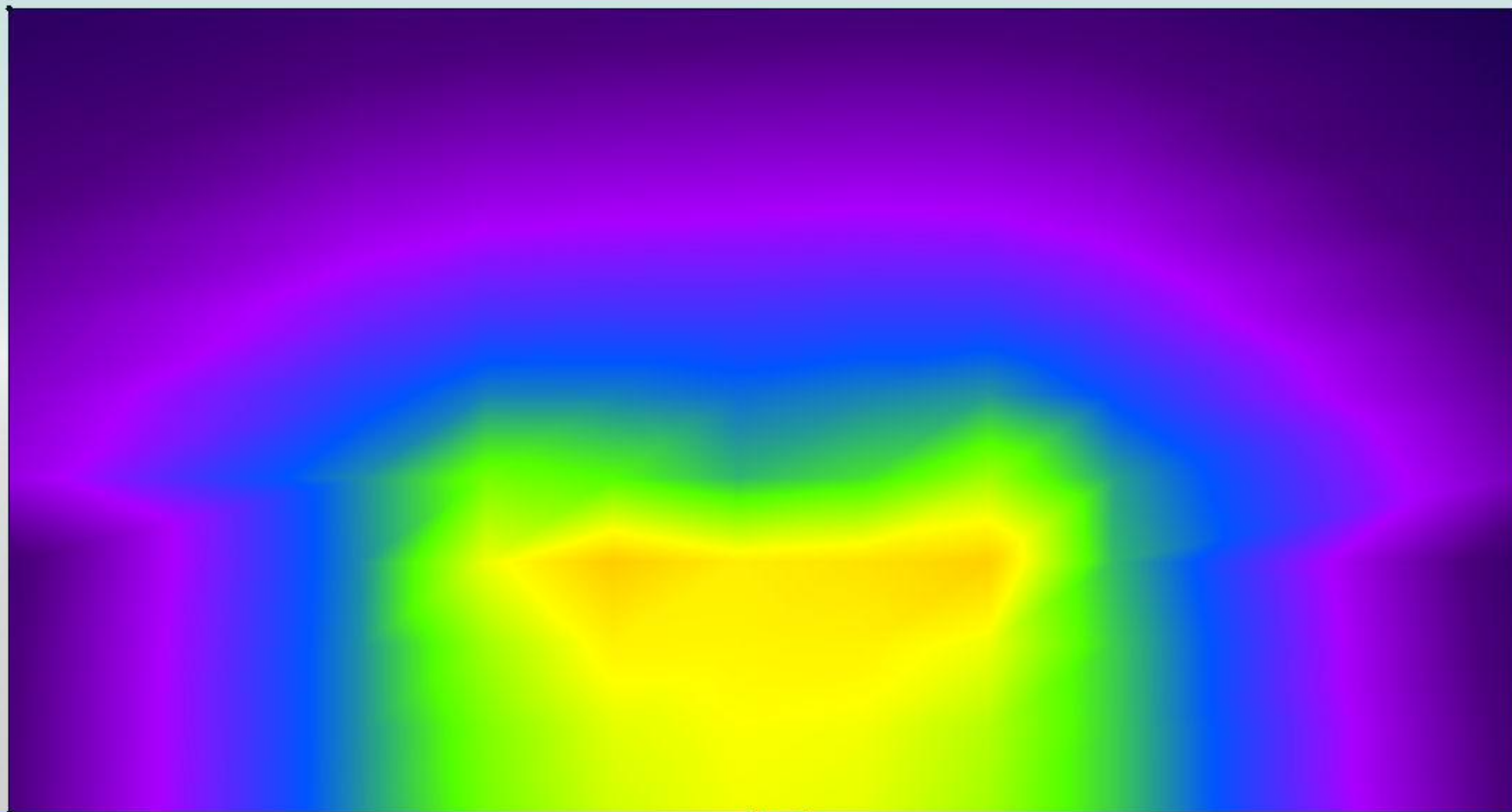


Implementation in microstrip technology

- quasi TEM line, EmPro

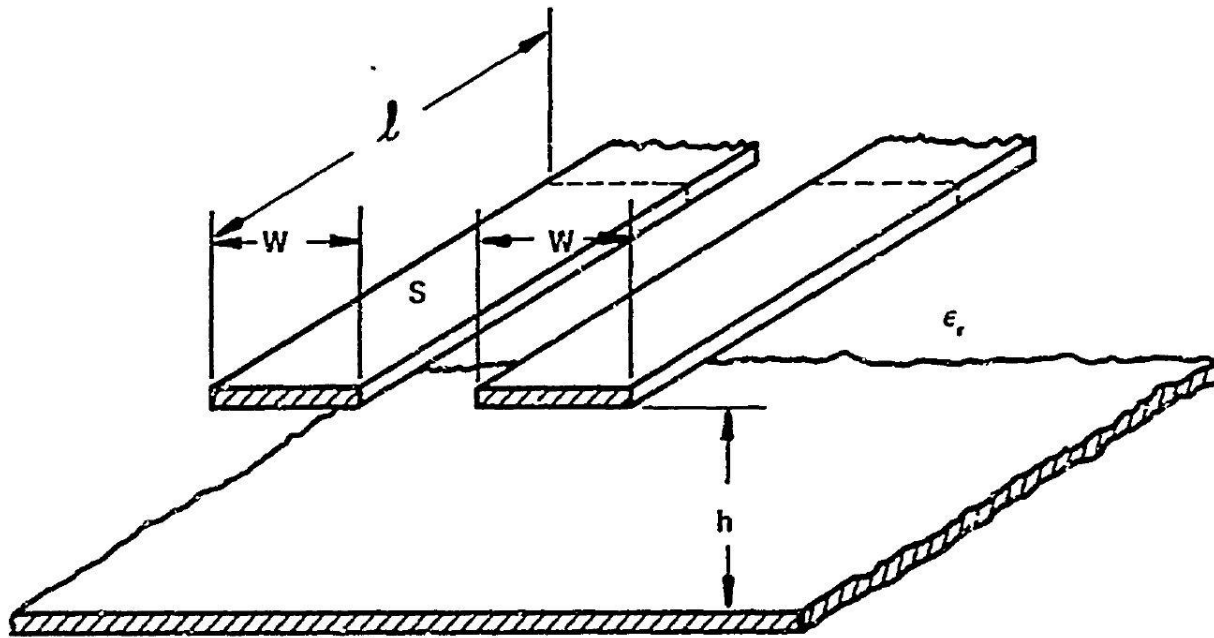


(85, 42, 48)



Implementation in microstrip technology

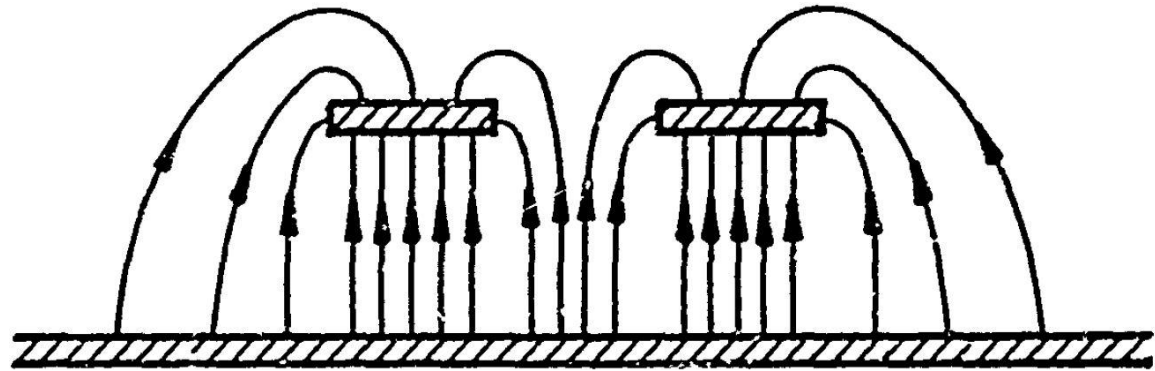
- ~ quasi TEM



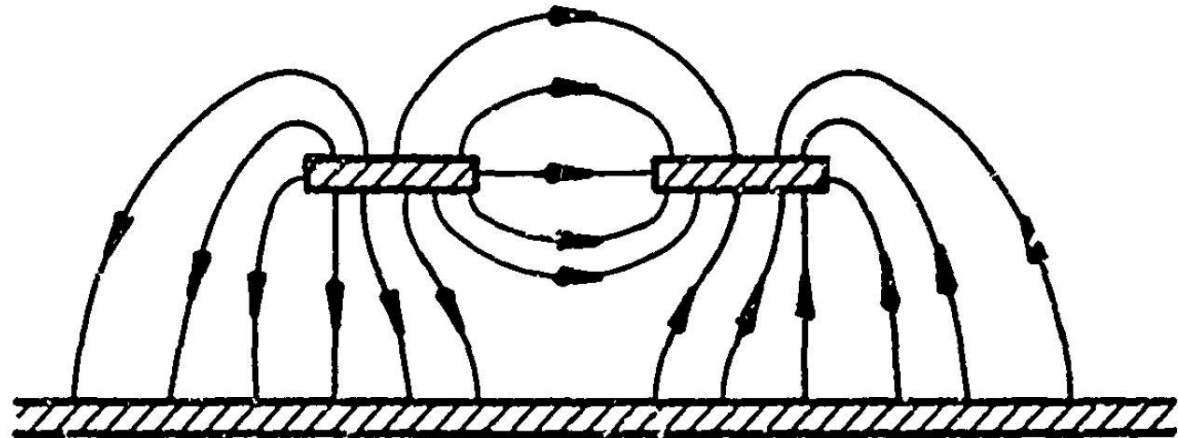
a) COUPLED STRIP GEOMETRY

Implementation in microstrip technology

- ~ quasi TEM



b) EVEN MODE ELECTRIC FIELD PATTERN (SCHEMATIC)



c) ODD MODE ELECTRIC FIELD PATTERN (SCHEMATIC)

Implementation in microstrip technology

- Equivalent geometry of a quasi-TEM microstrip line with effective dielectric constant homogeneous medium

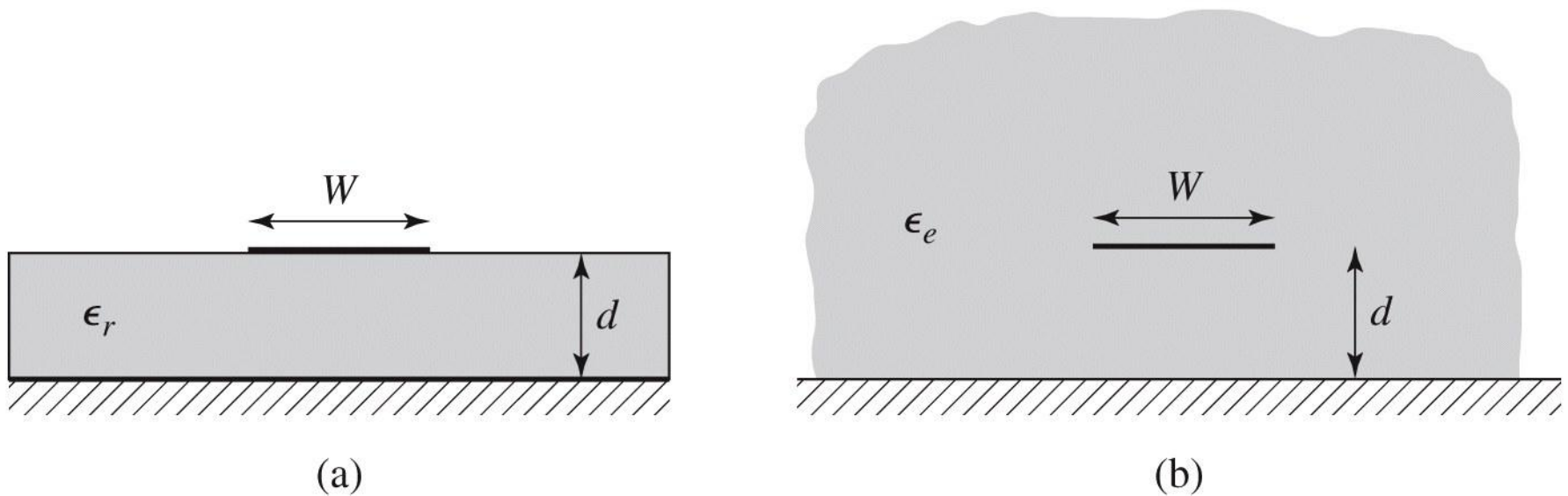


Figure 3.26
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Design

■ Empirical formulas

$$v_p = \frac{c}{\sqrt{\epsilon_e}},$$

$$\beta = k_0 \sqrt{\epsilon_e},$$

$$\epsilon_e = \frac{\epsilon_r + 1}{2} + \frac{\epsilon_r - 1}{2} \frac{1}{\sqrt{1 + 12d/W}}.$$

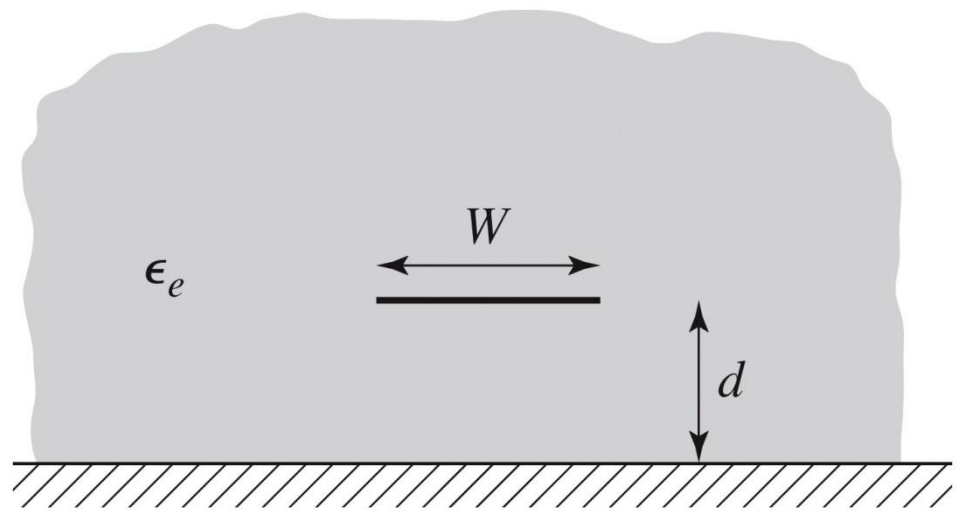


Figure 3.26b
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$$Z_0 = \begin{cases} \frac{60}{\sqrt{\epsilon_e}} \ln \left(\frac{8d}{W} + \frac{W}{4d} \right) & \text{for } W/d \leq 1 \\ \frac{120\pi}{\sqrt{\epsilon_e} [W/d + 1.393 + 0.667 \ln (W/d + 1.444)]} & \text{for } W/d \geq 1. \end{cases}$$

Design

- Empirical formulas

$$A = \frac{Z_0}{60} \sqrt{\frac{\epsilon_r + 1}{2}} + \frac{\epsilon_r - 1}{\epsilon_r + 1} \left(0.23 + \frac{0.11}{\epsilon_r} \right)$$

$$B = \frac{377\pi}{2Z_0\sqrt{\epsilon_r}}$$

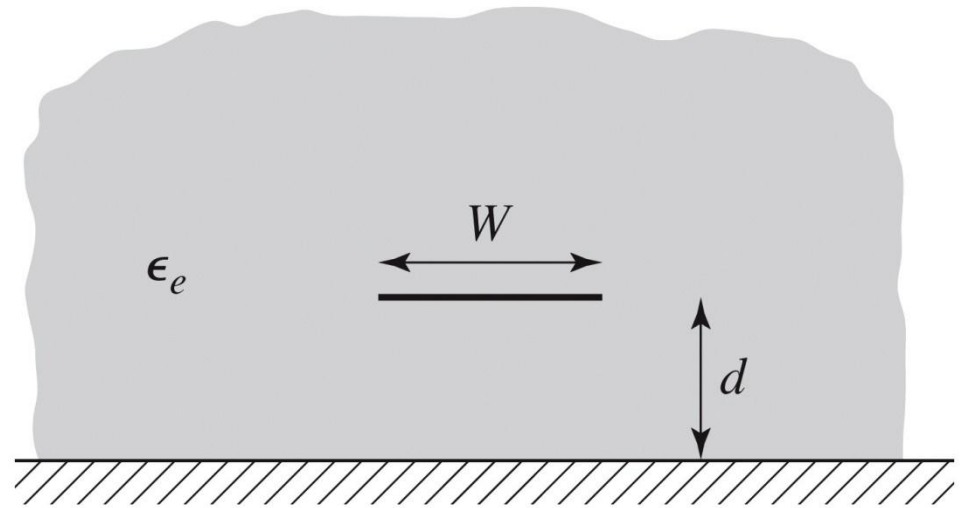
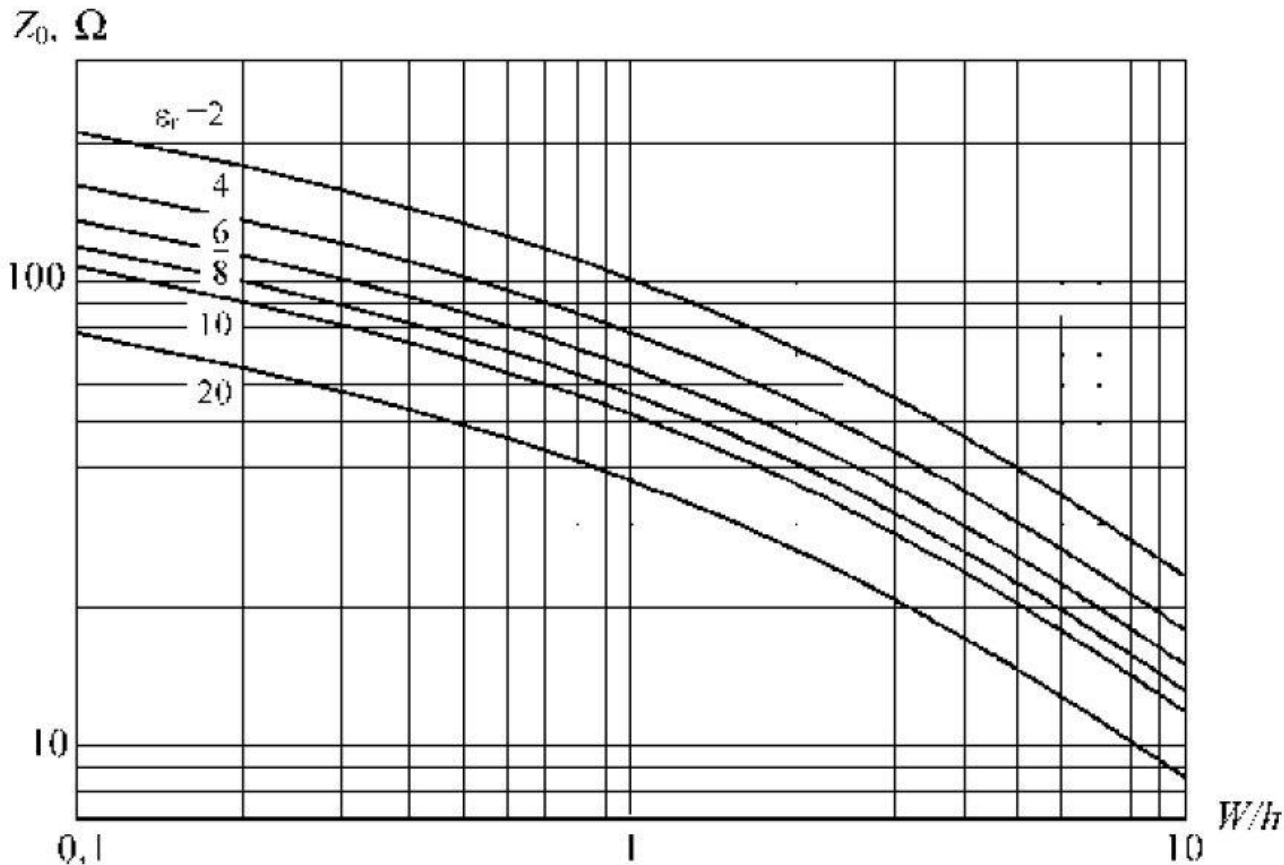


Figure 3.26b
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$$\frac{W}{d} = \begin{cases} \frac{8e^A}{e^{2A} - 2} & \text{for } W/d < 2 \\ \frac{2}{\pi} \left[B - 1 - \ln(2B - 1) + \frac{\epsilon_r - 1}{2\epsilon_r} \left\{ \ln(B - 1) + 0.39 - \frac{0.61}{\epsilon_r} \right\} \right] & \text{for } W/d > 2, \end{cases}$$

Characteristic impedance

- **Large impedances** require **narrow traces**
- **Small impedances** require **wide traces**



$$k_0 = \frac{2\pi f}{c}$$
$$\beta l = \sqrt{\epsilon_e} k_0 l,$$

Microstrip standardization

- Standardization
 - dimensions in **mil**
 - 1 mil = 10^{-3} inch
 - 1 inch = 2.54 cm
- Trace thickness
 - based on the weight of the deposited copper
 - oz/ft²
 - 1oz=28.35g and 1ft=30.48cm

Weight of the deposited copper		Trace thickness	
oz/ft ²	g/ft ²	inch	mm
0.5	14.175	0.0007	0.0178
1.0	28.35	0.0014	0.0356
2.0	56.7	0.0028	0.0712

Microstrip standardization

- Typically the height of the dielectric layers is also standardized in mil

Standard Thickness

RO4003C:

0.008" (0.203mm), 0.012 (0.305mm), 0.016" (0.406mm),
0.020" (0.508mm)

0.032" (0.813mm), 0.060" (1.524mm)

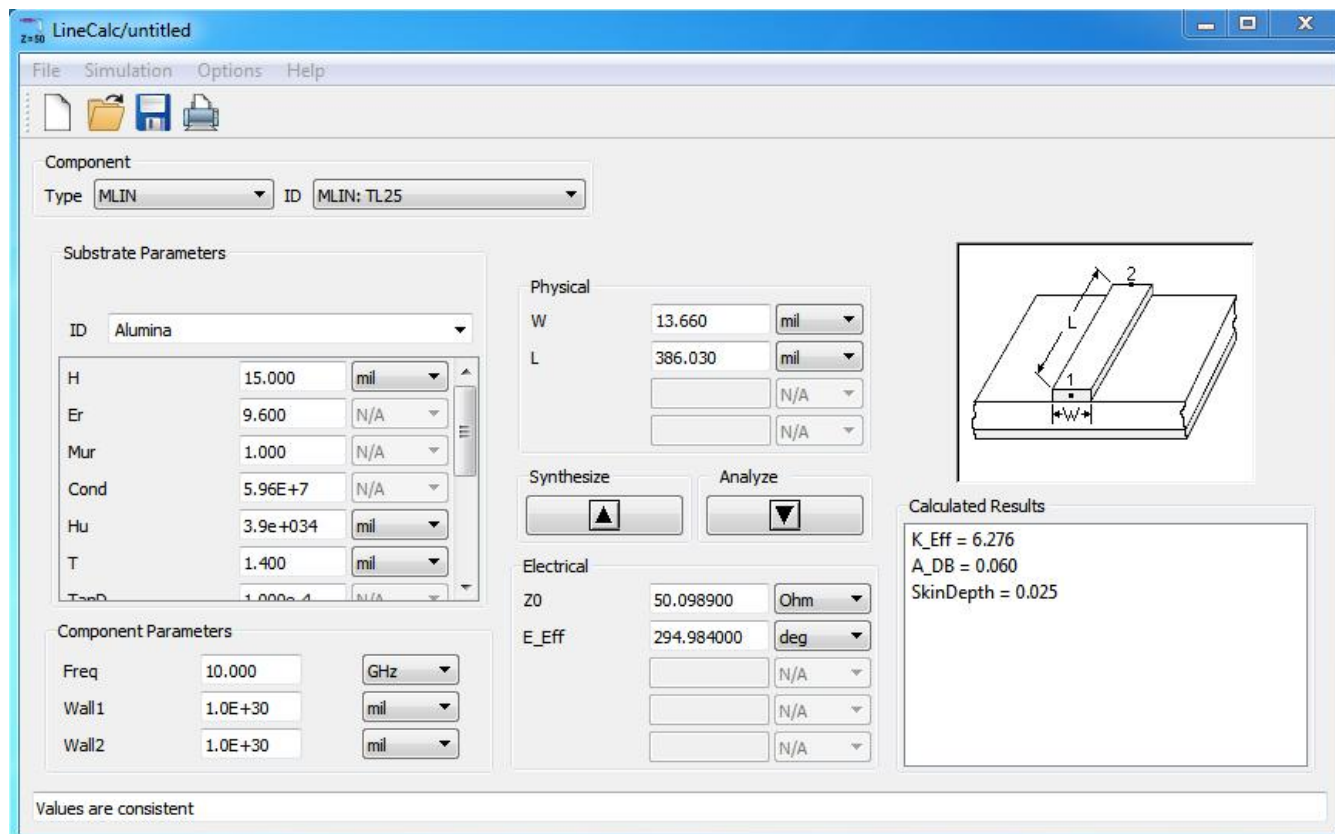
RO4350B:

*0.004" (0.101mm), 0.0066" (0.168mm) 0.010" (0.254mm),
0.0133 (0.338mm), 0.0166 (0.422mm), 0.020" (0.508mm)

0.030" (0.762mm), 0.060" (1.524mm)

ADS linecalc

- In schematics: >Tools>LineCalc>Start
- for Microstrip lines >Tools>LineCalc>Send to Linecalc



ADS linecalc

- 1. Define substrate (receive from schematic)
- 2. Insert frequency
- 3. Insert input data
 - Analyze: $W, L \rightarrow Z_o, E$ or Z_e, Z_o, E / at f [GHz]
 - Synthesis: $Z_o, E \rightarrow W, L$ / at f [GHz]

The screenshot shows the ADS LineCalc software interface. The window title is "LineCalc/untitled". The menu bar includes "File", "Simulation", "Options", and "Help". The "Component" section shows "Type: MLIN" and "ID: MLIN: TL25".

The "Substrate Parameters" section is circled in red and labeled "1". It includes a table of parameters:

ID	Aluminum		
H	15.000	mil	
Er	9.600	N/A	
Mur	1.000	N/A	
Cond	5.96E+7	N/A	
Hu	3.9e+034	mil	
T	1.400	mil	
Tz	1.000e-1		

The "Physical" section is circled in red and labeled "3". It includes a table of parameters:

W	13.660	mil
L	386.030	mil
		N/A
		N/A

The "Component Parameters" section is circled in red and labeled "2". It includes a table of parameters:

Freq	10.000	GHz
Wall1	1.0E+30	mil
Wall2	1.0E+30	mil

The "Calculated Results" section shows the following values:

- K_Eff = 6.276
- A_DB = 0.060
- SkinDepth = 0.025

A diagram of a microstrip line is shown on the right, with dimensions W, L, and H labeled. A red "3" is placed next to the diagram.

ADS linecalc

- Can be used for:
 - microstrip lines MLIN: $W, L \Leftrightarrow Z_0, E$
 - microstrip coupled lines MCLIN: $W, L, S \Leftrightarrow Z_e, Z_0, E$

The screenshot shows the ADS LineCalc interface for a single microstrip line (MLIN). The component type is set to MLIN with ID MLIN: TL25. The substrate is Alumina. The physical parameters are W = 13.660 mil and L = 386.030 mil. The calculated results are K_Eff = 6.276, A_DB = 0.060, and SkinDepth = 0.025. A diagram shows a single microstrip line on a substrate with width W and length L.

Parameter	Value	Unit
W	13.660	mil
L	386.030	mil
Z ₀	50.098900	Ohm
E _{Eff}	294.984000	deg

Calculated Results

- K_{Eff} = 6.276
- A_{DB} = 0.060
- SkinDepth = 0.025

The screenshot shows the ADS LineCalc interface for a microstrip coupled line (MCLIN). The component type is set to MCLIN with ID MCLIN: MCLIN_DEFAULT. The substrate is Alumina. The physical parameters are W = 9.924291 mil, S = 7.993661 mil, and L = 121.714173 mil. The calculated results are K_E = 6.978, K_O = 4.870, A_{E,DB} = 0.018, A_{O,DB} = 0.032, and SkinDepth = 0.025. A diagram shows two coupled microstrip lines on a substrate with width W, spacing S, and length L.

Parameter	Value	Unit
W	9.924291	mil
S	7.993661	mil
L	121.714173	mil
Z _e	70.040	Ohm
Z ₀	39.370	Ohm
E _{Eff}	90.000	deg

Calculated Results

- K_E = 6.978
- K_O = 4.870
- A_{E,DB} = 0.018
- A_{O,DB} = 0.032
- SkinDepth = 0.025

ADS linecalc

LineCalc/untitled

File Simulation Options Help

Component
Type: MCLIN ID: MCLIN: MCLIN_DEFAULT

Substrate Parameters

Parameter	Value	Unit
ID	Alumina	
H	15.000	mil
Er	9.600	N/A
Mur	1.000	N/A
Cond	5.96E+7	N/A
Hu	3.9e+034	mil
T	1.400	mil
TanD	1.000e-4	N/A

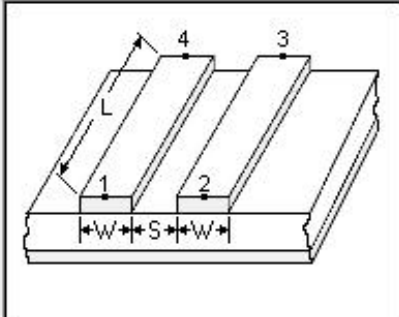
Physical

W	9.924291	mil
S	7.993661	mil
L	121.714173	mil
		N/A

Synthesize Analyze

Electrical

ZE	70.040	Ohm
ZO	39.370	Ohm
Z0	52.511663	Ohm
C_DB	-11.046865	N/A
E_Eff	90.000	deg



Calculated Results

KE = 6.978
KO = 4.870
AE_DB = 0.018
AO_DB = 0.032
SkinDepth = 0.025

Values are consistent

Transmission lines

- <http://rf-opto.etti.tuiasi.ro>
- Transmission lines / Rogers
 - more precise formulas including
 - t , trace thickness
 - f , frequency
 - formulas for
 - microstrip
 - strip
 - coupled lines

Implementation in microstrip technology

MTEE

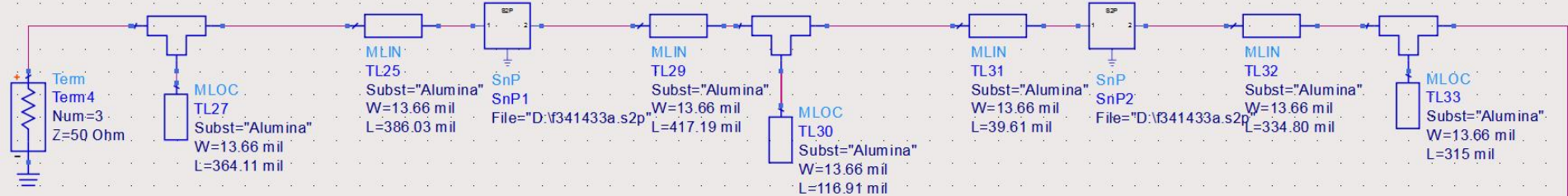
Tee1
Subst="Alumina"
W1=13.66 mil
W2=13.66 mil
W3=13.66 mil

MTEE

Tee2
Subst="Alumina"
W1=13.66 mil
W2=13.66 mil
W3=13.66 mil

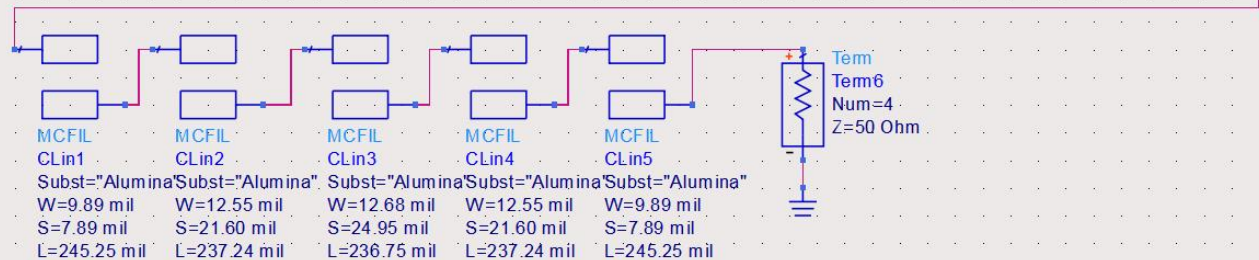
MTEE

Tee3
Subst="Alumina"
W1=13.66 mil
W2=13.66 mil
W3=13.66 mil



MSub

MSUB
Alumina
H=15 mil
Er=9.6
Mur=1
Cond=5.96E+7
Hu=3.9e+034 mil
T=1.4 mil
TanD=0.0001
Rough=0 mil

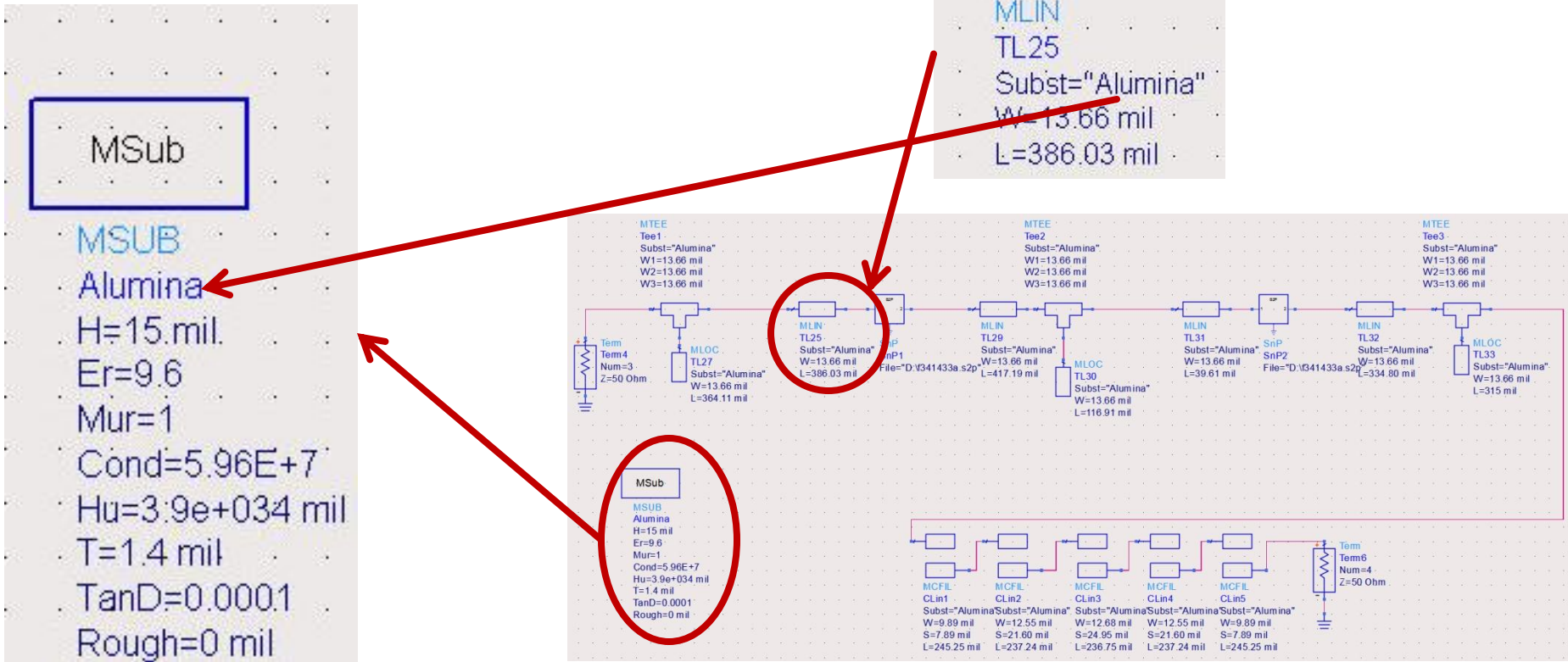


MCFIL	MCFIL	MCFIL	MCFIL	MCFIL
CLin1	CLin2	CLin3	CLin4	CLin5
Subst="Alumina"	Subst="Alumina"	Subst="Alumina"	Subst="Alumina"	Subst="Alumina"
W=9.89 mil	W=12.55 mil	W=12.68 mil	W=12.55 mil	W=9.89 mil
S=7.89 mil	S=21.60 mil	S=24.95 mil	S=21.60 mil	S=7.89 mil
L=245.25 mil	L=237.24 mil	L=236.75 mil	L=237.24 mil	L=245.25 mil

Tem6
Num=4
Z=50 Ohm

Implementation in microstrip technology

- On all schematics you must have a substrate model/component
- Microstrip lines and coupled lines are computed in Linecalc for the same substrate

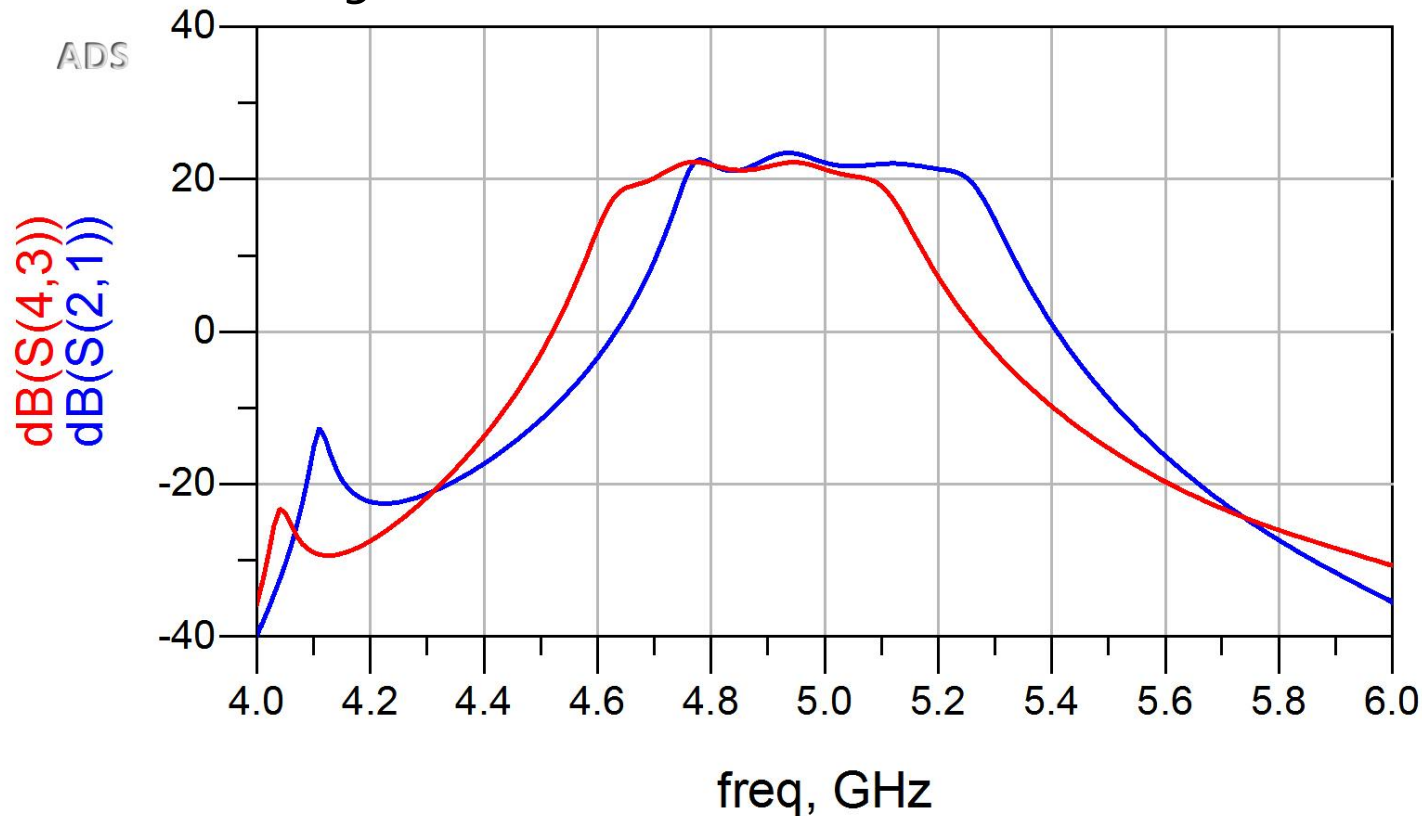


Implementation in microstrip technology

- We use components from the “Transmission Lines – Microstrip” palette
 - MSUB - substrate
 - MLIN – series line
 - MLOC – open-circuit shunt stub
 - MTEE – modeling of T junction (shunt stub connection to main line)
 - MCFIL – coupled line filter section (more accurate model than MCLIN – takes into account that two adjacent sections are physically close)

Implementation in microstrip technology

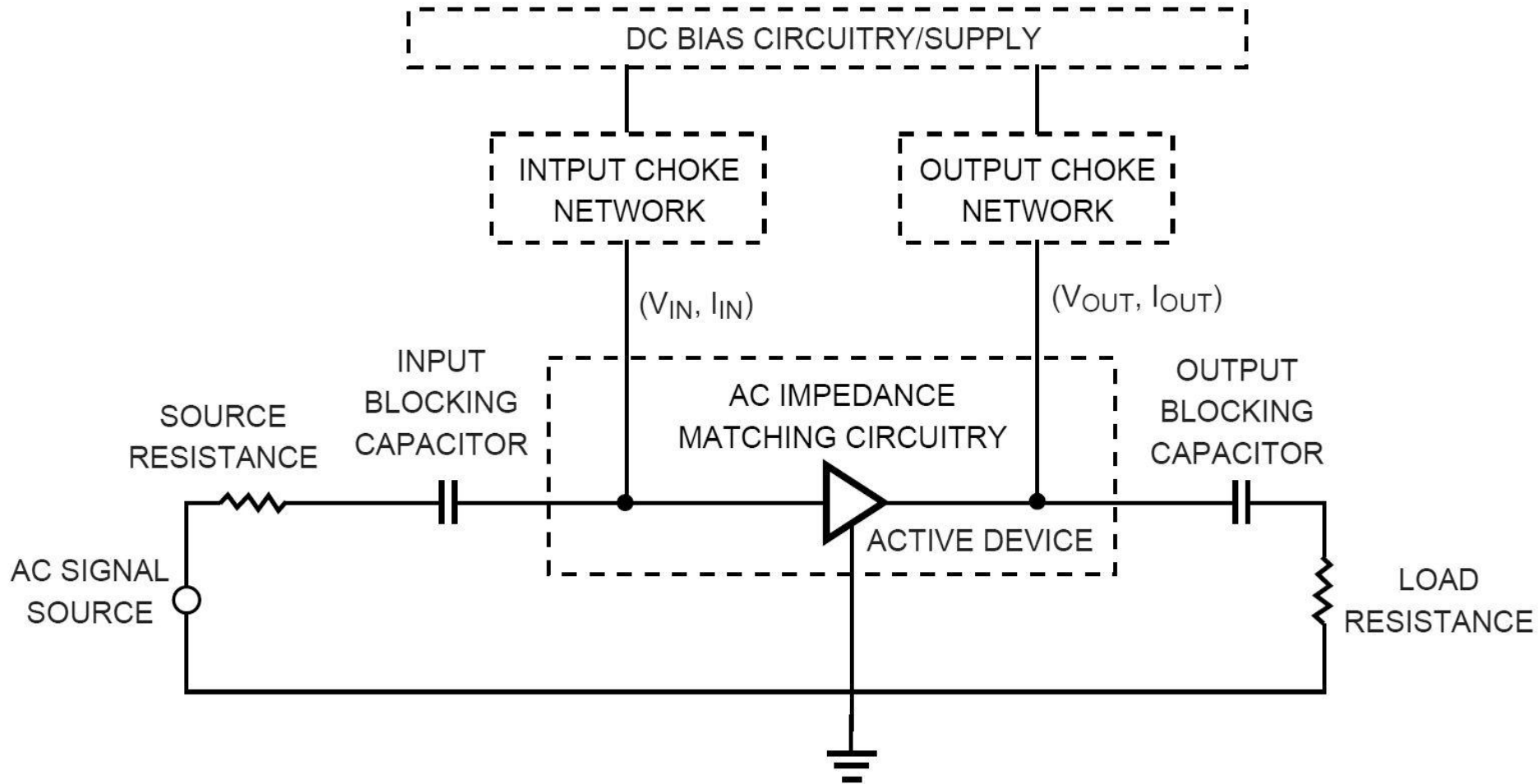
- Usually there is a shift of the transfer function (red) towards lower frequencies compared to the ideal model (blue)
 - due to the MCFIL/MCLIN difference
- Tune the length of filter elements to move the filter bandwidth around $f_0 = 5\text{GHz}$



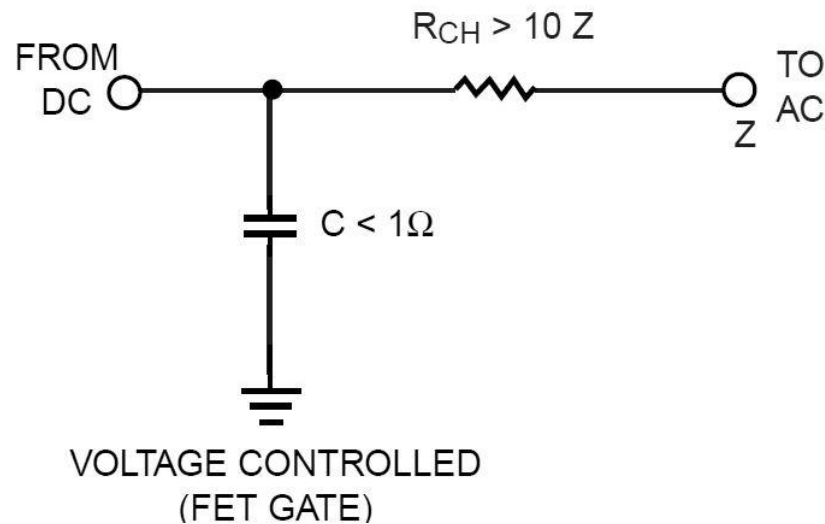
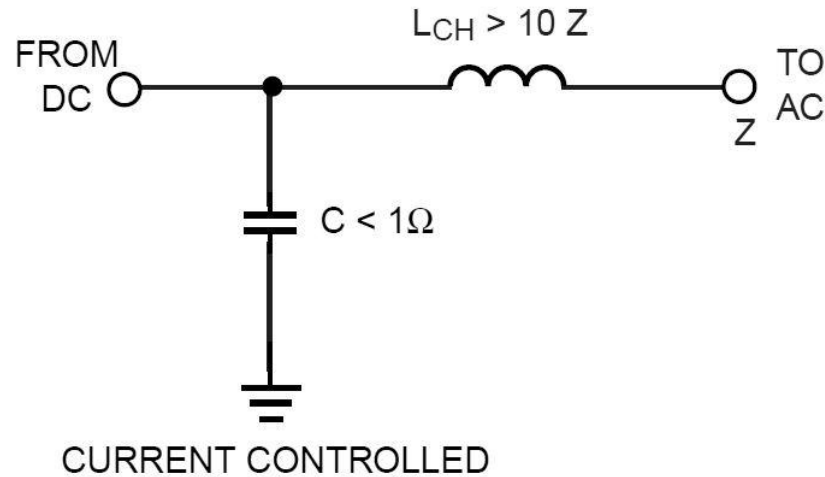
DC Bias

- <https://rf-opto.etti.tuiasi.ro>
- Agilent Application Notes
 - decoupling signal from DC Bias circuitry
 - DC Bias circuits for microwave transistors
- Appcad has tools for designing DC Bias circuits

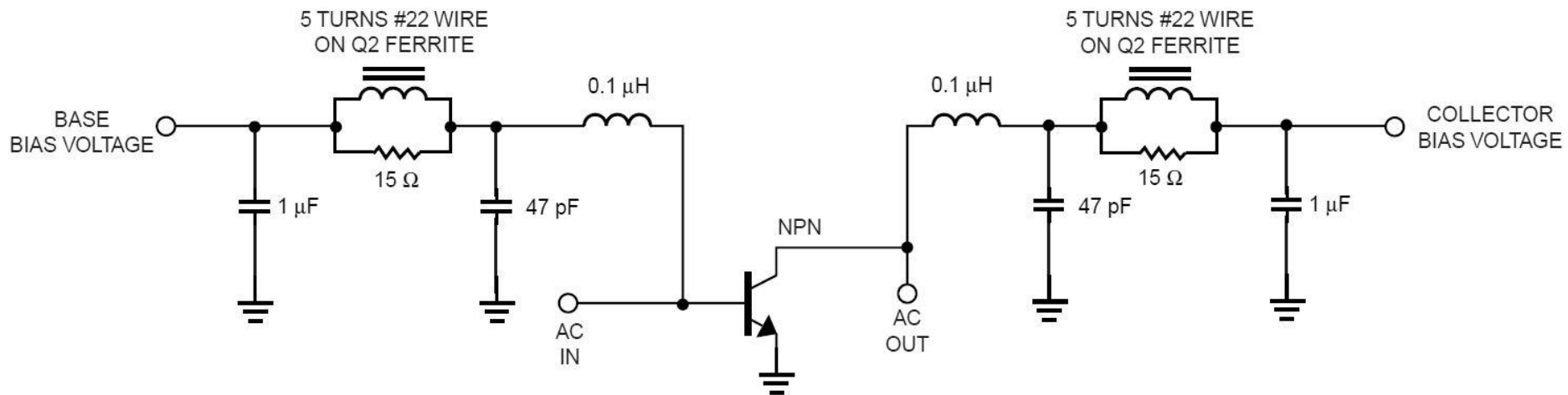
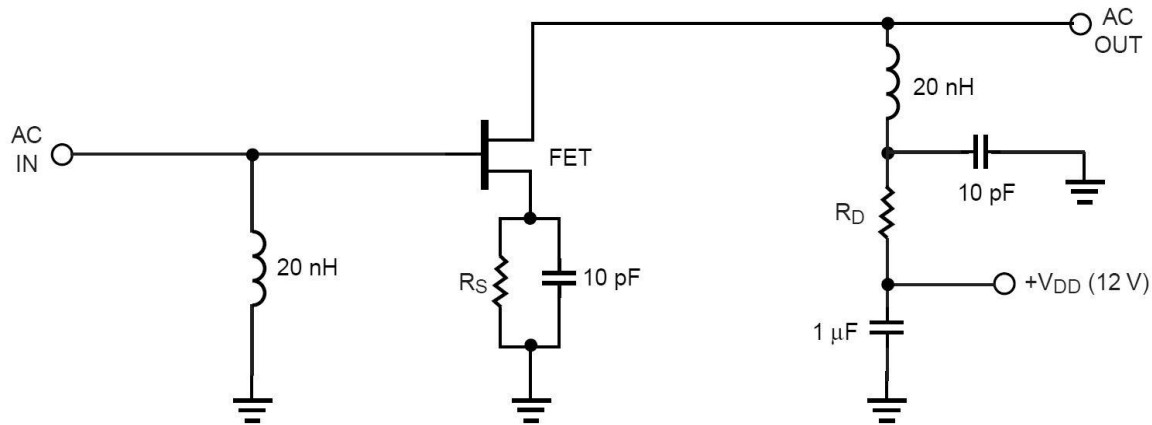
DC Bias



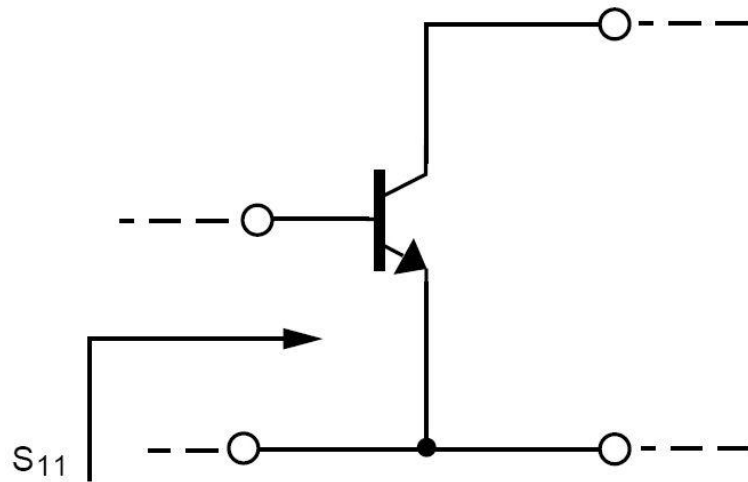
DC Bias, typical choke



DC Bias, typical schematics/values

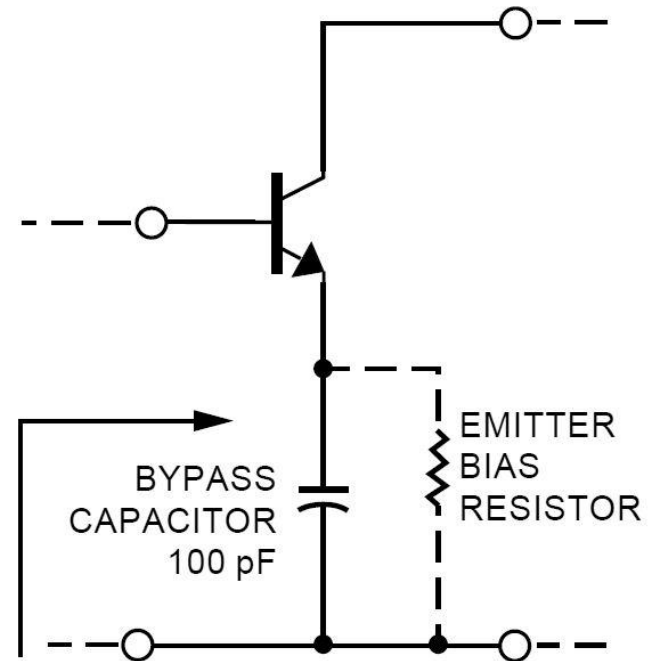


DC Bias, elements in E/S



$$S_{11} \text{ (AT 4 GHz)} = 0.52 \angle 154^\circ$$

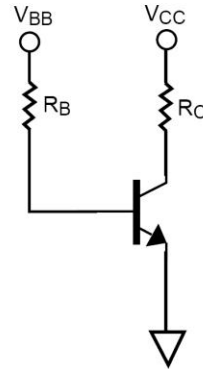
$$S_{11} \text{ (AT 0.1 GHz)} = 0.901 \angle -14.9^\circ$$



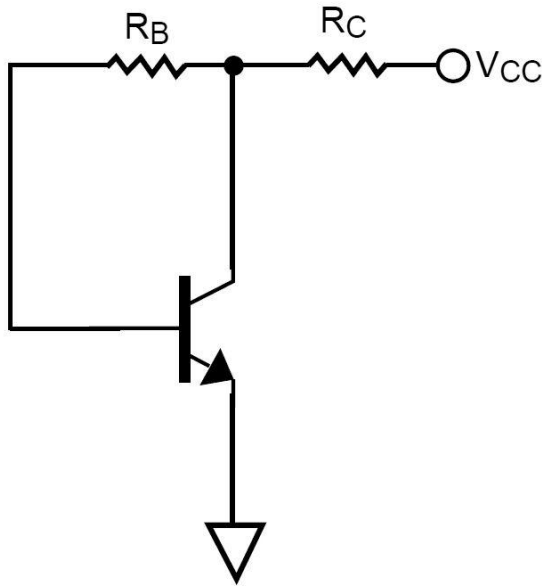
$$S'_{11} \text{ (AT 4 GHz)} = 0.52 \angle 154^\circ \text{ UNCHANGED AT 4 GHz}$$

$$S'_{11} \text{ (AT 0.1 GHz)} = 1.066 \angle -8.5^\circ \quad |S_{11}| > 1 \text{ AT 0.1GHz}$$

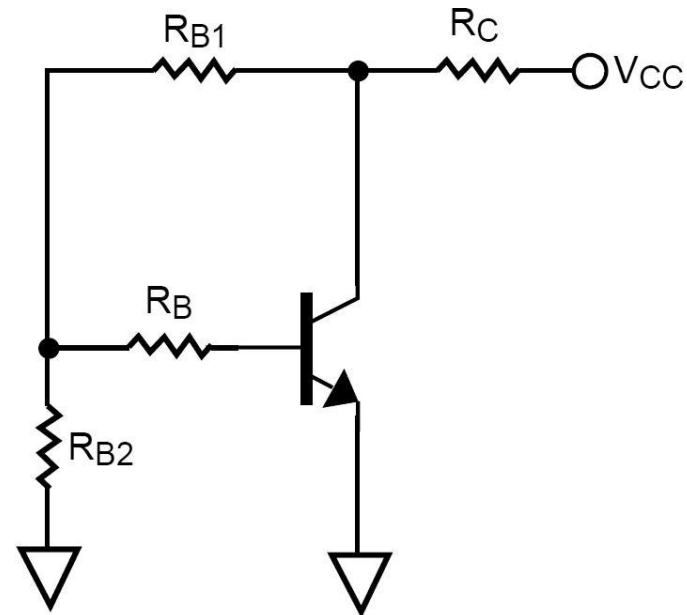
DC Bias, bipolar transistors



NON-STABILIZED



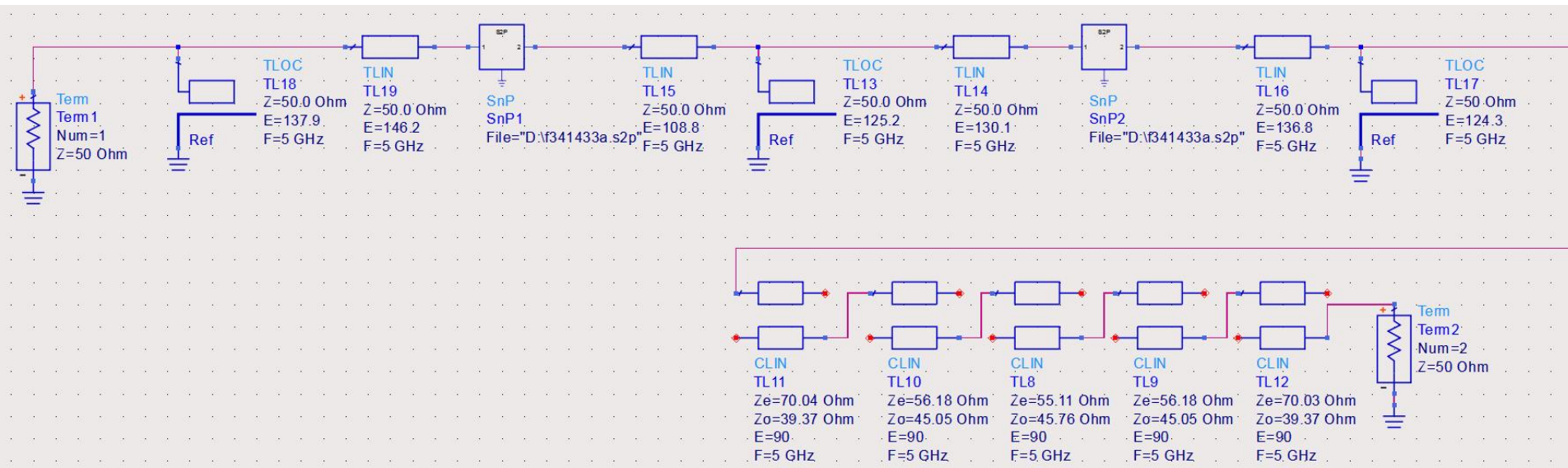
VOLTAGE FEEDBACK



VOLTAGE FEEDBACK AND CONSTANT
BASE CURRENT SOURCE

Example project

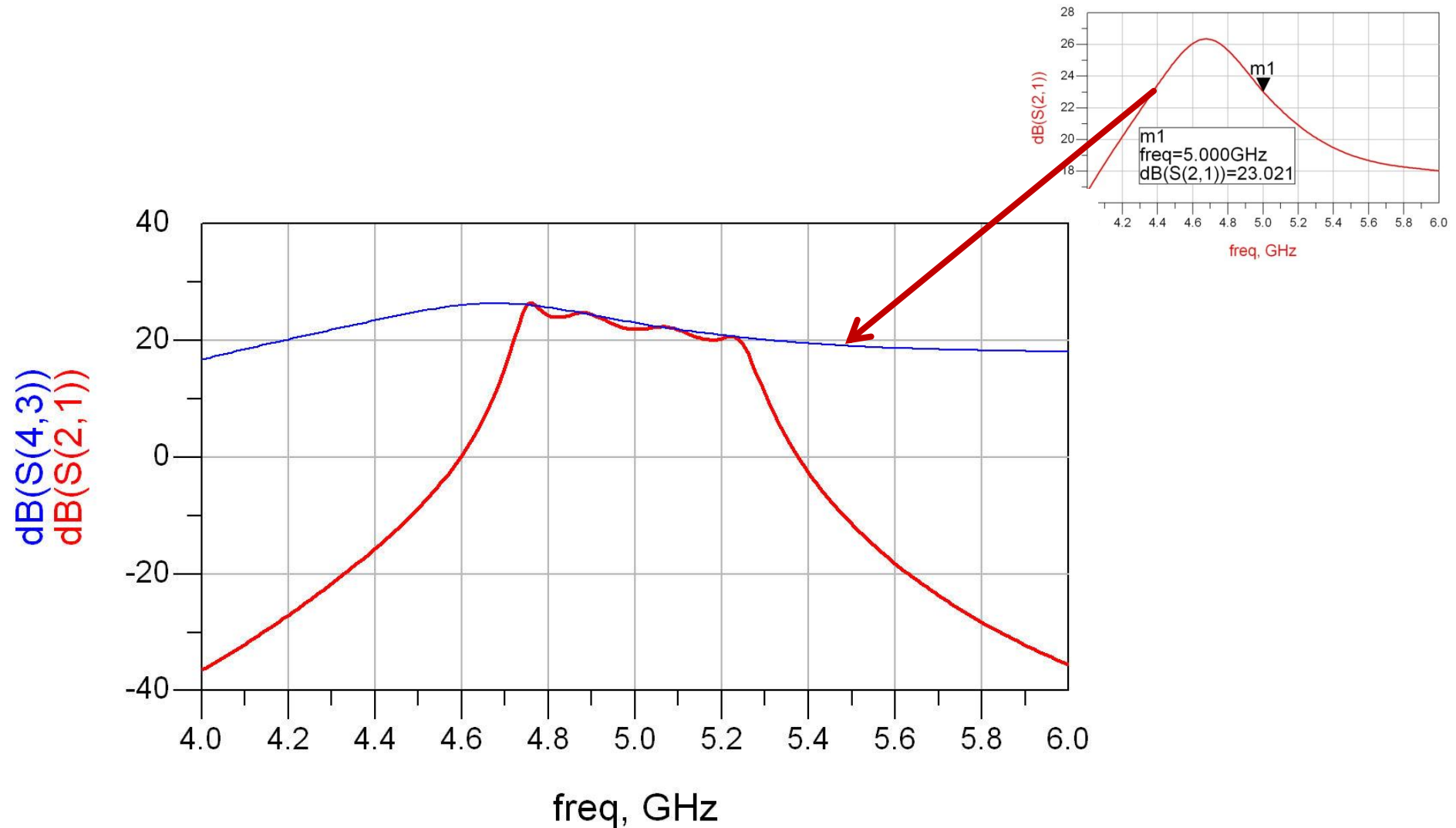
- Unify the two schematics
 - L10 – amplifier
 - L12 – filter



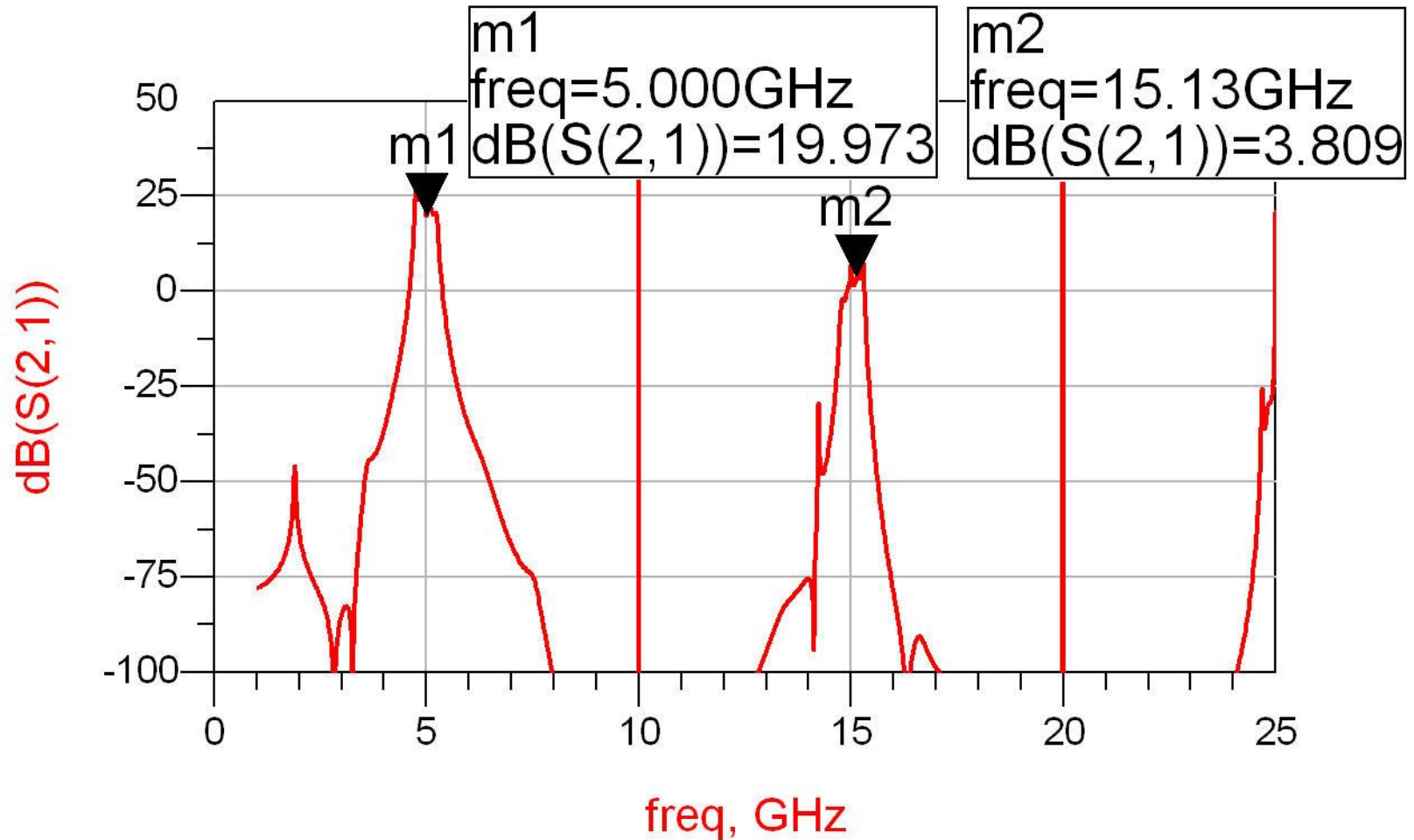
Result (unbalanced)



Result (unbalanced)

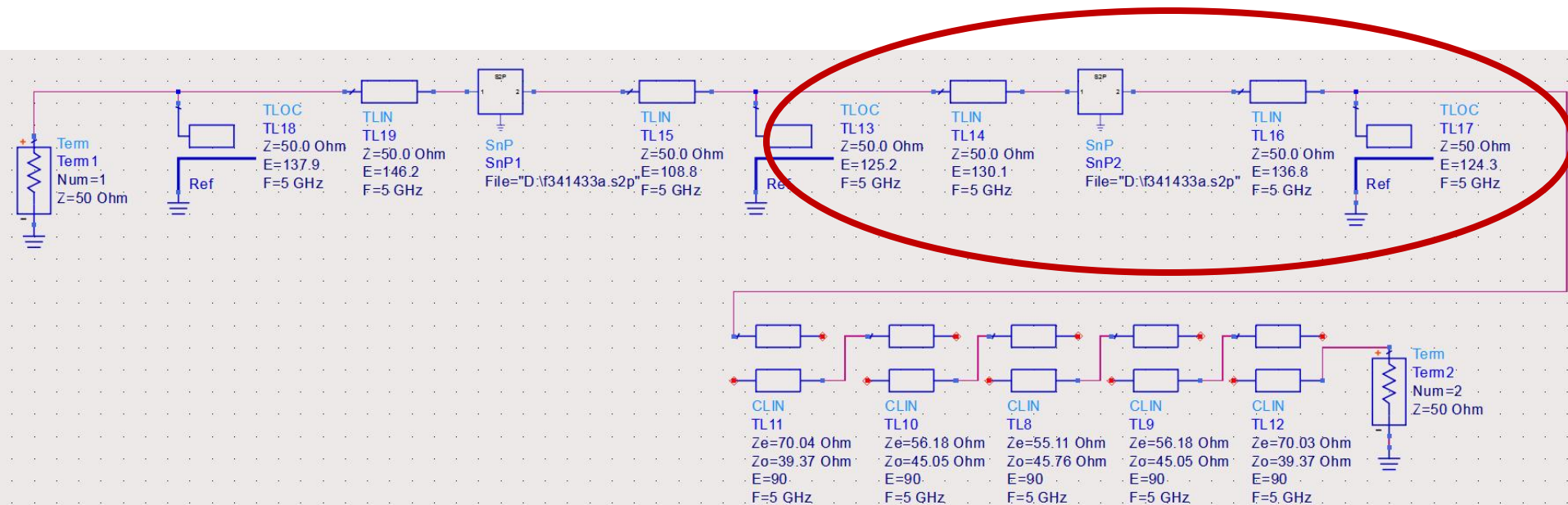


Result (~periodic in frequency)

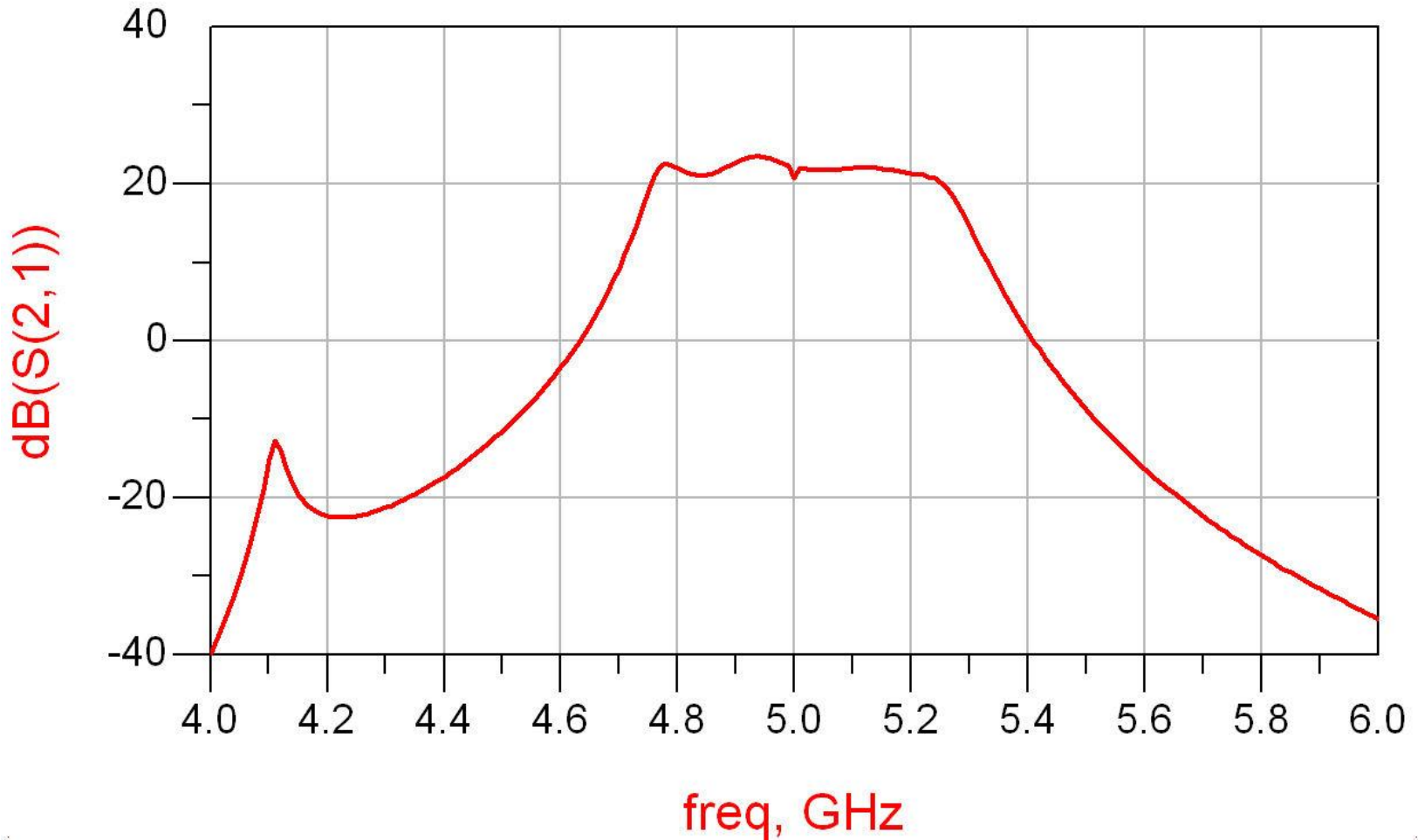


Tune -> balance

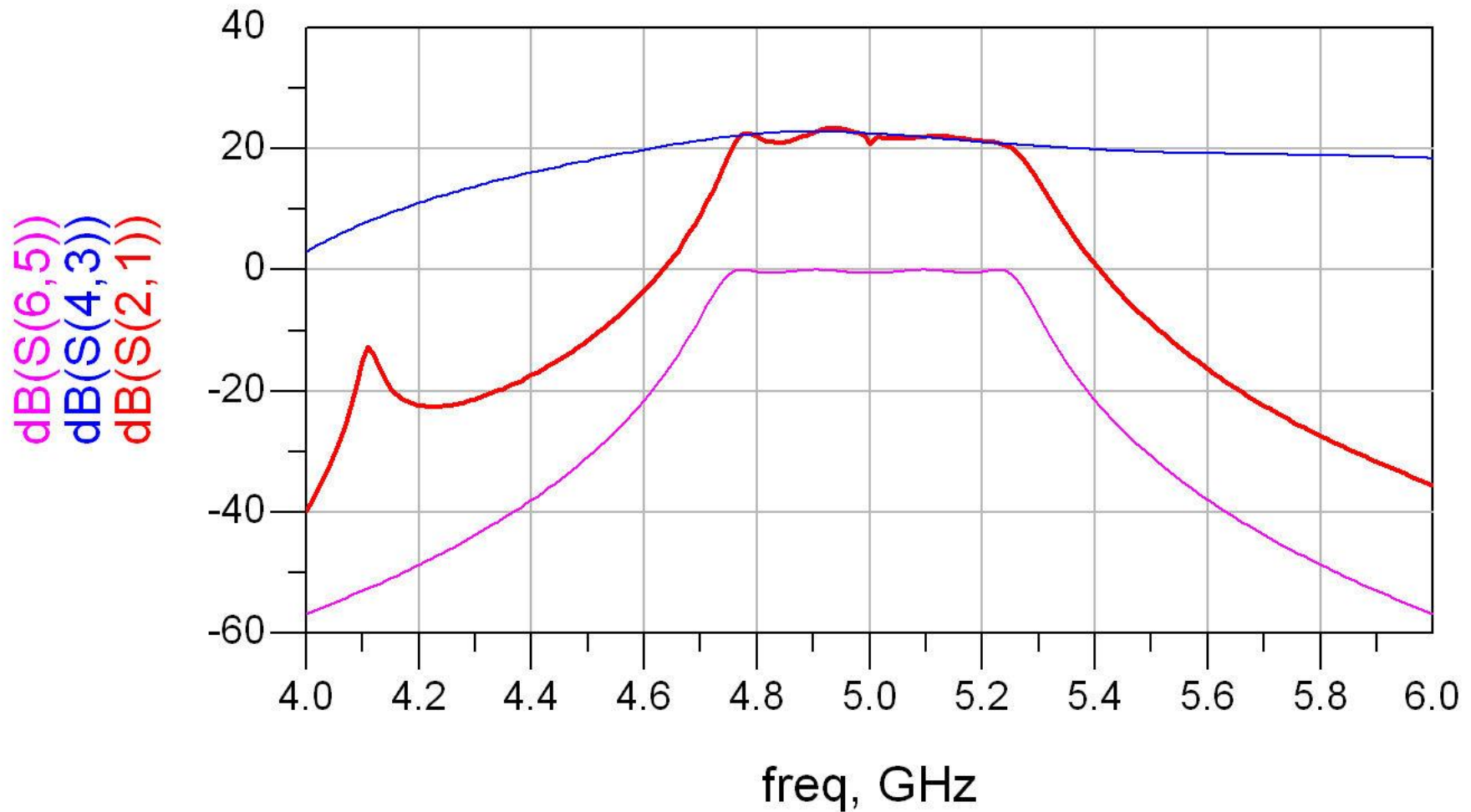
- purpose: balance the gain characteristic of the amplifier (maximum at design frequency)
 - favor tuning lines at the end of the amplifier
 - eliminate/minimize effect of the tune on noise



Tune -> balance, result

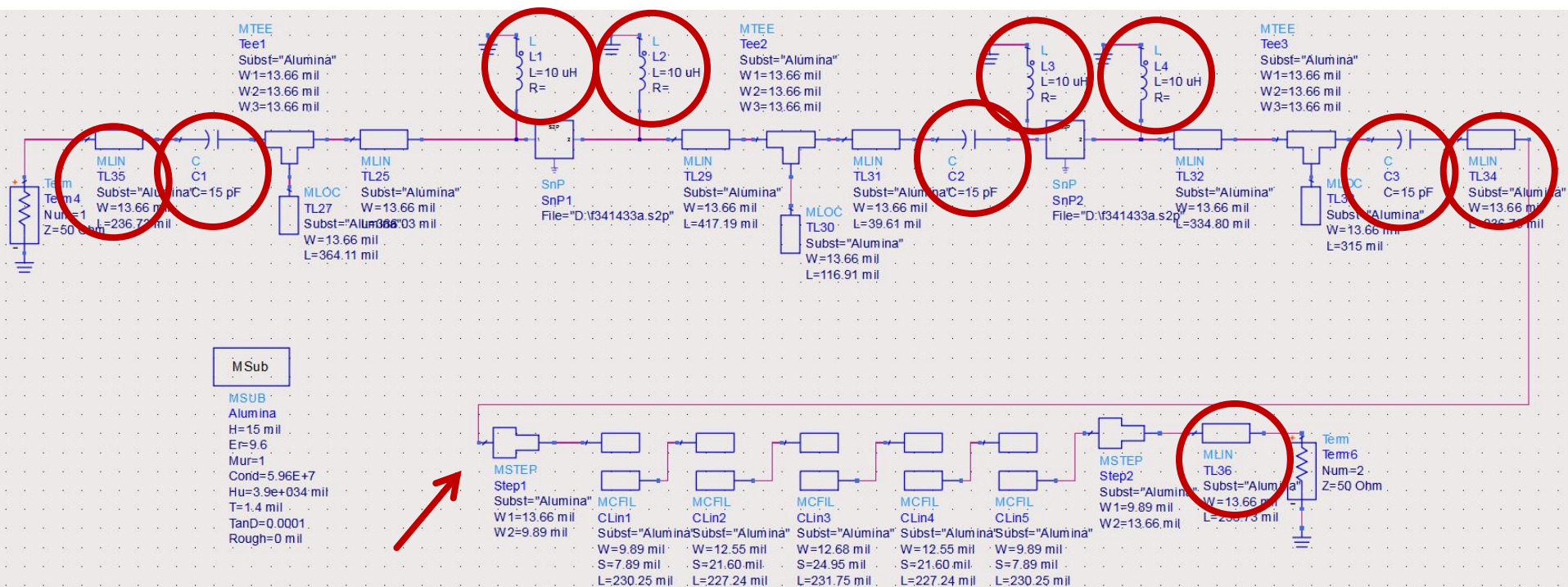


Amplifier, Filter, Total

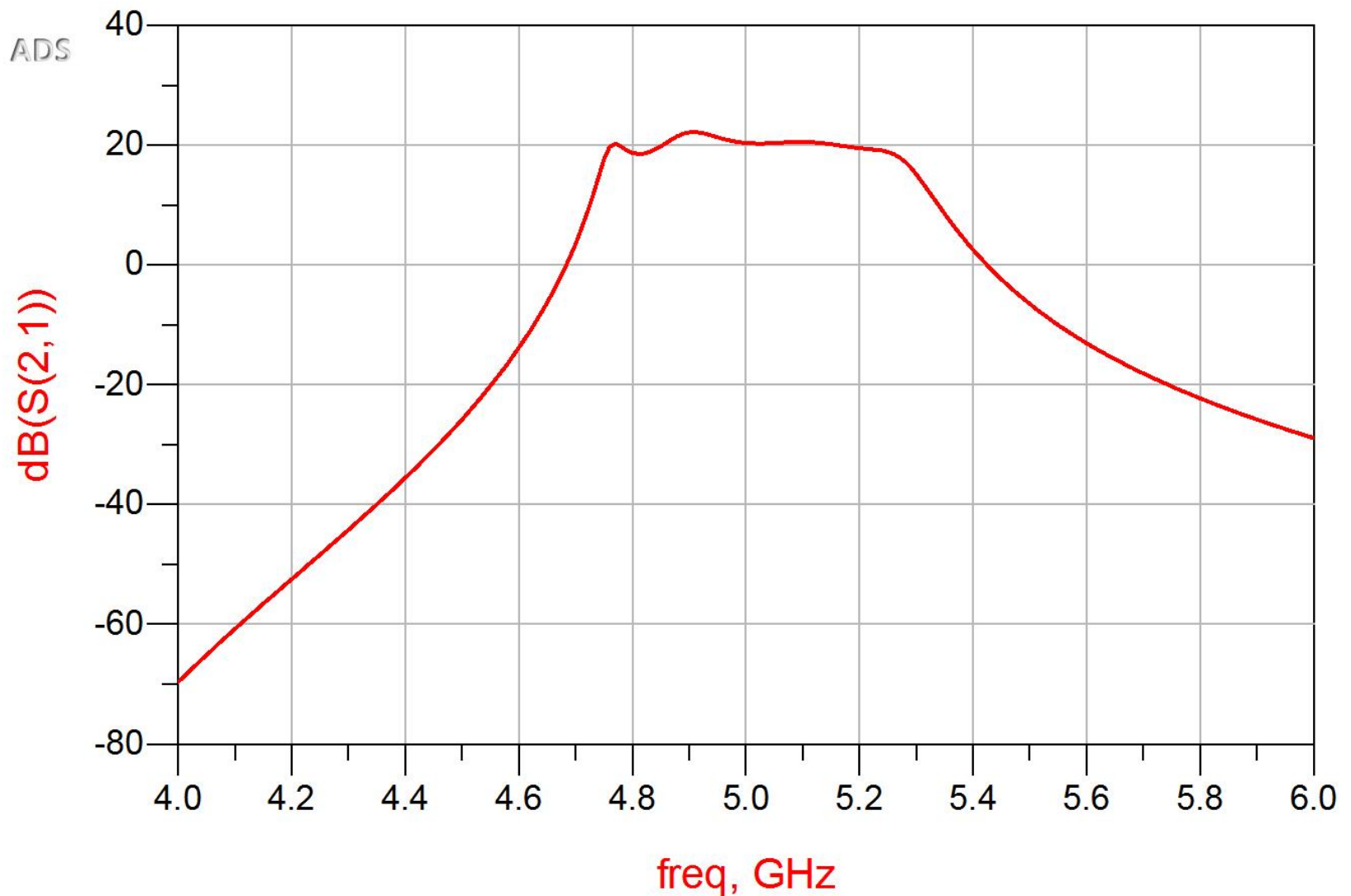


DC Bias elements in ADS schematic

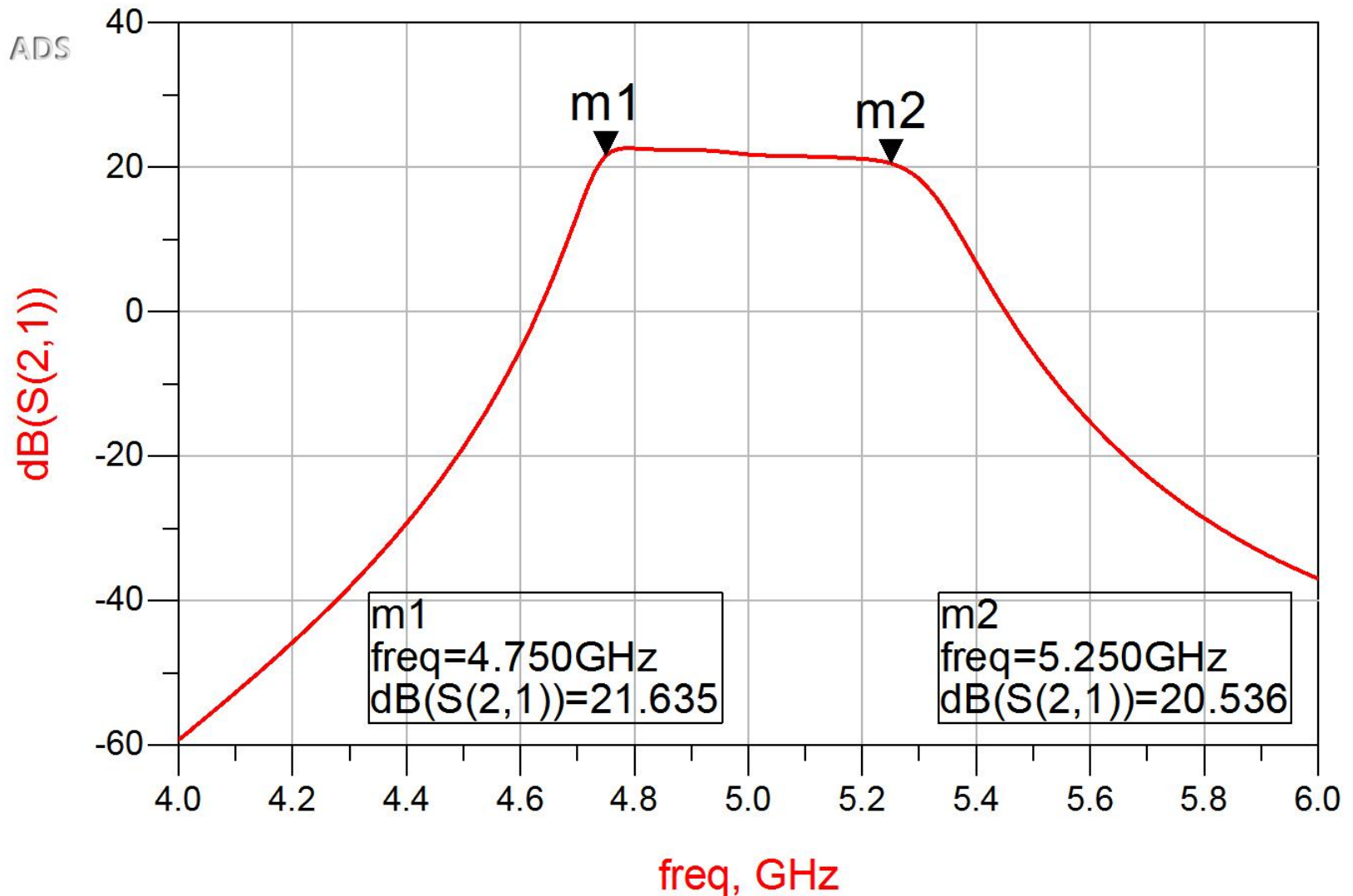
- Insert L (RF chokes) and C (decoupling)
- additional 50Ω connection lines
 - source
 - load
 - between blocks



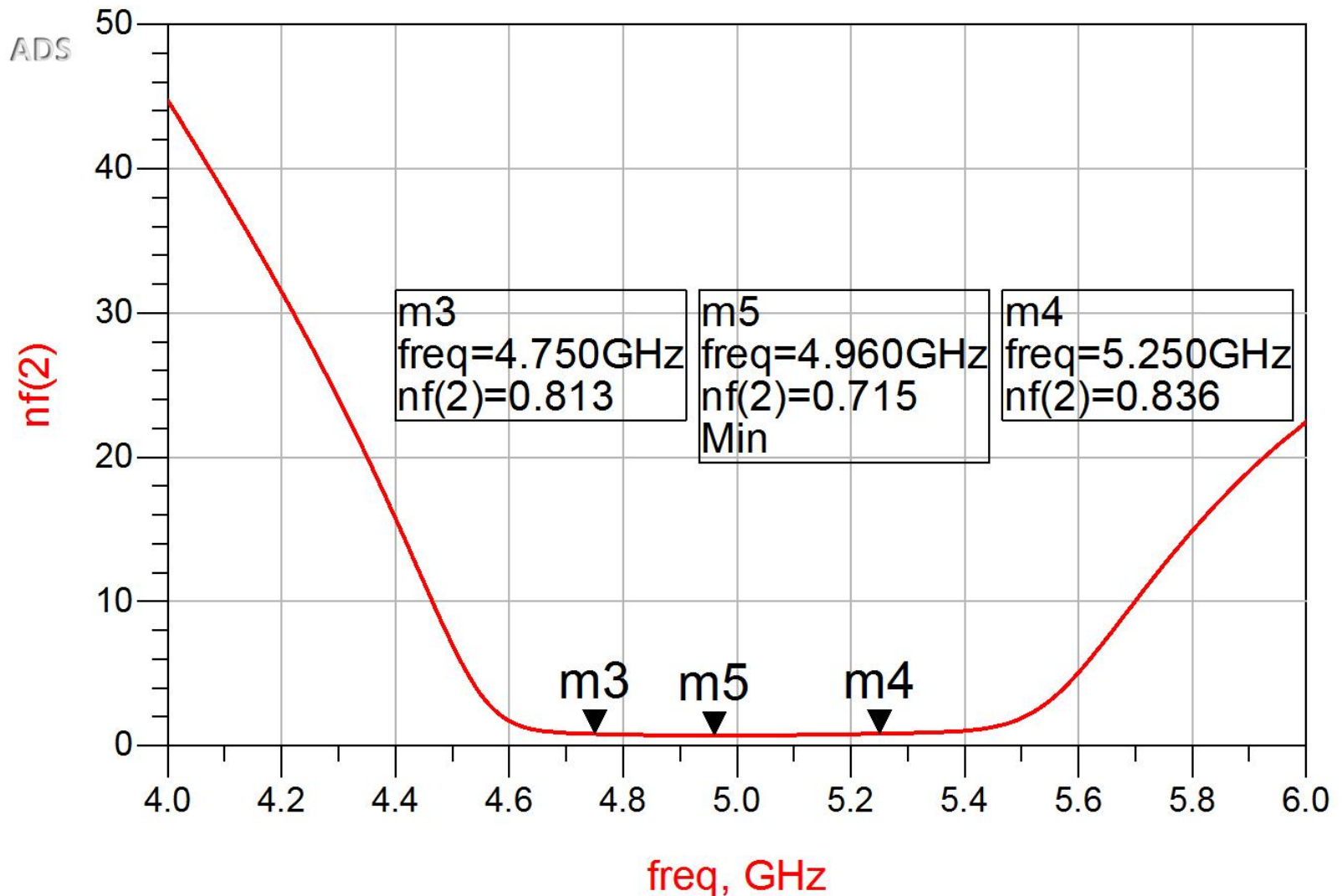
Gain -> Tune/Optimization



Final result (Gain)

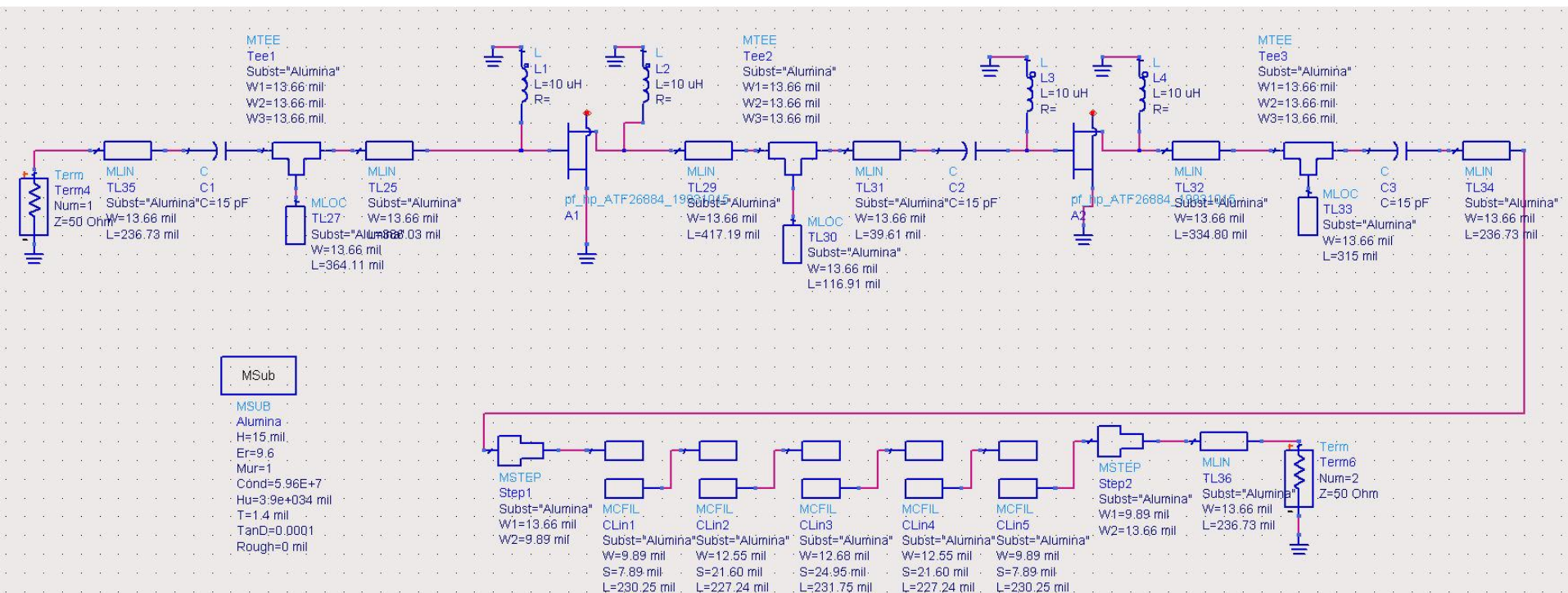


Final result (Noise)



Layout (Example)

- Temporary replacement of the transistors and lumped elements (LC) with elements for which ADS has case information



Contact

- Microwave and Optoelectronics Laboratory
- <https://rf-opto.etti.tuiasi.ro>
- rdamian@etti.tuiasi.ro